

### FEATURES

**Flexible CMOS interface allows dual-word, word, or byte load**  
**Single-carrier W-CDMA ACLR = 80 dBc at 122.88 MHz IF**  
**Analog output: adjustable 8.7 mA to 31.7 mA,  $R_L = 25 \Omega$  to  $50 \Omega$**   
**Novel  $2 \times / 4 \times / 8 \times$  interpolator/complex modulator allows carrier placement anywhere in the DAC bandwidth**  
**Gain and phase adjustment for sideband suppression**  
**Multichip synchronization interface**  
**High performance, low noise PLL clock multiplier**  
**Digital inverse sinc filter**  
**Low power: 900 mW at 500 MSPS, full operating conditions**  
**72-lead, exposed paddle LFCSP**

### APPLICATIONS

**Wireless infrastructure**  
**W-CDMA, CDMA2000, TD-SCDMA, WiMAX, GSM, LTE**  
**Digital high or low IF synthesis**  
**Transmit diversity**  
**Wideband communications: LMDS/MMDS, point-to-point**  
**Cable modem termination systems**

### GENERAL DESCRIPTION

The AD9125 is a dual, 16-bit, high dynamic range TxDAC+® digital-to-analog converter (DAC) that provides a sample rate of 1000 MSPS, permitting a multicarrier generation up to the Nyquist frequency. It includes features optimized for direct conversion transmit applications, including complex digital modulation, and gain and offset compensation. The DAC outputs are optimized to interface seamlessly with analog quadrature modulators, such as the ADL537x F-MOD series from Analog Devices, Inc. A 4-wire serial port interface allows programming/readback of many internal parameters. Full-scale output current can be programmed over a range of 8.7 mA to 31.7 mA. The AD9125 comes in a 72-lead LFCSP.

### PRODUCT HIGHLIGHTS

1. Ultralow noise and intermodulation distortion (IMD) enable high quality synthesis of wideband signals from baseband to high intermediate frequencies.
2. A proprietary DAC output switching technique enhances dynamic performance.
3. The current outputs are easily configured for various single-ended or differential circuit topologies.
4. The flexible CMOS digital interface allows the standard 32-wire bus to be reduced to a 16-wire bus.

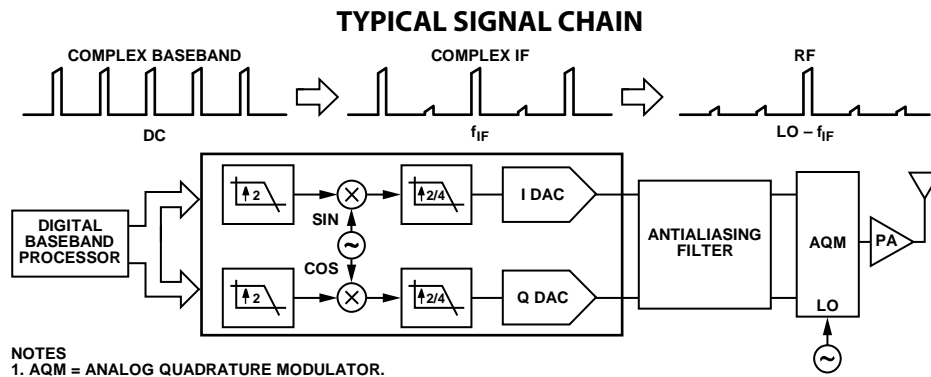


Figure 1.

### Rev. 0

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## TABLE OF CONTENTS

|  |    |  |    |
|--|----|--|----|
| Features .....                                   | 1  | NCO Modulation .....                             | 35 |
| Applications.....                                | 1  | Datapath Configuration .....                     | 35 |
| General Description .....                        | 1  | Determining Interpolation Filter Modes .....     | 36 |
| Product Highlights .....                         | 1  | Datapath Configuration Example .....             | 37 |
| Typical Signal Chain.....                        | 1  | Data Rates vs. Interpolation Modes.....          | 38 |
| Revision History .....                           | 2  | Coarse Modulation Mixing Sequences.....          | 38 |
| Functional Block Diagram .....                   | 3  | Quadrature Phase Correction.....                 | 39 |
| Specifications.....                              | 4  | DC Offset Correction .....                       | 39 |
| DC Specifications .....                          | 4  | Inverse Sinc Filter .....                        | 39 |
| Digital Specifications .....                     | 5  | DAC Input Clock Configurations .....             | 40 |
| Latency and Power-Up Timing Specifications ..... | 5  | DAC Input Clock Configurations.....              | 40 |
| AC Specifications.....                           | 6  | Analog Outputs.....                              | 42 |
| Absolute Maximum Ratings.....                    | 7  | Transmit DAC Operation.....                      | 42 |
| Thermal Resistance .....                         | 7  | Auxiliary DAC Operation .....                    | 43 |
| ESD Caution.....                                 | 7  | Baseband Filter Implementation .....             | 44 |
| Pin Configuration and Function Descriptions..... | 8  | Driving the ADL5375-15 .....                     | 44 |
| Typical Performance Characteristics .....        | 10 | Reducing LO Leakage and Unwanted Sidebands ..... | 44 |
| Terminology .....                                | 16 | Device Power Dissipation.....                    | 45 |
| Theory of Operation .....                        | 17 | Temperature Sensor .....                         | 46 |
| Serial Port Operation .....                      | 17 | Multichip Synchronization.....                   | 47 |
| Data Format .....                                | 17 | Synchronization with Clock Multiplication .....  | 47 |
| Serial Port Pin Descriptions.....                | 17 | Synchronization with Direct Clocking.....        | 49 |
| Serial Port Options.....                         | 18 | Data Rate Mode Synchronization .....             | 49 |
| Device Configuration Register Map .....          | 19 | FIFO Rate Mode Synchronization .....             | 50 |
| Device Configuration Register Descriptions.....  | 21 | Additional Synchronization Features .....        | 51 |
| CMOS Input Data Ports .....                      | 29 | Interrupt Request Operation .....                | 52 |
| Dual-Word Mode .....                             | 29 | Interrupt Service Routine.....                   | 52 |
| Word Mode .....                                  | 29 | Interface Timing Validation.....                 | 53 |
| Byte Mode.....                                   | 29 | SED Operation.....                               | 53 |
| Interface Timing .....                           | 30 | SED Example .....                                | 53 |
| FIFO Operation .....                             | 30 | Example Start-Up Routine .....                   | 54 |
| Digital Datapath.....                            | 32 | Outline Dimensions .....                         | 55 |
| Premodulation .....                              | 32 | Ordering Guide .....                             | 55 |
| Interpolation Filters .....                      | 32 |  |    |

## REVISION HISTORY

6/10—Revision 0: Initial Version

# FUNCTIONAL BLOCK DIAGRAM

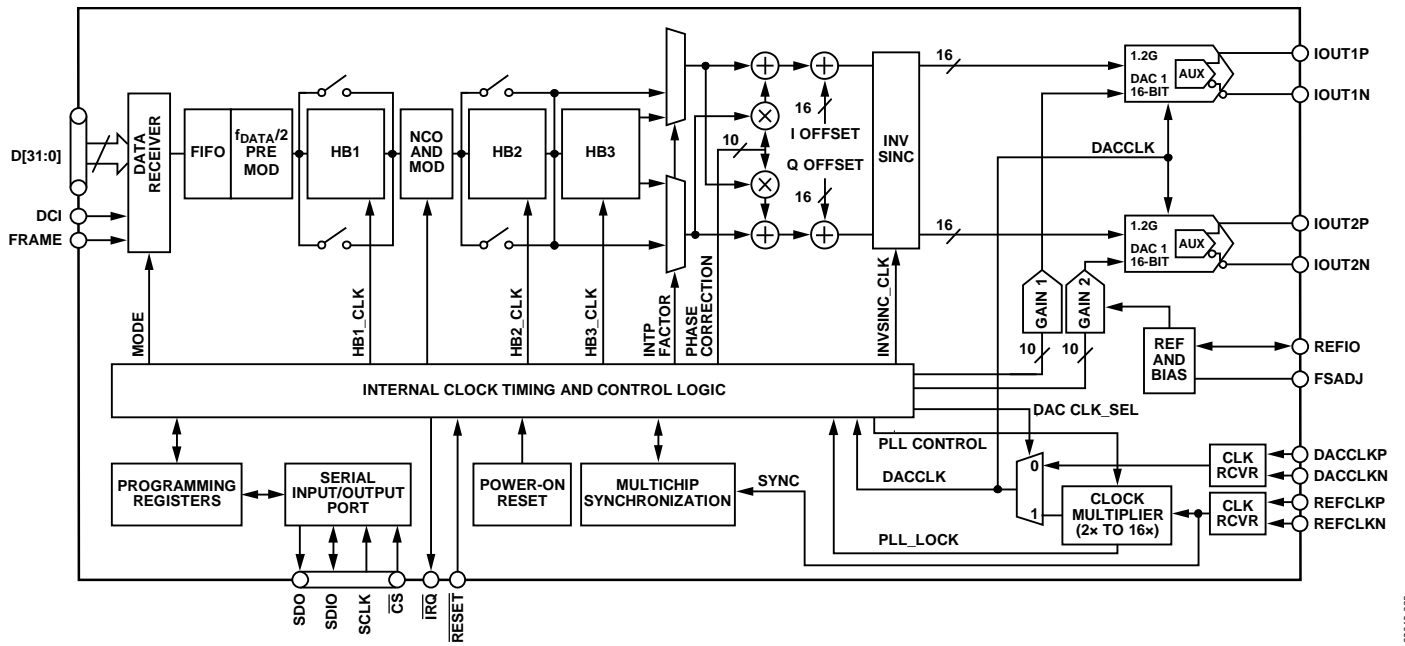


Figure 2. AD9125 Functional Block Diagram

08016-002

## SPECIFICATIONS

### DC SPECIFICATIONS

$T_{MIN}$  to  $T_{MAX}$ , AVDD33 = 3.3 V, DVDD18 = 1.8 V, CVDD18 = 1.8 V,  $I_{OUTFS}$  = 20 mA, maximum sample rate, unless otherwise noted.

Table 1.

| Parameter  | Min    | Typ        | Max    | Unit    |
|--|--------|------------|--------|---------|
| RESOLUTION   |        | 16         |        | Bits    |
| ACCURACY   |        |            |        |         |
| Differential Nonlinearity (DNL)                        |        | ±2.1       |        | LSB     |
| Integral Nonlinearity (INL)                            |        | ±3.7       |        | LSB     |
| MAIN DAC OUTPUTS                                       |        |            |        |         |
| Offset Error   | -0.001 | 0          | +0.001 | % FSR   |
| Gain Error (with Internal Reference)                   | -3.6   | ±2         | +3.6   | % FSR   |
| Full-Scale Output Current <sup>1</sup>                 | 8.66   | 19.6       | 31.66  | mA      |
| Output Compliance Range                                | -1.0   |            | +1.0   | V       |
| Output Resistance                                      |        | 10         |        | MΩ      |
| Gain DAC Monotonicity                                  |        | Guaranteed |        |         |
| Settling Time to Within ±0.5 LSB                       |        | 20         |        | ns      |
| MAIN DAC TEMPERATURE DRIFT                             |        |            |        |         |
| Offset   |        | 0.04       |        | ppm/°C  |
| Gain   |        | 100        |        | ppm/°C  |
| Reference Voltage                                      |        | 30         |        | ppm/°C  |
| REFERENCE  |        |            |        |         |
| Internal Reference Voltage                             |        | 1.2        |        | V       |
| Output Resistance                                      |        | 5          |        | kΩ      |
| ANALOG SUPPLY VOLTAGES                                 |        |            |        |         |
| AVDD33   | 3.13   | 3.3        | 3.47   | V       |
| CVDD18   | 1.71   | 1.8        | 1.89   | V       |
| DIGITAL SUPPLY VOLTAGES                                |        |            |        |         |
| DVDD18   | 1.71   | 1.8        | 1.89   | V       |
| IOVDD  | 1.71   | 1.8/3.3    | 3.47   | V       |
| POWER CONSUMPTION                                      |        |            |        |         |
| 2× Mode, $f_{DAC}$ = 491.52 MSPS, IF = 10 MHz, PLL Off |        | 834        |        | mW      |
| 2× Mode, $f_{DAC}$ = 491.52 MSPS, IF = 10 MHz, PLL On  |        | 913        |        | mW      |
| 8× Mode, $f_{DAC}$ = 800 MSPS, IF = 10 MHz, PLL Off    |        | 1114       | 1227   | mW      |
| AVDD33   |        | 55         | 58     | mA      |
| CVDD18   |        | 78         | 85     | mA      |
| DVDD18   |        | 440        | 490    | mA      |
| Power-Down Mode  |        | 1.5        | 2.7    | mW      |
| Power Supply Rejection Ratio, AVDD33                   | -0.3   |            | +0.3   | % FSR/V |
| OPERATING RANGE  | -40    | +25        | +85    | °C      |

<sup>1</sup> Based on a 10 kΩ external resistor.

**DIGITAL SPECIFICATIONS**

$T_{MIN}$  to  $T_{MAX}$ ,  $AVDD33 = 3.3$  V,  $IOVDD = 3.3$  V,  $DVDD18 = 1.8$  V,  $CVDD18 = 1.8$  V,  $I_{OUTFS} = 20$  mA, maximum sample rate, unless otherwise noted.

**Table 2.**

| Parameter  | Conditions   | Min    | Typ  | Max  | Unit |
|--|--|--------|------|------|------|
| <b>CMOS DATA INPUTS</b>                                      |  |        |      |      |      |
| Input $V_{IN}$ Logic High                                    |  | 1.2    |      |      | V    |
| Input $V_{IN}$ Logic Low                                     |  |        |      | 0.6  | V    |
| Maximum Bus Speed  |  | 250    |      |      | MHz  |
| <b>SERIAL PORT OUTPUT LOGIC LEVELS</b>                       |  |        |      |      |      |
| Output $V_{OUT}$ Logic High                                  | $IOVDD = 1.8$ V  | 1.4    |      |      | V    |
|  | $IOVDD = 2.5$ V  | 1.8    |      |      | V    |
|  | $IOVDD = 3.3$ V  | 2.0    |      |      | V    |
| Output $V_{OUT}$ Logic Low                                   | $IOVDD = 1.8$ V  |        |      | 0.4  | V    |
|  | $IOVDD = 2.5$ V  |        |      | 0.4  | V    |
|  | $IOVDD = 3.3$ V  |        |      | 0.4  | V    |
| <b>SERIAL PORT INPUT LOGIC LEVELS</b>                        |  |        |      |      |      |
| Input $V_{IN}$ Logic High                                    | $IOVDD = 1.8$ V  | 1.2    |      |      | V    |
|  | $IOVDD = 2.5$ V  | 1.6    |      |      | V    |
|  | $IOVDD = 3.3$ V  | 2.4    |      |      | V    |
| Input $V_{IN}$ Logic Low                                     | $IOVDD = 1.8$ V  |        |      | 0.6  | V    |
|  | $IOVDD = 2.5$ V  |        |      | 0.8  | V    |
|  | $IOVDD = 3.3$ V  |        |      | 0.8  | V    |
| <b>DACCLK INPUT (DACCLKP, DACCLKN)</b>                       |  |        |      |      |      |
| Differential Peak-to-Peak Voltage                            |  | 100    | 500  | 2000 | mV   |
| Common-Mode Voltage  | Self biased input, ac couple                             |        | 1.25 |      | V    |
| Maximum Clock Rate   |  | 1000   |      |      | MHz  |
| <b>REFCLK INPUT (REFCLKP, REFCLKN)</b>                       |  |        |      |      |      |
| Differential Peak-to-Peak Voltage                            |  | 100    | 500  | 2000 | mV   |
| Common-Mode Voltage  |  |        | 1.25 |      | V    |
| REFCLKx Frequency, PLL Mode                                  | $1 \text{ GHz} \leq f_{VCO} \leq 2.1 \text{ GHz}$        | 15.625 |      | 600  | MHz  |
| REFCLKx Frequency, SYNC Mode                                 | See the Multichip Synchronization section for conditions | 0      |      | 600  | MHz  |
| <b>SERIAL PERIPHERAL INTERFACE</b>                           |  |        |      |      |      |
| Maximum Clock Rate (SCLK)                                    |  | 40     |      |      | MHz  |
| Minimum Pulse Width High ( $t_{PWH}$ )                       |  |        |      | 12.5 | ns   |
| Minimum Pulse Width Low ( $t_{PWOL}$ )                       |  |        |      | 12.5 | ns   |
| Setup Time, SDI to SCLK ( $t_{DS}$ )                         |  | 1.9    |      |      | ns   |
| Hold Time, SDI to SCLK ( $t_{DH}$ )                          |  | 0.2    |      |      | ns   |
| Data Valid, SDO to SCLK ( $t_{DV}$ )                         |  | 2.3    |      |      | ns   |
| Setup Time, $\overline{CS}$ to SCLK ( $t_{D\overline{CS}}$ ) |  |        | 1.4  |      | ns   |

**LATENCY AND POWER-UP TIMING SPECIFICATIONS****Table 3.**

| Parameter                                     | Min | Typ | Max | Unit   |
|---|-----|-----|-----|--------|
| <b>LATENCY (DACCLK Cycles)</b>                |     |     |     |        |
| 1× Interpolation (with or Without Modulation) |     | 64  |     | Cycles |
| 2× Interpolation (with or Without Modulation) |     | 135 |     | Cycles |
| 4× Interpolation (with or Without Modulation) |     | 292 |     | Cycles |
| 8× Interpolation (with or Without Modulation) |     | 608 |     | Cycles |
| Inverse Sinc                                  |     | 20  |     | Cycles |
| Fine Modulation                               |     | 8   |     | Cycles |
| Power-Up Time                                 |     | 260 |     | ms     |

# AD9125

## AC SPECIFICATIONS

$T_{MIN}$  to  $T_{MAX}$ ,  $AVDD33 = 3.3$  V,  $DVDD18 = 1.8$  V,  $CVDD18 = 1.8$  V,  $I_{OUTFS} = 20$  mA, maximum sample rate, unless otherwise noted.

**Table 4.**

| Parameter   | Min | Typ  | Max | Unit   |
|---|-----|------|-----|--------|
| SPURIOUS-FREE DYNAMIC RANGE (SFDR)                            |     |      |     |        |
| $f_{DAC} = 100$ MSPS, $f_{OUT} = 20$ MHz                      |     | 78   |     | dBc    |
| $f_{DAC} = 200$ MSPS, $f_{OUT} = 50$ MHz                      |     | 80   |     | dBc    |
| $f_{DAC} = 400$ MSPS, $f_{OUT} = 70$ MHz                      |     | 69   |     | dBc    |
| $f_{DAC} = 800$ MSPS, $f_{OUT} = 70$ MHz                      |     | 72   |     | dBc    |
| TWO-TONE INTERMODULATION DISTORTION (IMD)                     |     |      |     |        |
| $f_{DAC} = 200$ MSPS, $f_{OUT} = 50$ MHz                      |     | 84   |     | dBc    |
| $f_{DAC} = 400$ MSPS, $f_{OUT} = 60$ MHz                      |     | 86   |     | dBc    |
| $f_{DAC} = 400$ MSPS, $f_{OUT} = 80$ MHz                      |     | 84   |     | dBc    |
| $f_{DAC} = 800$ MSPS, $f_{OUT} = 100$ MHz                     |     | 81   |     | dBc    |
| NOISE SPECTRAL DENSITY (NSD) EIGHT-TONE, 500 kHz TONE SPACING |     |      |     |        |
| $f_{DAC} = 200$ MSPS, $f_{OUT} = 80$ MHz                      |     | -162 |     | dBm/Hz |
| $f_{DAC} = 400$ MSPS, $f_{OUT} = 80$ MHz                      |     | -163 |     | dBm/Hz |
| $f_{DAC} = 800$ MSPS, $f_{OUT} = 80$ MHz                      |     | -164 |     | dBm/Hz |
| W-CDMA ADJACENT CHANNEL LEAKAGE RATIO (ACLR), SINGLE CARRIER  |     |      |     |        |
| $f_{DAC} = 491.52$ MSPS, $f_{OUT} = 10$ MHz                   |     | 82   |     | dBc    |
| $f_{DAC} = 491.52$ MSPS, $f_{OUT} = 122.88$ MHz               |     | 80   |     | dBc    |
| $f_{DAC} = 983.04$ MSPS, $f_{OUT} = 122.88$ MHz               |     | 81   |     | dBc    |
| W-CDMA SECOND ACLR, SINGLE CARRIER                            |     |      |     |        |
| $f_{DAC} = 491.52$ MSPS, $f_{OUT} = 10$ MHz                   |     | 88   |     | dBc    |
| $f_{DAC} = 491.52$ MSPS, $f_{OUT} = 122.88$ MHz               |     | 86   |     | dBc    |
| $f_{DAC} = 983.04$ MSPS, $f_{OUT} = 122.88$ MHz               |     | 88   |     | dBc    |

**Table 5. Interface Speeds**

| Mode           | Interpolation | $f_{BUS}$ | $f_{DATA}$ | $f_{DAC}$ |
|----------------|---------------|-----------|------------|-----------|
| Byte Mode      | 1×            | 250       | 62.5       | 62.5      |
|                | 2× (HB1)      | 250       | 62.5       | 125       |
|                | 2× (HB2)      | 250       | 62.5       | 125       |
|                | 4×            | 250       | 62.5       | 250       |
|                | 8×            | 250       | 62.5       | 500       |
| Word Mode      | 1×            | 250       | 125        | 125       |
|                | 2× (HB1)      | 250       | 125        | 250       |
|                | 2× (HB2)      | 250       | 125        | 250       |
|                | 4×            | 250       | 125        | 500       |
|                | 8×            | 250       | 125        | 1000      |
| Dual-Word Mode | 1×            | 250       | 250        | 250       |
|                | 2× (HB1)      | 250       | 250        | 500       |
|                | 2× (HB2)      | 250       | 250        | 500       |
|                | 4×            | 250       | 250        | 1000      |
|                | 8×            | 125       | 125        | 1000      |

## ABSOLUTE MAXIMUM RATINGS

Table 6.

| Parameter                                  | With Respect To        | Rating                   |
|--|------------------------|--------------------------|
| AVDD33                                     | AVSS, EPAD, CVSS, DVSS | -0.3 V to +3.6 V         |
| IOVDD                                      | AVSS, EPAD, CVSS, DVSS | -0.3 V to +3.6 V         |
| DVDD18, CVDD18                             | AVSS, EPAD, CVSS, DVSS | -0.3 V to +2.1 V         |
| AVSS                                       | EPAD, CVSS, DVSS       | -0.3 V to +0.3 V         |
| EPAD                                       | AVSS, CVSS, DVSS       | -0.3 V to +0.3 V         |
| CVSS                                       | AVSS, EPAD, DVSS       | -0.3 V to +0.3 V         |
| DVSS                                       | AVSS, EPAD, CVSS       | -0.3 V to +0.3 V         |
| FSADJ, REFIO, IOUT1P/IOUT1N, IOUT2P/IOUT2N | AVSS                   | -0.3 V to AVDD33 + 0.3 V |
| D[31:0], FRAME, DCI                        | EPAD, DVSS             | -0.3 V to DVDD18 + 0.3 V |
| DACCLKP/DACCLKN, REFCLKP/REFCLKN           | DVSS                   | -0.3 V to CVDD18 + 0.3 V |
| RESET, IRQ, CS, SCLK, SDIO, SDO            | EPAD, DVSS             | -0.3 V to IOVDD + 0.3 V  |
| Junction Temperature                       |                        | 125°C                    |
| Storage Temperature Range                  |                        | -65°C to +150°C          |

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## THERMAL RESISTANCE

The exposed paddle (EPAD) must be soldered to the ground plane for the 72-lead LFCSP. The EPAD performs as an electrical and thermal connection to the board.

Typical  $\theta_{JA}$ ,  $\theta_{JB}$ , and  $\theta_{JC}$  values are specified for a 4-layer board in still air. Airflow increases heat dissipation, effectively reducing  $\theta_{JA}$  and  $\theta_{JB}$ .

Table 7. Thermal Resistance

| Package       | $\theta_{JA}$ | $\theta_{JB}$ | $\theta_{JC}$ | Unit | Conditions    |
|---------------|---------------|---------------|---------------|------|---------------|
| 72-Lead LFCSP | 20.7          | 10.9          | 1.1           | °C/W | EPAD soldered |

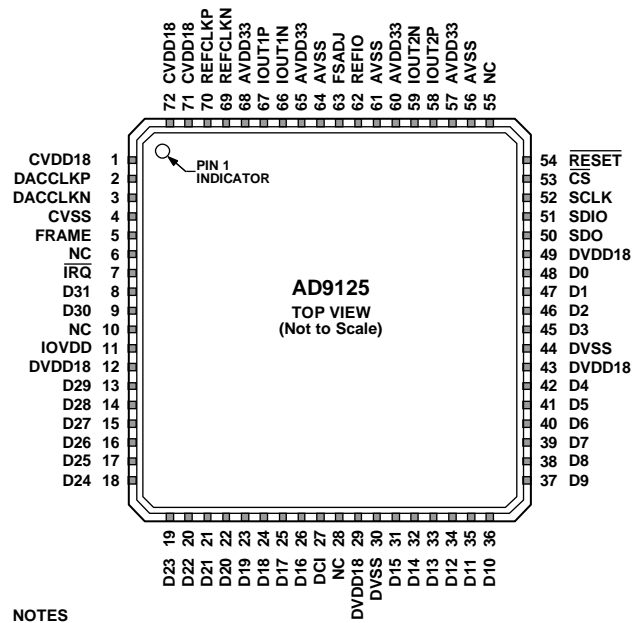
## ESD CAUTION



**ESD (electrostatic discharge) sensitive device.** Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.



## PIN CONFIGURATION AND FUNCTION DESCRIPTIONS



- NOTES  
 1. NC = NO CONNECT.  
 2. EXPOSED PAD MUST BE CONNECTED TO AVSS.

Figure 3. Pin Configuration

09016-003

Table 8. Pin Function Descriptions

| Pin No. | Mnemonic                      | Description  |
|---------|-------------------------------|--|
| 1       | CVDD18                        | 1.8 V Clock Supply. Supplies clock receivers, clock distribution, and PLL circuitry.   |
| 2       | DACCLKP                       | DAC Clock Input, Positive.   |
| 3       | DACCLKN                       | DAC Clock Input, Negative.   |
| 4       | CVSS                          | Clock Supply Common.   |
| 5       | FRAME                         | Frame Input.   |
| 6       | NC                            | No Connect   |
| 7       | $\overline{\text{IRQ}}$ (INT) | Interrupt Request. Open Drain, Active Low Output. Connect external pull-up to IOVDD.   |
| 8       | D31                           | Data Bit 31.   |
| 9       | D30                           | Data Bit 30.   |
| 10      | NC                            | No Connect.  |
| 11      | IOVDD                         | Supply for Serial Port Pin, $\overline{\text{RESET}}$ Pin, and $\overline{\text{IRQ}}$ Pin. 1.8 V to 3.3 V can be applied to this pin. |
| 12      | DVDD18                        | 1.8 V Digital Supply. Supplies power to digital core and digital data ports.   |
| 13      | D29                           | Data Bit 29.   |
| 14      | D28                           | Data Bit 28.   |
| 15      | D27                           | Data Bit 27.   |
| 16      | D26                           | Data Bit 26.   |
| 17      | D25                           | Data Bit 25.   |
| 18      | D24                           | Data Bit 24.   |
| 19      | D23                           | Data Bit 23.   |
| 20      | D22                           | Data Bit 22.   |
| 21      | D21                           | Data Bit 21.   |
| 22      | D20                           | Data Bit 20.   |
| 23      | D19                           | Data Bit 19.   |
| 24      | D18                           | Data Bit 18.   |
| 25      | D17                           | Data Bit 17.   |
| 26      | D16                           | Data Bit 16.   |
| 27      | DCI                           | Data Clock Input.  |

| Pin No. | Mnemonic           | Description  |
|---------|--------------------|--|
| 28      | NC                 | No Connect.  |
| 29      | DVDD18             | 1.8 V Digital Supply.  |
| 30      | DVSS               | Digital Common.  |
| 31      | D15                | Data Bit 15.   |
| 32      | D14                | Data Bit 14.   |
| 33      | D13                | Data Bit 13.   |
| 34      | D12                | Data Bit 12.   |
| 35      | D11                | Data Bit 11.   |
| 36      | D10                | Data Bit 10.   |
| 37      | D9                 | Data Bit 9.  |
| 38      | D8                 | Data Bit 8.  |
| 39      | D7                 | Data Bit 7.  |
| 40      | D6                 | Data Bit 6.  |
| 41      | D5                 | Data Bit 5.  |
| 42      | D4                 | Data Bit 4.  |
| 43      | DVDD18             | 1.8 V Digital Supply.  |
| 44      | DVSS               | Digital Supply Common.   |
| 45      | D3                 | Data Bit 3.  |
| 46      | D2                 | Data Bit 2.  |
| 47      | D1                 | Data Bit 1.  |
| 48      | D0                 | Data Bit 0.  |
| 49      | DVDD18             | 1.8 V Digital Supply.  |
| 50      | SDO                | Serial Port Data Output (CMOS levels with respect to IOVDD).   |
| 51      | SDIO               | Serial Port Data Input/Output (CMOS levels with respect to IOVDD).   |
| 52      | SCLK               | Serial Port Clock Input (CMOS levels with respect to IOVDD).   |
| 53      | $\overline{CS}$    | Serial Port Chip Select. Active Low (CMOS levels with respect to IOVDD).   |
| 54      | $\overline{RESET}$ | Reset. Active Low (CMOS levels with respect to IOVDD).   |
| 55      | NC                 | No Connect.  |
| 56      | AVSS               | Analog Supply Common.  |
| 57      | AVDD33             | 3.3 V Analog Supply.   |
| 58      | IOUT2P             | Q DAC Positive Current Output.   |
| 59      | IOUT2N             | Q DAC Negative Current Output.   |
| 60      | AVDD33             | 3.3 V Analog Supply.   |
| 61      | AVSS               | Analog Supply Common.  |
| 62      | REFIO              | Voltage Reference. Nominally 1.2 V output. Should be decoupled to analog common.                                   |
| 63      | FSADJ              | Full-Scale Current Output Adjust. Place a 10 k $\Omega$ resistor on the analog common.                             |
| 64      | AVSS               | Analog Common.   |
| 65      | AVDD33             | 3.3 V Analog Supply.   |
| 66      | IOUT1N             | I DAC Negative Current Output.   |
| 67      | IOUT1P             | I DAC Positive Current Output.   |
| 68      | AVDD33             | 3.3 V Analog Supply.   |
| 69      | REFCLKN            | PLL Reference Clock Input, Negative. This pin has a secondary function as the SYNC input.                          |
| 70      | REFCLKP            | PLL Reference Clock Input, Positive. This pin has a secondary function as the SYNC input.                          |
| 71      | CVDD18             | 1.8 V Clock Supply. Supplies clock receivers, clock distribution, and PLL circuitry.                               |
| 72      | CVDD18             | 1.8 V Clock Supply. Supplies clock receivers, clock distribution, and PLL circuitry.                               |
|         | EPAD               | Exposed pad must be connected to AVSS. This provides an electrical, thermal, and mechanical connection to the PCB. |

TYPICAL PERFORMANCE CHARACTERISTICS

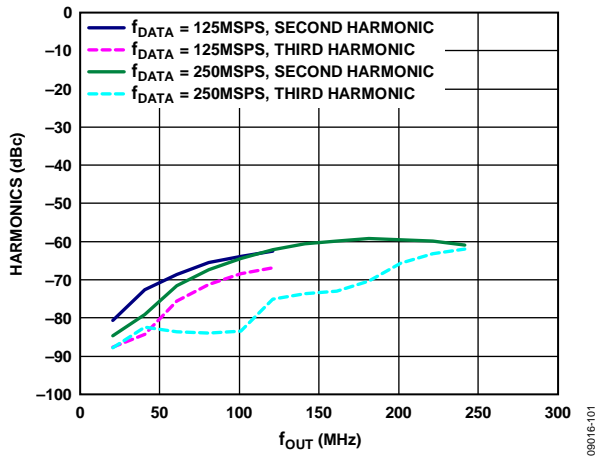


Figure 4. Harmonics vs.  $f_{OUT}$  over  $f_{DATA}$ , 2X Interpolation, Digital Scale = 0 dBFS,  $f_{SC} = 20$  mA

09016-101

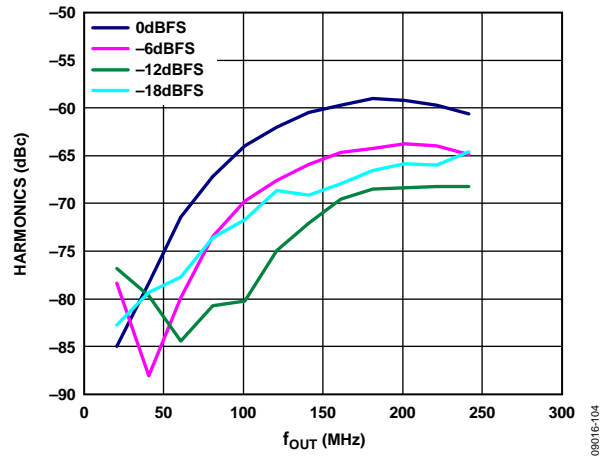


Figure 7. Second Harmonic vs.  $f_{OUT}$  over Digital Scale, 2X Interpolation,  $f_{DATA} = 250$  MSPS,  $f_{SC} = 20$  mA

09016-104

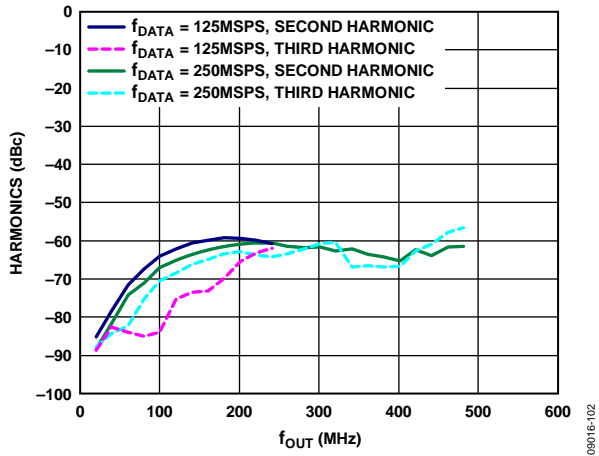


Figure 5. Harmonics vs.  $f_{OUT}$  over  $f_{DATA}$ , 4X Interpolation, Digital Scale = 0 dBFS,  $f_{SC} = 20$  mA

09016-102

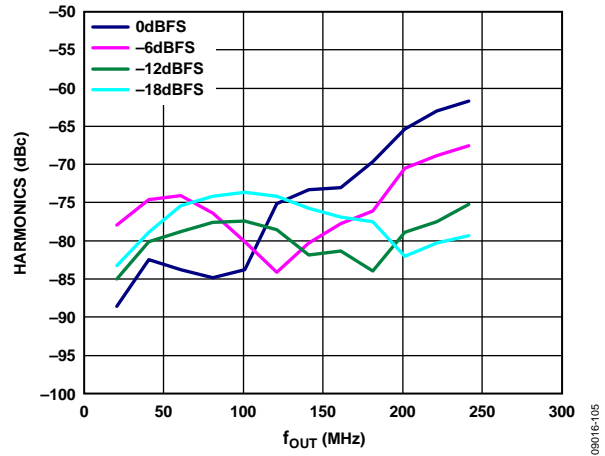


Figure 8. Third Harmonic vs.  $f_{OUT}$  over Digital Scale, 2X Interpolation,  $f_{DATA} = 250$  MSPS,  $f_{SC} = 20$  mA

09016-105

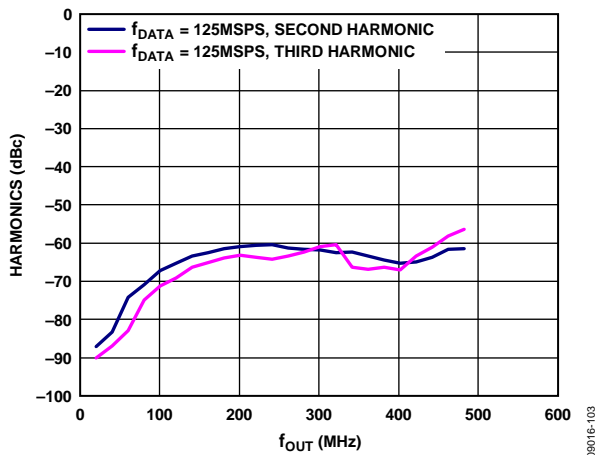


Figure 6. Harmonics vs.  $f_{OUT}$  over  $f_{DATA}$ , 8X Interpolation, Digital Scale = 0 dBFS,  $f_{SC} = 20$  mA

09016-103

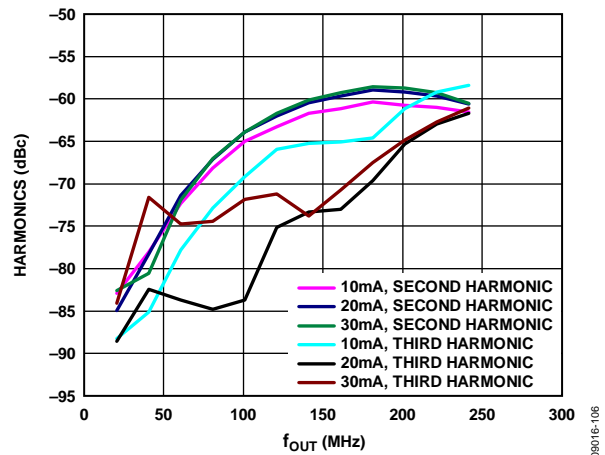


Figure 9. Harmonics vs.  $f_{OUT}$  over  $f_{SC}$ , 2X Interpolation,  $f_{DATA} = 250$  MSPS, Digital Scale = 0 dBFS

09016-106

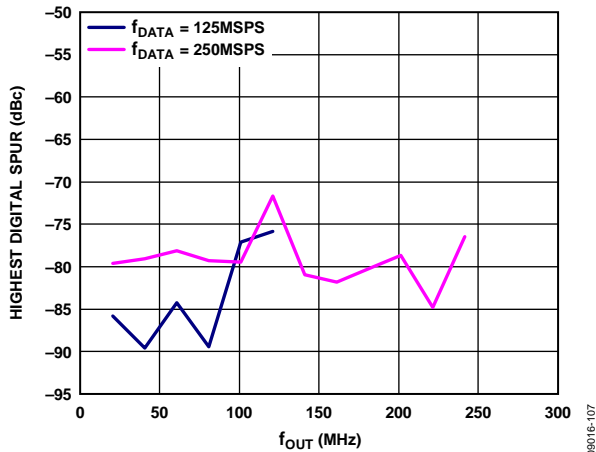


Figure 10. Highest Digital Spur vs.  $f_{OUT}$  over  $f_{DATA}$ , 2x Interpolation, Digital Scale = 0 dBFS,  $f_{SC} = 20\text{ mA}$

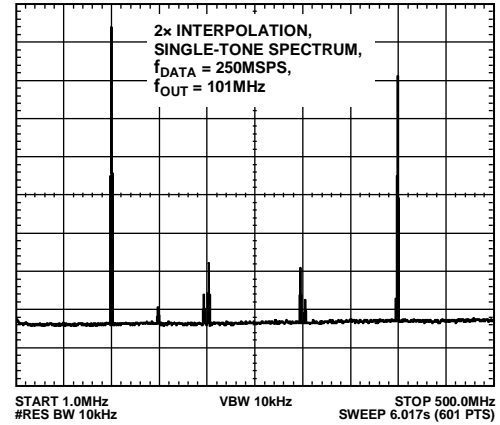


Figure 13. 2x Interpolation, Single-Tone Spectrum

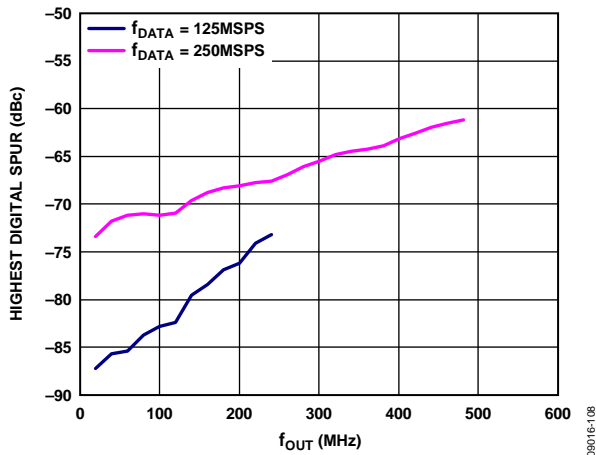


Figure 11. Highest Digital Spur vs.  $f_{OUT}$  over  $f_{DATA}$ , 4x Interpolation, Digital Scale = 0 dBFS,  $f_{SC} = 20\text{ mA}$

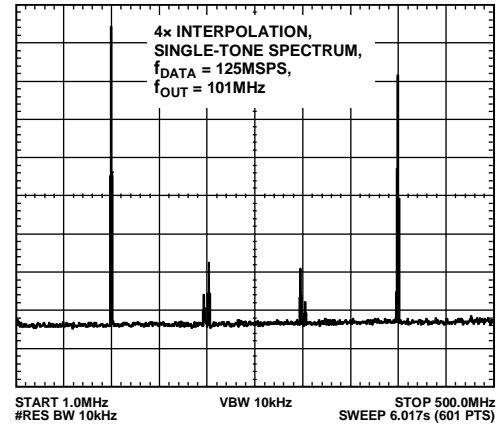


Figure 14. 4x Interpolation, Single-Tone Spectrum

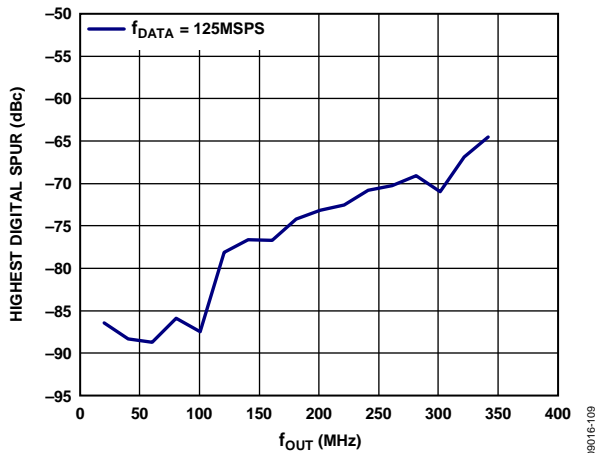


Figure 12. Highest Digital Spur vs.  $f_{OUT}$  over  $f_{DATA}$ , 8x Interpolation, Digital Scale = 0 dBFS,  $f_{SC} = 20\text{ mA}$

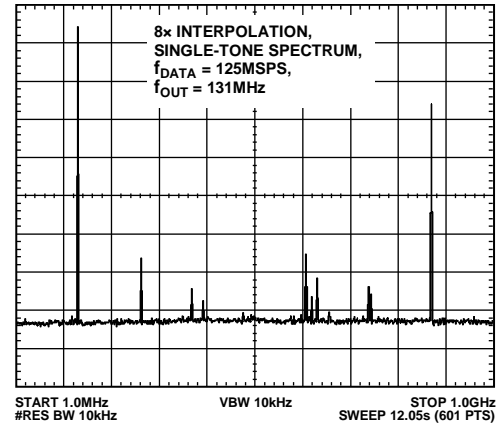


Figure 15. 8x Interpolation, Single-Tone Spectrum

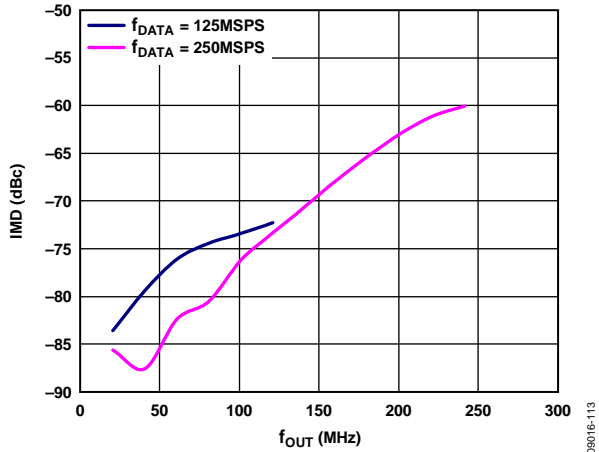


Figure 16. IMD vs.  $f_{OUT}$  over  $f_{DATA}$ , 2× Interpolation, Digital Scale = 0 dBFS,  $f_{SC} = 20$  mA

09016-113

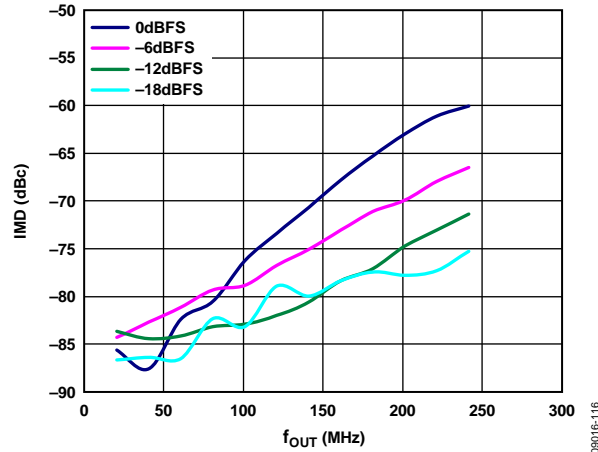


Figure 19. IMD vs.  $f_{OUT}$  over Digital Scale, 2× Interpolation,  $f_{DATA} = 250$  MSPS,  $f_{SC} = 20$  mA

09016-116

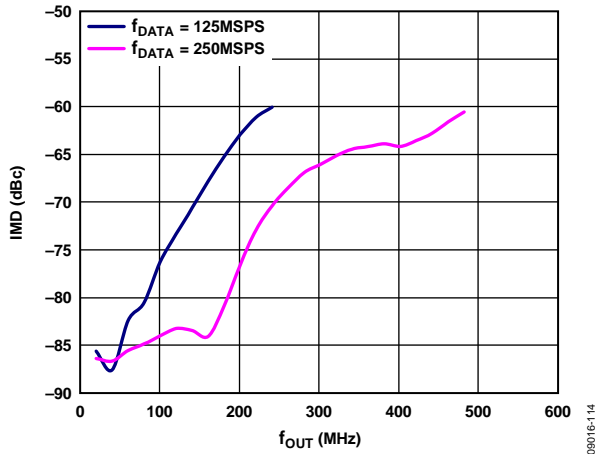


Figure 17. IMD vs.  $f_{OUT}$  over  $f_{DATA}$ , 4× Interpolation, Digital Scale = 0 dBFS,  $f_{SC} = 20$  mA

09016-114

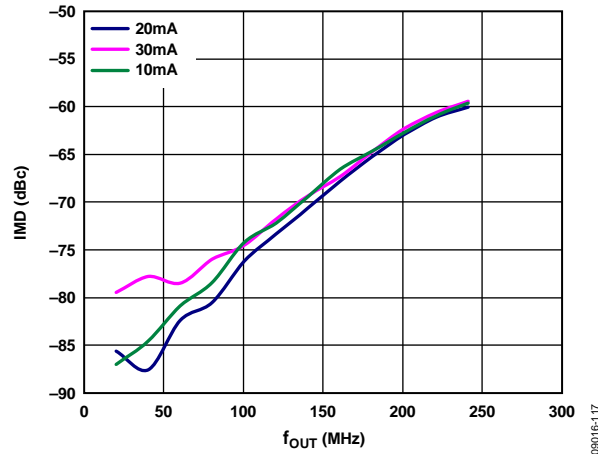


Figure 20. IMD vs.  $f_{OUT}$  over  $f_{SC}$ , 2× Interpolation,  $f_{DATA} = 250$  MSPS, Digital Scale = 0 dBFS

09016-117

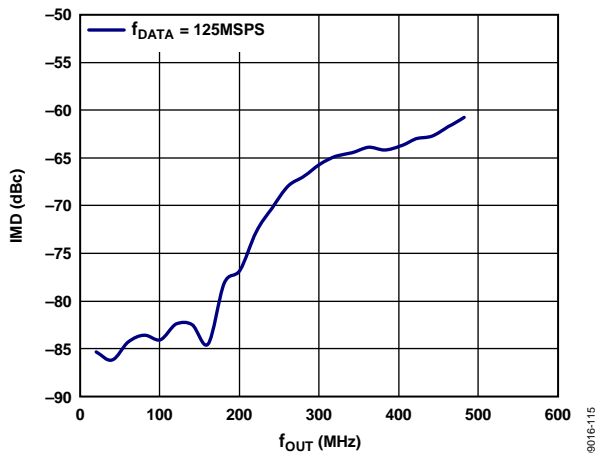


Figure 18. IMD vs.  $f_{OUT}$  over  $f_{DATA}$ , 8× Interpolation, Digital Scale = 0 dBFS,  $f_{SC} = 20$  mA

09016-115

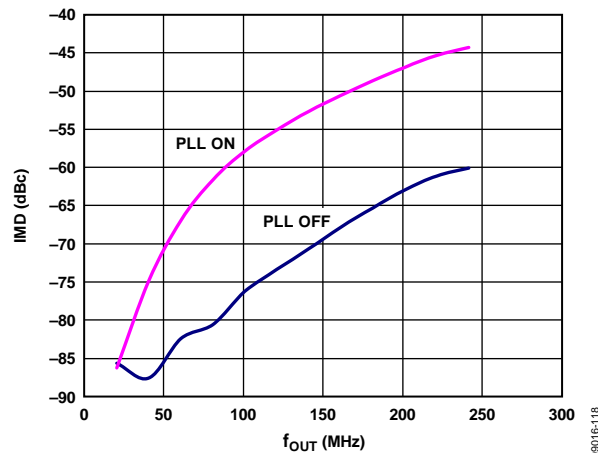


Figure 21. IMD vs.  $f_{OUT}$ , PLL On vs. PLL Off

09016-118

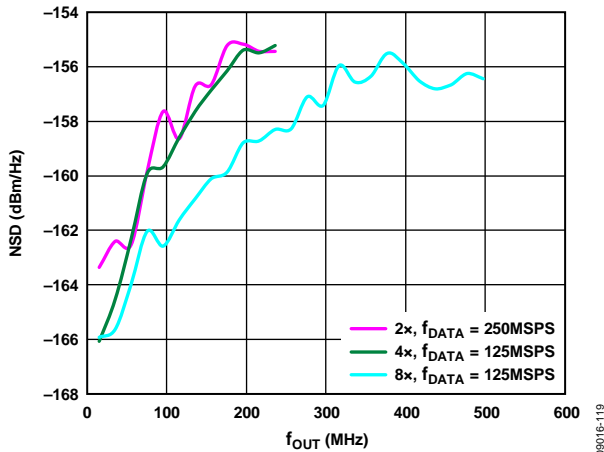


Figure 22. One-Tone NSD vs.  $f_{OUT}$  over Interpolation Rate and  $f_{DATA}$ , Digital Scale = 0 dBFS,  $f_{SC} = 20$  mA, PLL Off

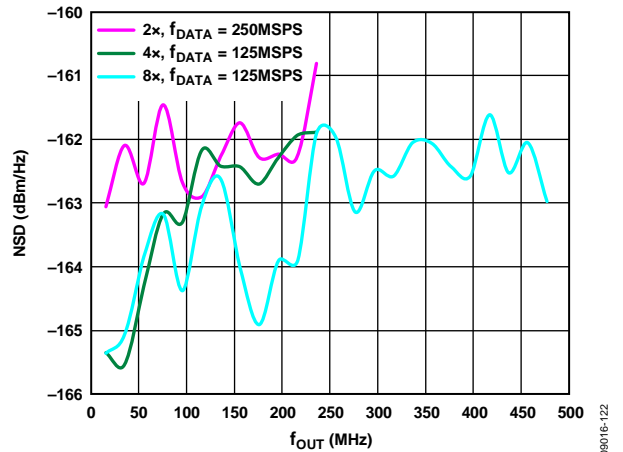


Figure 25. Eight-Tone NSD vs.  $f_{OUT}$  over Interpolation Rate and  $f_{DATA}$ , Digital Scale = 0 dBFS,  $f_{SC} = 20$  mA, PLL Off

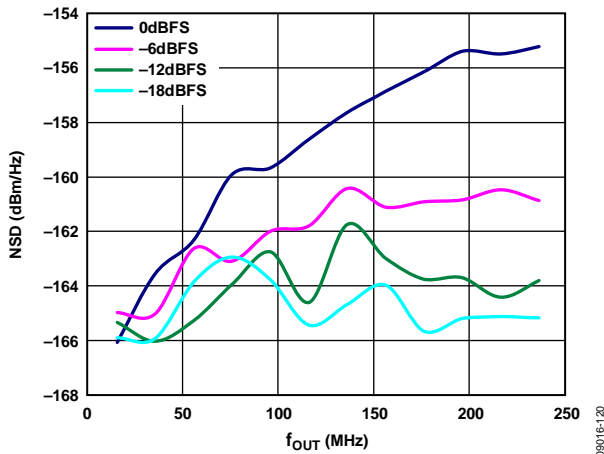


Figure 23. One-Tone NSD vs.  $f_{OUT}$  over Digital Scale,  $f_{DATA} = 200$  MSPS, 4x Interpolation,  $f_{SC} = 20$  mA, PLL Off

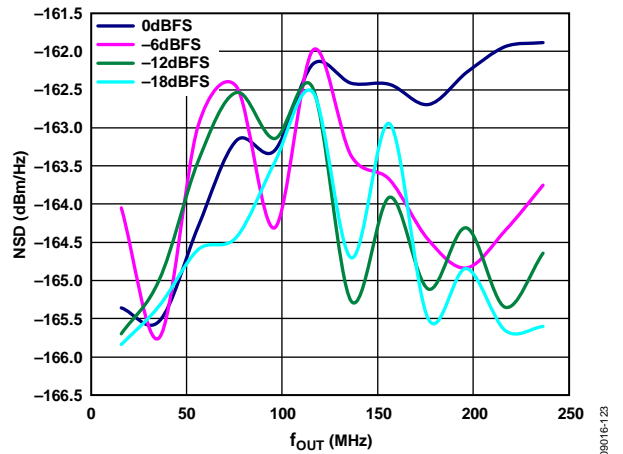


Figure 26. Eight-Tone NSD vs.  $f_{OUT}$  over Digital Scale,  $f_{DATA} = 200$  MSPS, 4x Interpolation,  $f_{SC} = 20$  mA, PLL Off

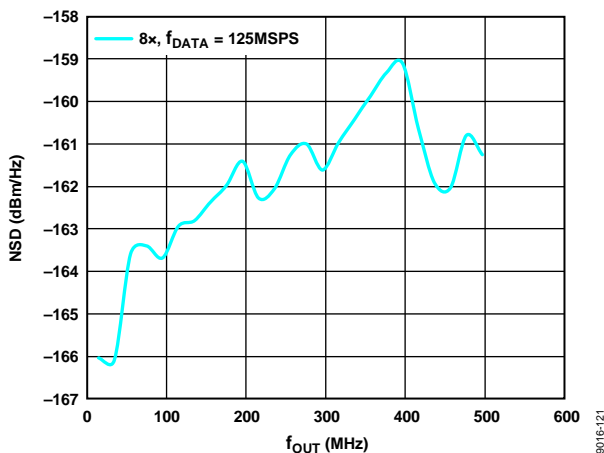


Figure 24. One-Tone NSD vs.  $f_{OUT}$  over Interpolation Rate and  $f_{DATA}$ , Digital Scale = 0 dBFS,  $f_{SC} = 20$  mA, PLL On

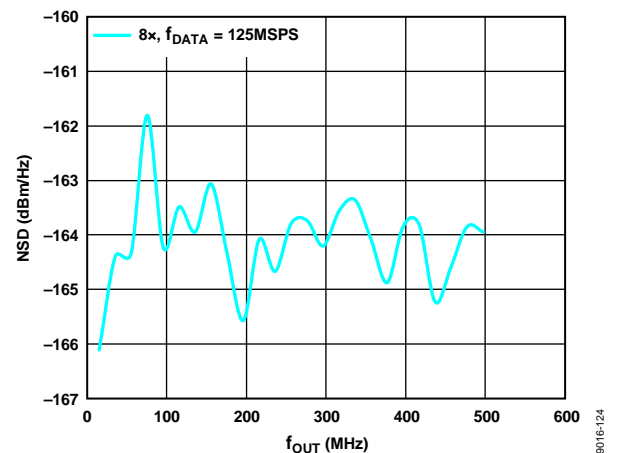


Figure 27. Eight-Tone NSD vs.  $f_{OUT}$  over Interpolation Rate and  $f_{DATA}$ , Digital Scale = 0 dBFS,  $f_{SC} = 20$  mA, PLL On

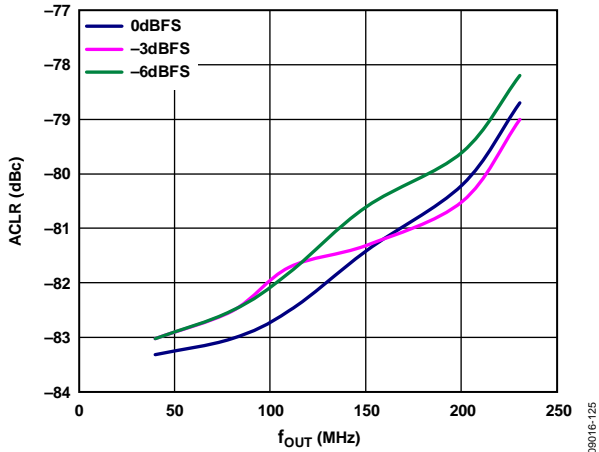


Figure 28. One-Carrier W-CDMA ACLR vs.  $f_{OUT}$  over Digital Cutback, Adjacent Channel, PLL Off

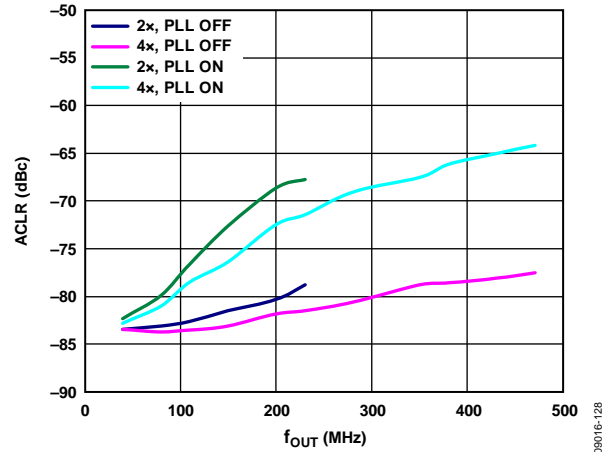


Figure 31. One-Carrier W-CDMA ACLR vs.  $f_{OUT}$  over Interpolation Rate, Adjacent Channel, PLL On vs. PLL Off

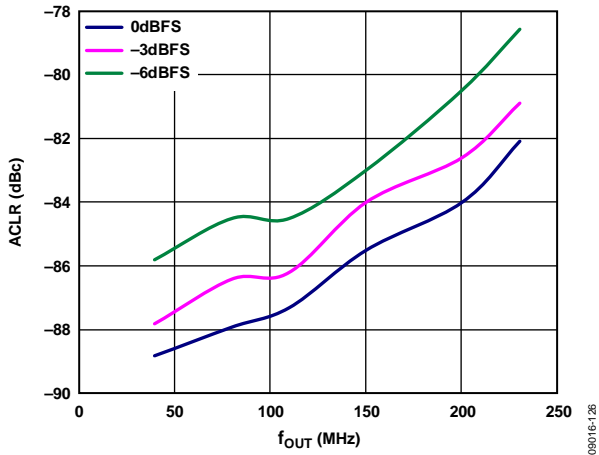


Figure 29. One-Carrier W-CDMA ACLR vs.  $f_{OUT}$  over  $f_{DAG}$ , Alternate Channel, PLL Off

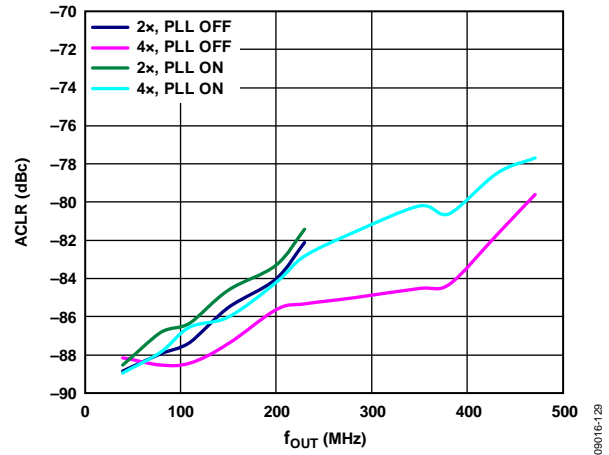


Figure 32. One-Carrier W-CDMA ACLR vs.  $f_{OUT}$  over Interpolation Rate, Alternate Channel, PLL On vs. PLL Off

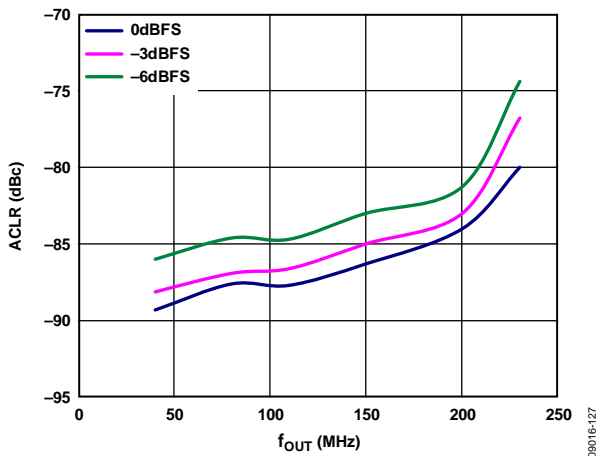


Figure 30. One-Carrier W-CDMA ACLR vs.  $f_{OUT}$  over  $f_{DAG}$ , Second Alternate Channel, PLL Off

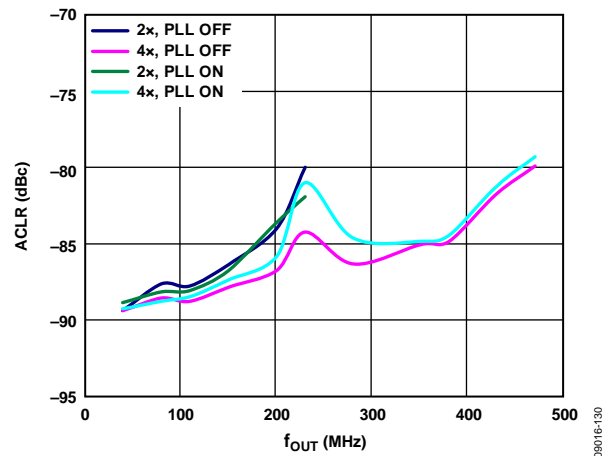
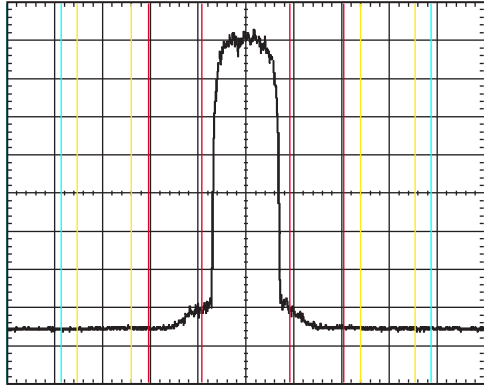


Figure 33. One-Carrier W-CDMA ACLR vs.  $f_{OUT}$  over Interpolation Rate, Second Alternate Channel, PLL On vs. PLL Off

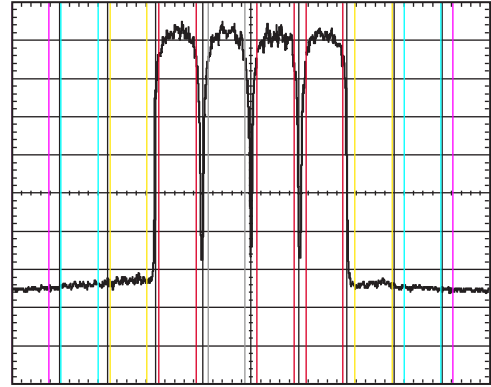


START 133.06MHz      VBW 30kHz      STOP 166.94MHz  
 #RES BW 30kHz      SWEEP 143.6ms (601 PTS)

| RMS RESULTS   | FREQ     | OFFSET   | LOWER  |        | UPPER  |        |
|---------------|----------|----------|--------|--------|--------|--------|
|               |          |          | dBc    | dBm    | dBc    | dBm    |
| CARRIER POWER | 5.00MHz  | 3.840MHz | -75.96 | -85.96 | -77.13 | -87.13 |
| -10.00dBm/    | 10.00MHz | 3.840MHz | -85.33 | -95.33 | -85.24 | -95.25 |
| 3.840MHz      | 15.00MHz | 2.888MHz | -95.81 | -95.81 | -85.43 | -95.43 |

09016-131

Figure 34. Four-Carrier W-CDMA ACLR Performance,  $IF \approx 150$  MHz



START 125.88MHz      VBW 30kHz      STOP 174.42MHz  
 #RES BW 30kHz      SWEEP 206.9ms (601 PTS)

TOTAL CARRIER POWER: -11.19dBm/15.3600MHz  
 RRC FILTER: OFF FILTER ALPHA 0.22  
 REF CARRIER POWER: -16.89dBm/3.8400MHz

|   | OFFSET    | FREQ     | INTEG BW | LOWER  |        | UPPER  |        |
|---|-----------|----------|----------|--------|--------|--------|--------|
|   |           |          |          | dBc    | dBm    | dBc    | dBm    |
| 1 | -16.92dBm | 5.000MHz | 3.840MHz | -65.88 | -82.76 | -67.52 | -84.40 |
| 2 | -16.89dBm | 10.00MHz | 3.840MHz | -68.17 | -85.05 | -69.91 | -86.79 |
| 3 | -17.43dBm | 15.00MHz | 3.840MHz | -70.42 | -87.31 | -71.40 | -88.28 |
| 4 | -17.64dBm |          |          |        |        |        |        |

09016-132

Figure 35. One-Carrier W-CDMA ACLR Performance,  $IF \approx 150$  MHz



## TERMINOLOGY

### Integral Nonlinearity (INL)

INL is defined as the maximum deviation of the actual analog output from the ideal output, determined by a straight line drawn from zero scale to full scale.

### Differential Nonlinearity (DNL)

DNL is the measure of the variation in analog value, normalized to full scale, associated with a 1 LSB change in digital input code.

### Offset Error

The deviation of the output current from the ideal of zero is called offset error. For IOUT1P, 0 mA output is expected when the inputs are all 0s. For IOUT1N, 0 mA output is expected when all inputs are set to 1.

### Gain Error

The difference between the actual and ideal output span. The actual span is determined by the difference between the outputs when all inputs are set to 1 vs. when all inputs are set to 0.

### Output Compliance Range

The range of allowable voltage at the output of a current output DAC. Operation beyond the maximum compliance limits can cause either output stage saturation or breakdown, resulting in nonlinear performance.

### Temperature Drift

Temperature drift is specified as the maximum change from the ambient (25°C) value to the value at either  $T_{MIN}$  or  $T_{MAX}$ . For offset and gain drift, the drift is reported in ppm of full-scale range (FSR) per degree Celsius. For reference drift, the drift is reported in ppm per degree Celsius.

### Power Supply Rejection (PSR)

The maximum change in the full-scale output as the supplies are varied from minimum to maximum specified voltages.

### Settling Time

The time required for the output to reach and remain within a specified error band around its final value, measured from the start of the output transition.

### Spurious-Free Dynamic Range (SFDR)

The difference in decibels between the peak amplitude of the output signal and the peak spurious signal within the dc to the Nyquist frequency of the DAC. Typically, energy in this band is rejected by the interpolation filters. This specification, therefore, defines how well the interpolation filters work and the effect of other parasitic coupling paths to the DAC output.

### Signal-to-Noise Ratio (SNR)

SNR is the ratio of the rms value of the measured output signal to the rms sum of all other spectral components below the Nyquist frequency, excluding the first six harmonics and dc. The value for SNR is expressed in decibels.

### Interpolation Filter

If the digital inputs to the DAC are sampled at a multiple rate of  $f_{DATA}$  (interpolation rate), a digital filter can be constructed that has a sharp transition band near  $f_{DATA}/2$ . Images that typically appear around  $f_{DAC}$  (output data rate) can be greatly suppressed.

### Adjacent Channel Leakage Ratio (ACLR)

The ratio in decibels relative to the carrier (dBc) between the measured power within a channel and that of its adjacent channel.

### Complex Image Rejection

In a traditional two-part upconversion, two images are created around the second IF frequency. These images have the effect of wasting transmitter power and system bandwidth. By placing the real part of a second complex modulator in series with the first complex modulator, either the upper or lower frequency image near the second IF can be rejected.

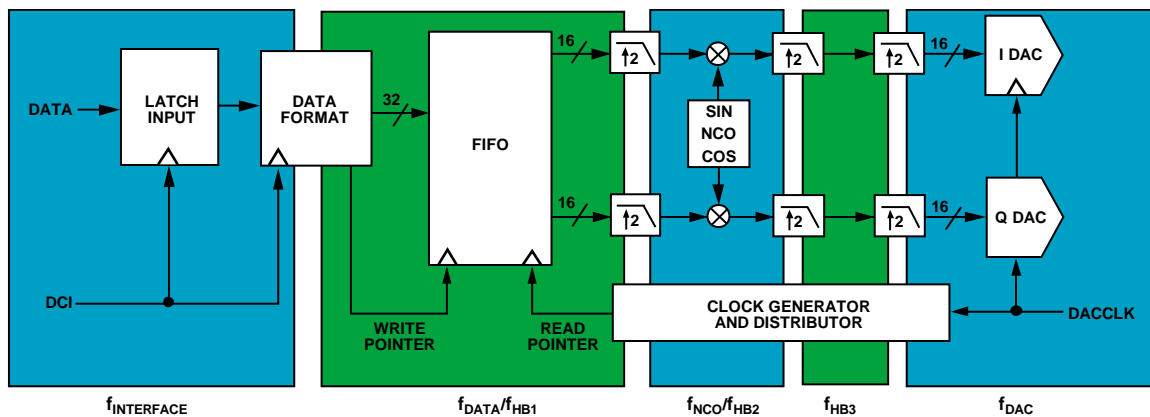


Figure 36. Defining Data Rates

## THEORY OF OPERATION

The AD9125 combines many features that make it a very attractive DAC for wired and wireless communications systems. The dual digital signal path and dual DAC structure allow an easy interface to common quadrature modulators when designing single sideband transmitters. The speed and performance of the AD9125 allows wider bandwidths and more carriers to be synthesized than in previously available DACs. In addition, these devices include an innovative low power, 32-bit, complex NCO that greatly increases the ease of frequency placement.

The AD9125 offers features that allow simplified synchronization with incoming data and between multiple devices. Auxiliary DACs are also provided on chip for output dc offset compensation (for local oscillator [LO] compensation in single sideband [SSB] transmitters) and for gain matching (for image rejection optimization in SSB transmitters).

### SERIAL PORT OPERATION

The serial port is a flexible, synchronous serial communication port, allowing easy interface to many industry-standard microcontrollers and microprocessors. The serial I/O is compatible with most synchronous transfer formats, including both the Motorola SPI® and Intel® SSR protocols. The interface allows read/write access to all registers that configure the AD9125. Single- or multiple-byte transfers are supported, as well as MSB-first or LSB-first transfer formats. The serial interface ports can be configured as a single-pin I/O (SDIO) or two unidirectional pins for input/output (SDIO/SDO).

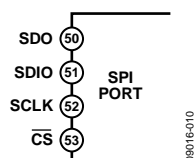


Figure 37. Serial Port Interface Pins

There are two phases of a communication cycle with the AD9125. Phase 1 is the instruction cycle (the writing of an instruction byte into the device), which is coincident with the first eight SCLK rising edges. The instruction byte provides the serial port controller with information regarding the data transfer cycle, which is Phase 2 of the communication cycle. The Phase 1 instruction byte defines whether the upcoming data transfer is a read or write and the starting register address for the first byte of the data transfer. The first eight SCLK rising edges of each communication cycle are used to write the instruction byte into the device.

A logic high on the  $\overline{CS}$  pin followed by a logic low resets the serial port timing to the initial state of the instruction cycle. From this state, the next eight rising SCLK edges represent the instruction bits of the current I/O operation.

The remaining SCLK edges are for Phase 2 of the communication cycle. Phase 2 is the actual data transfer between the device and the system controller. Phase 2 of the communication cycle is a transfer of one or more data bytes. Registers change immediately upon writing to the last bit of each transfer byte, except for the frequency tuning word and NCO phase offsets, which only change when the frequency update bit (Register 0x36, Bit 0) is set.

### DATA FORMAT

The instruction byte contains the information shown in Table 9.

Table 9. Serial Port Instruction Byte

| I7 (MSB) | I6 | I5 | I4 | I3 | I2 | I1 | I0 (LSB) |
|----------|----|----|----|----|----|----|----------|
| R/W      | A6 | A5 | A4 | A3 | A2 | A1 | A0       |

R/W, Bit 7 of the instruction byte, determines whether a read or write data transfer occurs after the instruction byte write. Logic 1 indicates a read operation, and Logic 0 indicates a write operation.

A6 to A0, Bit 6 to Bit 0 of the instruction byte, determine the register that is accessed during the data transfer portion of the communication cycle. For multibyte transfers, A6 is the starting byte address. The remaining register addresses are generated by the device based on the LSB\_FIRST bit (Register 0x00, Bit 6).

### SERIAL PORT PIN DESCRIPTIONS

#### Serial Clock (SCLK)

The serial clock pin synchronizes data to and from the device and runs the internal state machines. The maximum frequency of SCLK is 40 MHz. All data input is registered on the rising edge of SCLK. All data is driven out on the falling edge of SCLK.

#### Chip Select ( $\overline{CS}$ )

An active low input starts and gates a communication cycle. It allows more than one device to be used on the same serial communication lines. The SDO and SDIO pins go to a high impedance state when this input is high. During the communication cycle, the  $\overline{CS}$  pin should stay low.

#### Serial Data I/O (SDIO)

Data is always written into the device on this pin. However, this pin can be used as a bidirectional data line. The configuration of this pin is controlled by Register 0x00, Bit 7. The default is Logic 0, configuring the SDIO pin as unidirectional.

#### Serial Data Out (SDO)

Data is read from this pin for protocols that use separate lines for transmitting and receiving data. In the case where the device operates in a single bidirectional I/O mode, this pin does not output data and is set to a high impedance state.

## SERIAL PORT OPTIONS

The serial port can support both MSB-first and LSB-first data formats. This functionality is controlled by the LSB\_FIRST bit (Register 0x00, Bit 6). The default is MSB-first (LSB\_FIRST = 0).

When LSB\_FIRST = 0 (MSB-first), the instruction and data bit must be written from MSB to LSB. Multibyte data transfers in MSB-first format start with an instruction byte that includes the register address of the most significant data byte. Subsequent data bytes should follow from the high address to the low address. In MSB-first mode, the serial port internal byte address generator decrements for each data byte of the multibyte communication cycle.

When LSB\_FIRST = 1 (LSB-first), the instruction and data bit must be written from LSB to MSB. Multibyte data transfers in LSB-first format start with an instruction byte that includes the register address of the least significant data byte followed by multiple data bytes. The serial port internal byte address generator increments for each byte of the multibyte communication cycle.

The serial port controller data address decrements from the data address written toward 0x00 for multibyte I/O operations if the MSB-first mode is active. The serial port controller address increments from the data address written toward 0x7F for multibyte I/O operations if the LSB-first mode is active.

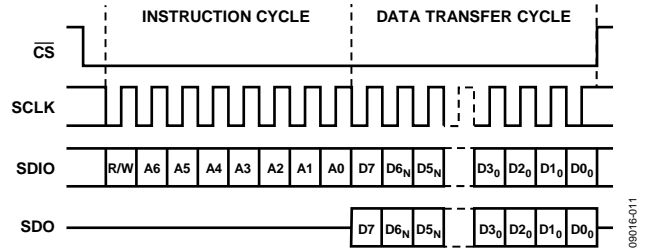


Figure 38. Serial Register Interface Timing, MSB First

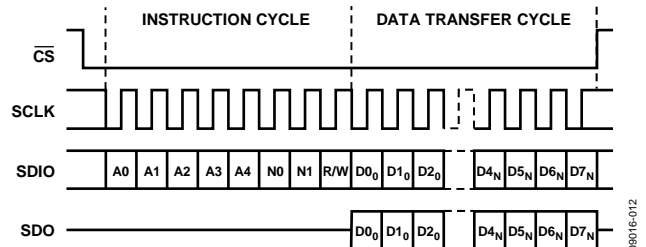


Figure 39. Serial Register Interface Timing, LSB First

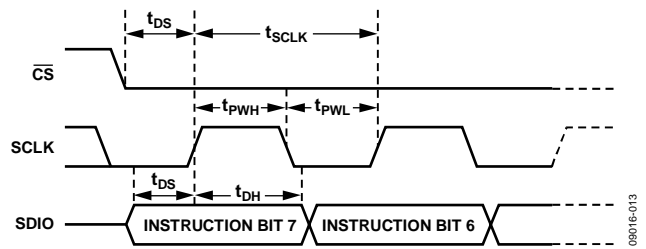


Figure 40. Timing Diagram for Serial Port Register Write ( $t_{DS}$  to  $t_{D\overline{CS}}$ )

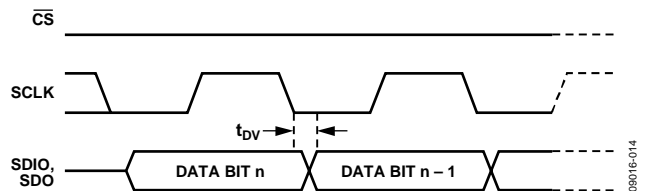


Figure 41. Timing Diagram for Serial Port Register Read

## DEVICE CONFIGURATION REGISTER MAP

Table 10. Device Configuration Register Map

| Register Name          | Addr (Hex) | Bit 7                                 | Bit 6                     | Bit 5                    | Bit 4                        | Bit 3                    | Bit 2                                   | Bit 1                   | Bit 0                 | Default |      |
|------------------------|------------|---------------------------------------|---------------------------|--------------------------|------------------------------|--------------------------|---|-------------------------|-----------------------|---------|------|
| Comm                   | 0x00       | SDIO                                  | LSB_FIRST                 | Reset                    |                              |                          |   |                         |                       | 0x00    |      |
| Power Control          | 0x01       | Power-down DAC I                      | Power-down DAC Q          | Power-down data receiver | Power-down aux ADC           |                          |   |                         | PLL lock status       | 0x10    |      |
| Data Format            | 0x03       | Binary data format                    | Q data first              | MSB swap                 |                              |                          |   | Data bus width[1:0]     |                       | 0x00    |      |
| Interrupt Enable 1     | 0x04       | Enable PLL lock lost                  | Enable PLL lock           | Enable sync signal lost  | Enable sync signal lock      | Enable sync phase lock   | Enable soft FIFO sync                   | Enable FIFO Warning 1   | Enable FIFO Warning 2 | 0x00    |      |
| Interrupt Enable 2     | 0x05       | 0                                     | 0                         | 0                        | Enable AED compare pass      | Enable AED compare fail  | Enable SED compare fail                 | 0                       | 0                     | 0x00    |      |
| Event Flag 1           | 0x06       | PLL lock lost                         | PLL locked                | Sync signal lost         | Sync signal locked           | Sync phase locked        | Soft FIFO sync                          | FIFO Warning 1          | FIFO Warning 2        | N/A     |      |
| Event Flag 2           | 0x07       |                                       |                           |                          | AED compare pass             | AED compare fail         | SED compare fail                        |                         |                       | N/A     |      |
| Clock Receiver Control | 0x08       | DACCLK duty correction                | REFCLK duty correction    | DACCLK cross-correction  | REFCLK cross-correction      | 1                        | 1                                       | 1                       | 1                     | 0x3F    |      |
| PLL Control 1          | 0x0A       | PLL enable                            | PLL manual enable         | Manual VCO band[5:0]     |                              |                          |   |                         |                       | 0x40    |      |
| PLL Control 2          | 0x0C       | PLL loop bandwidth[2:0]               |                           |                          | PLL charge pump current[4:0] |                          |   |                         |                       |         | 0xD1 |
| PLL Control 3          | 0x0D       | N2[1:0]                               |                           |                          | PLL cross control enable     | N0[1:0]                  |   | N1[1:0]                 |                       | 0xD9    |      |
| PLL Status 1           | 0x0E       | PLL lock                              |                           |                          |                              | VCO control voltage[3:0] |   |                         |                       | 0x00    |      |
| PLL Status 2           | 0x0F       |                                       |                           | VCO band readback[5:0]   |                              |                          |   |                         |                       | 0x00    |      |
| Sync Control 1         | 0x10       | Sync enable                           | Data/FIFO rate toggle     |                          |                              | Rising edge sync         | Sync Averaging[2:0]                     |                         |                       | 0x48    |      |
| Sync Control 2         | 0x11       |                                       |                           | Sync phase request[5:0]  |                              |                          |   |                         |                       | 0x00    |      |
| Sync Status 1          | 0x12       | Sync lost                             | Sync locked               |                          |                              |                          |   |                         |                       | N/A     |      |
| Sync Status 2          | 0x13       | Sync phase readback[7:0] (6.2 format) |                           |                          |                              |                          |   |                         |                       | N/A     |      |
| FIFO Control           | 0x17       |                                       |                           |                          |                              |                          | FIFO phase offset[2:0]                  |                         |                       | 0x04    |      |
| FIFO Status 1          | 0x18       | FIFO Warning 1                        | FIFO Warning 2            |                          |                              |                          | FIFO soft align ack                     | FIFO soft align request | FIFO reset aligned    | N/A     |      |
| FIFO Status 2          | 0x19       | FIFO level[7:0]                       |                           |                          |                              |                          |   |                         |                       | N/A     |      |
| Datapath Control       | 0x1B       | Bypass premod                         | Bypass sinc <sup>-1</sup> | Bypass NCO               |                              | NCO gain                 | Bypass phase compensation and dc offset | Select sideband         | Send I data to Q data | 0xE4    |      |
| HB1 Control            | 0x1C       |                                       |                           |                          |                              |                          | HB1[1:0]                                |                         | Bypass HB1            | 0x00    |      |
| HB2 Control            | 0x1D       |                                       |                           | HB2[5:0]                 |                              |                          |   |                         | Bypass HB2            | 0x00    |      |
| HB3 Control            | 0x1E       |                                       |                           | HB3[5:0]                 |                              |                          |   |                         | Bypass HB3            | 0x00    |      |
| Chip ID                | 0x1F       | Chip ID[7:0]                          |                           |                          |                              |                          |   |                         |                       | 0x08    |      |

# AD9125

| Register Name                 | Addr (Hex) | Bit 7                  | Bit 6                       | Bit 5                 | Bit 4             | Bit 3                  | Bit 2 | Bit 1                | Bit 0              | Default |
|-------------------------------|------------|------------------------|-----------------------------|-----------------------|-------------------|------------------------|-------|----------------------|--------------------|---------|
| FTW 1 (LSB)                   | 0x30       | FTW[7:0]               |                             |                       |                   |                        |       |                      |                    | 0x00    |
| FTW 2                         | 0x31       | FTW[15:8]              |                             |                       |                   |                        |       |                      |                    | 0x00    |
| FTW 3                         | 0x32       | FTW[23:16]             |                             |                       |                   |                        |       |                      |                    | 0x00    |
| FTW 4 (MSB)                   | 0x33       | FTW[31:24]             |                             |                       |                   |                        |       |                      |                    | 0x00    |
| NCO Phase Offset LSB          | 0x34       | NCO phase offset[7:0]  |                             |                       |                   |                        |       |                      |                    | 0x00    |
| NCO Phase Offset MSB          | 0x35       | NCO phase offset[15:8] |                             |                       |                   |                        |       |                      |                    | 0x00    |
| NCO FTW Update                | 0x36       |                        |                             | Frame FTW ack         | Frame FTW request |                        |       | Update FTW ack       | Update FTW request | 0x00    |
| I Phase Adj LSB               | 0x38       | I phase adjust[7:0]    |                             |                       |                   |                        |       |                      |                    | 0x00    |
| I Phase Adj MSB               | 0x39       |                        |                             |                       |                   |                        |       | I phase adjust[9:8]  |                    | 0x00    |
| Q Phase Adj LSB               | 0x3A       | Q phase adjust[7:0]    |                             |                       |                   |                        |       |                      |                    | 0x00    |
| Q Phase Adj MSB               | 0x3B       |                        |                             |                       |                   |                        |       | Q phase adjust[9:8]  |                    | 0x00    |
| I DAC Offset LSB              | 0x3C       | I DAC offset[7:0]      |                             |                       |                   |                        |       |                      |                    | 0x00    |
| I DAC Offset MSB              | 0x3D       | I DAC offset[15:8]     |                             |                       |                   |                        |       |                      |                    | 0x00    |
| Q DAC Offset LSB              | 0x3E       | Q DAC offset[7:0]      |                             |                       |                   |                        |       |                      |                    | 0x00    |
| Q DAC Offset MSB              | 0x3F       | Q DAC offset[15:8]     |                             |                       |                   |                        |       |                      |                    | 0x00    |
| I DAC FS Adjust               | 0x40       | I DAC FS adjust[7:0]   |                             |                       |                   |                        |       |                      |                    | 0xF9    |
| I DAC Control                 | 0x41       | I DAC sleep            |                             |                       |                   |                        |       | I DAC FS adjust[9:8] |                    | 0x01    |
| Aux DAC I Data                | 0x42       | I aux DAC[7:0]         |                             |                       |                   |                        |       |                      |                    | 0x00    |
| I Aux DAC Control             | 0x43       | I Aux DAC sign         | I Aux DAC current direction | I aux DAC sleep       |                   |                        |       | I aux DAC[9:8]       |                    | 0x00    |
| Q DAC FS Adjust               | 0x44       | Q DAC FS adjust[7:0]   |                             |                       |                   |                        |       |                      |                    | 0xF9    |
| Q DAC Control                 | 0x45       | Q DAC sleep            |                             |                       |                   |                        |       | Q DAC FS adjust[9:8] |                    | 0x01    |
| Aux DAC Q Data                | 0x46       | Q aux DAC[7:0]         |                             |                       |                   |                        |       |                      |                    | 0x00    |
| Q Aux DAC Control             | 0x47       | Q Aux DAC sign         | Q Aux DAC current direction | Q aux DAC sleep       |                   |                        |       | Q aux DAC[9:8]       |                    | 0x00    |
| Die Temperature Range Control | 0x48       |                        | FS current[2:0]             |                       |                   | Reference current[2:0] |       |                      | Capacitor value    | 0x02    |
| Die Temperature LSB           | 0x49       | Die temperature[7:0]   |                             |                       |                   |                        |       |                      |                    | N/A     |
| Die Temperature MSB           | 0x4A       | Die temperature[15:8]  |                             |                       |                   |                        |       |                      |                    | N/A     |
| SED Control                   | 0x67       | SED compare enable     |                             | Sample error detected |                   | Auto-clear enable      |       | Compare fail         | Compare pass       | 0x00    |
| Compare I0 LSBs               | 0x68       | Compare Value I0[7:0]  |                             |                       |                   |                        |       |                      |                    | 0xB6    |
| Compare I0 MSBs               | 0x69       | Compare Value I0[15:8] |                             |                       |                   |                        |       |                      |                    | 0x7A    |
| Compare Q0 LSBs               | 0x6A       | Compare Value Q0[7:0]  |                             |                       |                   |                        |       |                      |                    | 0x45    |
| Compare Q0 MSBs               | 0x6B       | Compare Value Q0[15:8] |                             |                       |                   |                        |       |                      |                    | 0xEA    |
| Compare I1 LSBs               | 0x6C       | Compare Value I1[7:0]  |                             |                       |                   |                        |       |                      |                    | 0x16    |
| Compare I1 MSBs               | 0x6D       | Compare Value I1[15:8] |                             |                       |                   |                        |       |                      |                    | 0x1A    |
| Compare Q1 LSBs               | 0x6E       | Compare Value Q1[7:0]  |                             |                       |                   |                        |       |                      |                    | 0xC6    |

| Register Name   | Addr (Hex) | Bit 7                        | Bit 6 | Bit 5         | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Default |
|-----------------|------------|------------------------------|-------|---------------|-------|-------|-------|-------|-------|---------|
| Compare Q1 MSBs | 0x6F       | Compare Value Q1[15:8]       |       |               |       |       |       |       |       | 0xAA    |
| SED I LSBs      | 0x70       | Errors detected I_BITS[7:0]  |       |               |       |       |       |       |       | 0x00    |
| SED I MSBs      | 0x71       | Errors detected I_BITS[15:8] |       |               |       |       |       |       |       | 0x00    |
| SED Q LSBs      | 0x72       | Errors detected Q_BITS[7:0]  |       |               |       |       |       |       |       | 0x00    |
| SED Q MSBs      | 0x73       | Errors detected Q_BITS[15:8] |       |               |       |       |       |       |       | 0x00    |
| Die Revision    | 0x7F       |                              |       | Revision[3:0] |       |       |       |       |       | 0x0C    |

## DEVICE CONFIGURATION REGISTER DESCRIPTIONS

Table 11. Device Configuration Register Descriptions

| Register Name      | Address (Hex) | Bits  | Name                     | Description   | Default |
|--------------------|---------------|-------|--------------------------|---|---------|
| Comm               | 0x00          | 7     | SDIO                     | SDIO operation.<br>0 = SDIO operates as an input only.<br>1 = SDIO operates as a bidirectional input/output.  | 0       |
|                    |               | 6     | LSB_FIRST                | Serial port communication LSB or MSB first.<br>0 = MSB first.<br>1 = LSB first.   | 0       |
|                    |               | 5     | Reset                    | 1 = device is held in reset when this bit is written high and is held there until the bit is written low.   | 0       |
| Power Control      | 0x01          | 7     | Power-down DAC I         | 1 = powers down DAC I.  | 0       |
|                    |               | 6     | Power-down DAC Q         | 1 = powers down DAC Q.  | 0       |
|                    |               | 5     | Power-down data receiver | 1 = powers down the input data receiver.  | 0       |
|                    |               | 4     | Power-down auxiliary ADC | 1 = powers down the auxiliary ADC for temperature sensor.   | 0       |
|                    |               | 0     | PLL lock status          | 1 = PLL is locked.  | 0       |
| Data Format        | 0x03          | 7     | Binary data format       | 0 = input data is in twos complement format.<br>1 = input data is in binary format.   | 0       |
|                    |               | 6     | Q data first             | Indicates I/Q data pairing on data input.<br>0 = I data sent to data receiver first.<br>1 = Q data sent to data receiver first.   | 0       |
|                    |               | 5     | MSB swap                 | Swaps the bit order of the data input port.<br>0 = order of the data bits corresponds to the pin descriptions.<br>1 = bit designations are swapped; most significant bits become the least significant bits.  | 0       |
|                    |               | [1:0] | Data bus width           | Data receiver interface mode.<br>00 = dual-word mode; 32-bit interface bus width.<br>01 = word mode; 16-bit interleaved interface bus width.<br>10 = byte mode; 8-bit interleaved interface bus width.<br>11 = invalid.<br>See the CMOS Input Data Ports section for details on the operation of the different interface modes. | 0       |
| Interrupt Enable 1 | 0x04          | 7     | Enable PLL lock lost     | 1 = enables interrupt for PLL lock lost.  | 0       |
|                    |               | 6     | Enable PLL lock          | 1 = enables interrupt for PLL lock.   | 0       |
|                    |               | 5     | Enable sync signal lost  | 1 = enables interrupt for sync signal lock lost.  | 0       |
|                    |               | 4     | Enable sync signal lock  | 1 = enables interrupt for sync signal lock.   | 0       |
|                    |               | 3     | Enable sync phase locked | 1 = enables interrupt for clock generation ready.   | 0       |
|                    |               | 2     | Enable soft FIFO sync    | 1 = enables interrupt for soft FIFO reset.  | 0       |

# AD9125

| Register Name             | Address (Hex) | Bits | Name                       | Description   | Default |
|---------------------------|---------------|------|----------------------------|---|---------|
| Interrupt Enable 2        | 0x05          | 1    | Enable FIFO Warning 1      | 1 = enables interrupt for FIFO Warning 1.   | 0       |
|                           |               | 0    | Enable FIFO Warning 2      | 1 = enables interrupt for FIFO Warning 2.   | 0       |
|                           |               | 7    | Set to 0                   | Set this bit to 0.  | 0       |
|                           |               | 6    | Set to 0                   | Set this bit to 0.  | 0       |
|                           |               | 5    | Set to 0                   | Set this bit to 0.  | 0       |
|                           |               | 4    | Enable AED comparison pass | 1 = enables interrupt for AED comparison pass.  | 0       |
|                           |               | 3    | Enable AED comparison fail | 1 = enables interrupt for AED comparison fail.  | 0       |
|                           |               | 2    | Enable SED comparison fail | 1 = enables interrupt for SED comparison fail.  | 0       |
|                           |               | 1    | Set to 0                   | Set this bit to 0.  | 0       |
| Event Flag 1 <sup>1</sup> | 0x06          | 0    | Set to 0                   | Set this bit to 0.  | 0       |
|                           |               | 7    | PLL lock lost              | 1 = indicates that the PLL, which had been previously locked, has unlocked from the reference signal. This is a latched signal.   | 0       |
|                           |               | 6    | PLL locked                 | 1 = indicates that the PLL has locked to the reference clock input.   | 0       |
|                           |               | 5    | Sync signal lost           | 1 = indicates that the sync logic, which had been previously locked, has lost alignment. This is a latched signal.  | 0       |
|                           |               | 4    | Sync signal locked         | 1 = indicates that the sync logic did achieve sync alignment. This is indicated when no phase changes were requested for at least a few full averaging cycles.  | 0       |
|                           |               | 3    | Sync phase locked          | 1 = indicates that the internal digital clock generation logic is ready. This occurs when internal clocks are present and stable.   | 0       |
|                           |               | 2    | Soft FIFO sync             | 1 = indicates that a FIFO reset originating from a serial port-based request has successfully completed. This is a latched signal.  | 0       |
|                           |               | 1    | FIFO Warning 1             | 1 = indicates that the difference between the FIFO read and write pointers is 1.  | 0       |
|                           |               | 0    | FIFO Warning 2             | 1 = indicates that the difference between the FIFO read and write pointers is 2.  | 0       |
| Event Flag 2 <sup>1</sup> | 0x07          | 4    | AED comparison pass        | 1 = indicates that the SED logic detected a valid input data pattern compared with the preprogrammed expected values. This is a latched signal.   | 0       |
|                           |               | 3    | AED comparison fail        | 1 = indicates that the SED logic detected an invalid input data pattern compared with the preprogrammed expected values. This is a latched signal that automatically clears when eight valid I/Q data pairs are received. | 0       |
|                           |               | 2    | SED comparison fail        | 1 = indicates that the SED logic detected an invalid input data pattern compared with the preprogrammed expected values. This is a latched signal.  |         |
| Clock Receiver Control    | 0x08          | 7    | DACCLK duty correction     | 1 = enables duty-cycle correction on the DACCLK input.  | 0       |
|                           |               | 6    | REFCLK duty correction     | 1 = enables duty-cycle correction on the REFCLK input.  | 0       |
|                           |               | 5    | DACCLK cross-correction    | 1 = enables differential crossing correction on the DACCLK input.   | 1       |
|                           |               | 4    | REFCLK cross-correction    | 1 = enables differential crossing correction on the REFCLK input.   | 1       |

| Register Name  | Address (Hex) | Bits  | Name                         | Description   | Default |
|----------------|---------------|-------|------------------------------|---|---------|
| PLL Control 1  | 0x0A          | 7     | PLL enable                   | 1 = enables the PLL clock multiplier. REFCLK input is used as the PLL reference clock signal.   | 0       |
|                |               | 6     | PLL manual enable            | Enables the manual selection of the VCO band.<br>1 = manual mode; the correct VCO band must be determined by the user.  | 1       |
|                |               | [5:0] | Manual VCO band              | Selects the VCO band to be used.  | 0       |
| PLL Control 2  | 0x0C          | [7:5] | PLL loop bandwidth[2:0]      | Selects the PLL loop filter bandwidth.<br>000 = loop bandwidth is nominally 200 kHz<br>010 = loop bandwidth is nominally 450 kHz<br>100 = loop bandwidth is nominally 950 kHz<br>110 = loop bandwidth is nominally 2 MHz  | 110     |
|                |               | [4:0] | PLL charge pump current[4:0] | Sets the nominal PLL charge-pump current.<br>00000 = lowest current setting.<br>11111 = highest current setting.  | 10001   |
| PLL Control 3  | 0x0D          | [7:6] | N2[1:0]                      | PLL control clock divider. These bits determine the ratio of the DACCLK rate to the PLL controller clock rate.<br>$f_{PC\_CLK}$ must always be less than 80 MHz.<br>00 = $f_{DACCLK}/f_{PC\_CLK} = 2$ .<br>01 = $f_{DACCLK}/f_{PC\_CLK} = 4$ .<br>10 = $f_{DACCLK}/f_{PC\_CLK} = 8$ .<br>11 = $f_{DACCLK}/f_{PC\_CLK} = 16$ . | 3       |
|                |               | 4     | PLL cross control enable     | Enables PLL cross-point controller.   | 1       |
|                |               | [3:2] | NO[1:0]                      | PLL VCO divider. These bits determine the ratio of the VCO output to the DACCLK frequencies.<br>00 = $f_{VCO}/f_{DACCLK} = 1$ .<br>01 = $f_{VCO}/f_{DACCLK} = 2$ .<br>10 = $f_{VCO}/f_{DACCLK} = 4$ .<br>11 = $f_{VCO}/f_{DACCLK} = 4$ .  | 10      |
|                |               | [1:0] | N1[1:0]                      | PLL loop divider. These bits determine the ratio of the DACCLK to the REFCLK frequencies.<br>00 = $f_{DACCLK}/f_{REFCLK} = 2$ .<br>01 = $f_{DACCLK}/f_{REFCLK} = 4$ .<br>10 = $f_{DACCLK}/f_{REFCLK} = 8$ .<br>11 = $f_{DACCLK}/f_{REFCLK} = 16$ .  | 01      |
| PLL Status 1   | 0x0E          | 7     | PLL lock                     | The PLL generated clock is tracking the REFCLK input signal.  | R       |
|                |               | [3:0] | VCO control voltage[3:0]     | VCO control voltage readback (see Table 25).  | R       |
| PLL Status 2   | 0x0F          | [5:0] | VCO band readback[5:0]       | Indicates the VCO band currently selected.  | R       |
| Sync Control 1 | 0x10          | 7     | Sync enable                  | 1 = enables the synchronization logic.  | 0       |
|                |               | 6     | Data/FIFO rate toggle        | 0 = operates the synchronization at the FIFO reset rate.<br>1 = operates the synchronization at the data rate.  | 1       |
|                |               | 3     | Rising edge sync             | 0 = sync is initiated on the falling edge of the sync input.<br>1 = sync is initiated on the rising edge of the sync input.   | 1       |
|                |               | [2:0] | Sync averaging[2:0]          | Sets the number of input samples that are averaged for determining the sync phase.<br>000 = 1.<br>001 = 2.<br>010 = 4.<br>011 = 8.<br>100 = 16.<br>101 = 32.  | 0       |



# AD9125

| Register Name    | Address (Hex) | Bits  | Name                                    | Description   | Default |
|------------------|---------------|-------|---|---|---------|
|                  |               |       |   | 110 = 64.<br>111 = 128.   |         |
| Sync Control 2   | 0x11          | 5:0   | Sync phase request[5:0]                 | This sets the requested clock phase offset after sync. The offset unit is in DACCLK cycles. This enables repositioning of the DAC output with respect to the sync input. The offset can also be used to skew the DAC outputs between the synchronized DACs.<br>000000 = 0 DACCLK cycles.<br>000001 = 1 DACCLK cycle.<br>...<br>111111 = 63 DACCLK cycles. | 0       |
| Sync Status 1    | 0x12          | 7     | Sync lost                               | 1 = indicates that synchronization had been attained but was subsequently lost.   | R       |
|                  |               | 6     | Sync locked                             | 1 = indicates that synchronization has been attained.   | R       |
| Sync Status 2    | 0x13          | [7:0] | Sync phase readback[7:0]                | Indicates the averaged sync phase offset (6.2 format). If the value differs from the requested sync phase value, this indicates sync timing errors.<br>00000000 = 0.0.<br>00000001 = 0.25.<br>...<br>11111110 = 63.50.<br>11111111 = 63.75.   | R       |
| FIFO Control     | 0x17          | [2:0] | FIFO phase offset[2:0]                  | FIFO write pointer phase offset following FIFO reset. This is the difference between the read pointer and the write pointer values upon FIFO reset. The optimal value is nominally 4.<br>000 = 0.<br>001 = 1.<br>...<br>111 = 7.  | 4       |
| FIFO Status 1    | 0x18          | 7     | FIFO Warning 1                          | FIFO read and write pointers within $\pm 1$ .   | 0       |
|                  |               | 6     | FIFO Warning 2                          | FIFO read and write pointers within $\pm 2$ .   | 0       |
|                  |               | 2     | FIFO soft align acknowledge             | FIFO read and write pointers are aligned after a serial port initiated FIFO reset.  |         |
|                  |               | 1     | FIFO soft align request                 | Request FIFO read and write pointers alignment via the serial port.   | 0       |
|                  |               | 0     | FIFO reset aligned                      | FIFO read and write pointers aligned after a hardware reset.  | 0       |
| FIFO Status 2    | 0x19          | [7:0] | FIFO level[7:0]                         | Thermometer encoded measure of the FIFO level.  | 0       |
| Datapath Control | 0x1B          | 7     | Bypass premod                           | 1 = bypasses $f_s/2$ premodulator.  | 1       |
|                  |               | 6     | Bypass sinc <sup>-1</sup>               | 1 = bypasses inverse sinc filter.   | 1       |
|                  |               | 5     | Bypass NCO                              | 1 = bypasses NCO.   | 1       |
|                  |               | 3     | NCO gain                                | 0 = default. No gain scaling is applied to the NCO input to the internal digital modulator.<br>1 = gain scaling of 0.5 is applied to the NCO input to the internal digital modulator. This can eliminate saturation of the modulator output for some combinations of data inputs and NCO signals.   | 0       |
|                  |               | 2     | Bypass phase compensation and dc offset | 1 = bypasses phase compensation and dc offset.  | 1       |

| Register Name | Address (Hex) | Bits  | Name                  | Description  | Default |
|---------------|---------------|-------|-----------------------|--|---------|
|               |               | 1     | Select sideband       | 0 = the modulator outputs high-side image.<br>1 = the modulator outputs low-side image. The image is spectrally inverted compared with the input data.   | 0       |
|               |               | 0     | Send I data to Q data | 1 = ignores Q data from the interface and disables the clocks to the Q datapath. Sends I data to both the I and Q DACs.  | 0       |
| HB1 Control   | 0x1C          | [2:1] | HB1[1:0]              | 00 = input signal is not modulated; filter pass band is from $-0.4$ to $+0.4$ of $f_{IN1}$ .<br>01 = input signal is not modulated; filter pass band is from $0.1$ to $0.9$ of $f_{IN1}$ .<br>10 = input signal is modulated by $f_{IN1}$ ; filter pass band is from $0.6$ to $1.4$ of $f_{IN1}$ .<br>11 = input signal is modulated by $f_{IN1}$ ; filter pass band is from $1.1$ to $1.9$ of $f_{IN1}$ .   | 0       |
|               |               | 0     | Bypass HB1            | 1 = bypasses first-stage interpolation filter.   | 0       |
| HB2 Control   | 0x1D          | [6:1] | HB2[5:0]              | Modulation mode for I Side Half-Band Filter 2.<br>000000 = input signal is not modulated; filter pass band is from $-0.25$ to $+0.25$ of $f_{IN2}$ .<br>001001 = input signal is not modulated; filter pass band is from $0.0$ to $0.5$ of $f_{IN2}$ .<br>010010 = input signal is not modulated; filter pass band is from $0.25$ to $0.75$ of $f_{IN2}$ .<br>011011 = input signal is not modulated; filter pass band is from $0.5$ to $1.0$ of $f_{IN2}$ .<br>100100 = input signal is modulated by $f_{IN2}$ ; filter pass band is from $0.75$ to $1.25$ of $f_{IN2}$ .<br>101101 = input signal is modulated by $f_{IN2}$ ; filter pass band is from $1.0$ to $1.5$ of $f_{IN2}$ .<br>110110 = input signal is modulated by $f_{IN2}$ ; filter pass band is from $1.25$ to $1.75$ of $f_{IN2}$ .<br>111111 = input signal is modulated by $f_{IN2}$ ; filter pass band is from $1.5$ to $2.0$ of $f_{IN2}$ . | 0       |
|               |               | 0     | Bypass HB2            | 1 = bypasses second stage interpolation filter.  | 0       |
| HB3 Control   | 0x1E          | [6:1] | HB3[5:0]              | Modulation mode for I Side Half-Band Filter 3.<br>000000 = input signal is not modulated; filter pass band is from $-0.2$ to $+0.2$ of $f_{IN3}$ .<br>001001 = input signal is not modulated; filter pass band is from $0.05$ to $0.45$ of $f_{IN3}$ .<br>010010 = input signal is not modulated; filter pass band is from $0.3$ to $0.7$ of $f_{IN3}$ .<br>011011 = input signal is not modulated; filter pass band is from $0.55$ to $0.95$ of $f_{IN3}$ .<br>100100 = input signal is modulated by $f_{IN3}$ ; filter pass band is from $0.8$ to $1.2$ of $f_{IN3}$ .<br>101101 = input signal is modulated by $f_{IN3}$ ; filter pass band is from $1.05$ to $1.45$ of $f_{IN3}$ .<br>110110 = input signal is modulated by $f_{IN3}$ ; filter pass band is from $1.3$ to $1.7$ of $f_{IN3}$ .<br>111111 = input signal is modulated by $f_{IN3}$ ; filter pass band is from $1.55$ to $1.95$ of $f_{IN3}$ . | 0       |
|               |               | 0     | Bypass HB3            | 1 = bypasses third-stage interpolation filter.   | 0       |
| Chip ID       | 0x1F          | [7:0] | Chip ID[7:0]          | This register identifies the device as an AD9125.  | 8       |

# AD9125

| Register Name        | Address (Hex) | Bits  | Name                   | Description  | Default |
|----------------------|---------------|-------|------------------------|--|---------|
| FTW 1 (LSB)          | 0x30          | [7:0] | FTW[7:0]               | FTW[31:0] is the 32-bit frequency tuning word that determines the frequency of the complex carrier generated by the on-chip NCO. The frequency is not updated when the FTW registers are written. The values are only updated when Bit 0 of Register 0x36 transitions from 0 to 1. | 0       |
| FTW 2                | 0x31          | [7:0] | FTW[15:8]              | See Register 0x30.   | 0       |
| FTW 3                | 0x32          | [7:0] | FTW[23:16]             | See Register 0x30.   | 0       |
| FTW 4 (MSB)          | 0x33          | [7:0] | FTW[31:24]             | See Register 0x30.   | 0       |
| NCO Phase Offset LSB | 0x34          | [7:0] | NCO phase offset[7:0]  | NCO phase offset[15:0] sets the phase of the complex carrier signal when the NCO is reset. The phase offset spans between 0° and 360°. Each bit represents an offset of 0.0055°. The value is in twos complement format.   | 0       |
| NCO Phase Offset MSB | 0x35          | [7:0] | NCO phase offset[15:8] | See Register 0x34.   | 0       |
| NCO FTW Update       | 0x36          | 5     | FRAME FTW acknowledge  | 1 = indicates that the NCO has been reset due to an extended FRAME pulse signal.   | 0       |
|                      |               | 4     | FRAME FTW request      | 0 → 1 = the NCO is reset on the first extended FRAME pulse after this bit transitions from 0 to 1.   | 0       |
|                      |               | 1     | Update FTW acknowledge | 1 = indicates that the FTW has been updated.   | 0       |
|                      |               | 0     | Update FTW request     | 0 → 1 = the FTW is updated on 0-to-1 transition of this bit.   | 0       |
| I Phase Adj LSB      | 0x38          | [7:0] | I phase adjust[7:0]    | I phase adjust[9:0] is used to insert a phase offset between the I and Q datapaths. This can be used to correct for phase imbalance in a quadrature modulator. See the Quadrature Phase Correction section for details.  | 0       |
| I Phase Adj MSB      | 0x39          | [1:0] | I phase adjust[9:8]    | Register 0x38.   | 0       |
| Q Phase Adj LSB      | 0x3A          | [7:0] | Q phase adjust[7:0]    | Q phase adjust[9:0] is used to insert a phase offset between the I and Q datapaths. This can be used to correct for phase imbalance in a quadrature modulator. See the Quadrature Phase Correction section for details.  | 0       |
| Q Phase Adj MSB      | 0x3B          | [1:0] | Q phase adjust[9:8]    | See Register 0x3A.   | 0       |
| I DAC Offset LSB     | 0x3C          | [7:0] | I DAC offset[7:0]      | I DAC offset[15:0] is a value added directly to the samples written to the I DAC.  | 0       |
| I DAC Offset MSB     | 0x3D          | [7:0] | I DAC offset[15:8]     | See Register 0x3C.   | 0       |
| Q DAC Offset LSB     | 0x3E          | [7:0] | Q DAC offset[7:0]      | Q DAC offset[15:0] is a value added directly to the samples written to the Q DAC.  | 0       |
| Q DAC Offset MSB     | 0x3F          | [7:0] | Q DAC offset[15:8]     | See Register 0x3E.   | 0       |
| I DAC FS Adjust      | 0x40          | [7:0] | I DAC FS adjust[7:0]   | I DAC FS adjust[9:0] sets the full-scale current of the I DAC. The full-scale current can be adjusted from 8.64 mA to 31.6 mA in step sizes of approximately 22.5 µA.<br>0x000 = 8.64 mA.<br>...<br>0x200 = 20.14 mA.<br>...<br>0x3FF = 31.66 mA.                                  | F9      |
| I DAC Control        | 0x41          | 7     | I DAC sleep            | 1 = puts the I-channel DAC into sleep mode (fast wake-up mode).  | 0       |
|                      |               | [1:0] | I DAC FS adjust[9:8]   | See Register 0x40.   | 1       |
| Aux DAC I Data       | 0x42          | [7:0] | I aux DAC[7:0]         | I aux DAC[9:0] sets the magnitude of the auxiliary DAC current. The range is 0 mA to 2 mA, and the step size is 2 µA.<br>0x000 = 0.000 mA.<br>0x001 = 0.002 mA.<br>...<br>0x3FF = 2.046 mA.  | 0       |

| Register Name          | Address (Hex) | Bits  | Name                        | Description  | Default |
|------------------------|---------------|-------|-----------------------------|--|---------|
| I Aux DAC Control      | 0x43          | 7     | I aux DAC sign              | 0 = the auxiliary DAC I sign is positive, and the current is directed to the IOUT1P pin (Pin 67).<br>1 = the auxiliary DAC I sign is negative, and the current is directed to the IOUT1N pin (Pin 66).   | 0       |
|                        |               | 6     | I aux DAC current direction | 0 = the auxiliary DAC I sources current.<br>1 = the auxiliary DAC I sinks current.   | 0       |
|                        |               | 5     | I aux DAC sleep             | I channel auxiliary DAC sleep.   | 0       |
|                        |               | [1:0] | I Aux DAC[9:8]              | See Register 0x42.   | 0       |
| Q DAC FS Adjust        | 0x44          | [7:0] | Q DAC FS adjust[7:0]        | Q DAC FS adjust[9:0] sets the full-scale current of the I DAC. The full-scale current can be adjusted from 8.64 mA to 31.6 mA in step sizes of approximately 22.5 $\mu$ A.<br>0x000 = 8.64 mA.<br>...<br>0x200 = 20.14 mA.<br>...<br>0x3FF = 31.66 mA. | F9      |
| Q DAC Control          | 0x45          | 7     | Q DAC sleep                 | 1 = puts the Q-channel DAC into sleep mode (fast wake-up mode).  | 0       |
|                        |               | [1:0] | Q DAC FS adjust[9:8]        | See Register 0x44.   | 1       |
| Aux DAC Q Data         | 0x46          | [7:0] | Q aux DAC[7:0]              | Q aux DAC[9:0] sets the magnitude of the aux DAC current. The range is 0 mA to 2 mA, and the step size is 2 $\mu$ A.<br>0x000 = 0.000 mA.<br>0x001 = 0.002 mA.<br>...<br>0x3FF = 2.046 mA.   | 0       |
| Q Aux DAC Control      | 0x47          | 7     | Q aux DAC sign              | 0 = the auxiliary DAC Q sign is positive, and the current is directed to the IOUT2P pin (Pin 58).<br>1 = the auxiliary DAC Q sign is negative, and the current is directed to the IOUT2N pin (Pin 59).   | 0       |
|                        |               | 6     | Q aux DAC current direction | 0 = the auxiliary DAC Q sources current.<br>1 = the auxiliary DAC Q sinks current.   | 0       |
|                        |               | 5     | Q aux DAC sleep             | Q-channel auxiliary DAC sleep  | 0       |
|                        |               | [1:0] | Q aux DAC[9:8]              | See Register 0x46.   | 0       |
| Die Temp Range Control | 0x48          | [6:4] | FS current[2:0]             | Auxiliary ADC full-scale current.<br>000 = lowest current.<br>...<br>111 = highest current.  | 0       |
|                        |               | [3:1] | Reference current[2:0]      | Auxiliary ADC reference current.<br>000 = lowest current.<br>111 = highest current.  | 1       |
|                        |               | 0     | Capacitor value             | Auxiliary ADC internal capacitor value.<br>0 = 5 pF.<br>1 = 10 pF.   | 0       |
| Die Temp LSB           | 0x49          | [7:0] | Die temp[7:0]               | Die Temp[15:0] indicates the approximate die temperature.<br>0xADCC = -39.9°C.<br>0xC422 = 25.1°C.<br>...<br>0xD8A8 = 84.8°C (see the Temperature Sensor section for details).   | R       |
| Die Temp MSB           | 0x4A          | [7:0] | Die temp[15:8]              | See Register 0x49.   | R       |

# AD9125

| Register Name   | Address (Hex) | Bits  | Name                         | Description   | Default |
|-----------------|---------------|-------|------------------------------|---|---------|
| SED Control     | 0x67          | 7     | SED compare enable           | 1 = enables the SED circuitry. None of the flags in this register or the values in Register 0x70 through Register 0x73 are significant if the SED is not enabled.   | 0       |
|                 |               | 5     | Sample error detected        | 1 = indicates an error is detected. The bit remains set until cleared. Any write to this register clears this bit to 0.   | 0       |
|                 |               | 3     | Autoclear enable             | 1 = enables autoclear mode. This activates Bit 1 and Bit 0 of this register and causes Register 0x70 through Register 0x73 to be autocleared whenever eight consecutive error-free sample data sets are received. | 0       |
|                 |               | 1     | Compare fail                 | 1 = indicates an error has been detected. This bit remains high until it is autocleared by the reception of eight consecutive error-free comparisons or until it is cleared by writing to this register.          | 0       |
|                 |               | 0     | Compare pass                 | 1 = indicates that the last sample comparison was error free.   | 0       |
| Compare I0 LSBs | 0x68          | [7:0] | Compare Value I0[7:0]        | Compare Value I0[15:0] is the word that is compared with the I0 input sample captured at the input interface.   | B6      |
| Compare I0 MSBs | 0x69          | [7:0] | Compare Value I0[15:8]       | See Register 0x68.  | 7A      |
| Compare Q0 LSBs | 0x6A          | [7:0] | Compare Value Q0[7:0]        | Compare Value Q0[15:0] is the word that is compared with the Q0 input sample captured at the input interface.   | 45      |
| Compare Q0 MSBs | 0x6B          | [7:0] | Compare Value Q0[15:8]       | See Register 0x6A   | EA      |
| Compare I1 LSBs | 0x6C          | [7:0] | Compare Value I1[7:0]        | Compare Value I1[15:0] is the word that is compared with the I1 input sample captured at the input interface.   | 16      |
| Compare I1 MSBs | 0x6D          | [7:0] | Compare Value I1[15:8]       | See Register 0x6C.  | 1A      |
| Compare Q1 LSBs | 0x6E          | [7:0] | Compare Value Q1[7:0]        | Compare Value Q1[15:0] is the word that is compared with the Q1 input sample captured at the input interface.   | C6      |
| Compare Q1 MSBs | 0x6F          | [7:0] | Compare Value Q1[15:8]       | See Register 0x6E.  | AA      |
| SED I LSBs      | 0x70          | [7:0] | Errors Detected I_BITS[7:0]  | Errors detected I_BITS[15:0] indicates which bits were received in error.   | 0       |
| SED I MSBs      | 0x71          | [7:0] | Errors detected I_BITS[15:8] | See Register 0x70.  | 0       |
| SED Q LSBs      | 0x72          | [7:0] | Errors detected Q_BITS[7:0]  | Errors detected Q_BITS[15:0] indicates which bits were received in error.   | 0       |
| SED Q MSBs      | 0x73          | [7:0] | Errors detected Q_BITS[15:8] | See Register 0x72.  | 0       |
| Die Revision    | 0x7F          | [5:2] | Revision[3:0]                | Corresponds to device die revision.   | 3       |

<sup>1</sup> All bit event flags are cleared by writing the respective bit high.

## CMOS INPUT DATA PORTS

The AD9125 input data port consists of a data clock (DCI), data bus, and FRAME signal. The data port can be configured to operate in three modes: dual-word mode, word mode, and byte mode.

In dual-word mode, I and Q data is received simultaneously on two 16-pin buses. One bus receives I datapath input words, and the other bus receives Q datapath input words. In word mode, one 16-pin bus is used to receive interleaved I and Q input words. In byte mode, an 8-pin bus is used to receive interleaved I and Q input bytes. The pin assignments of the bus in each mode is described in Table 12.

**Table 12. Data Bit Pin Assignments for Data Input Modes**

| Mode      | Data Bus Pin Assignments  |
|-----------|---|
| Dual Word | I data: D[31:16]<br>Q data: D[15:0]   |
| Word      | I and Q data: D[29:28], D[25:24], D[21:20], D[17:16],<br>D[15:14], D[11:10], D[7:6], D[3:2] |
| Byte      | I and Q data: D[21:20], D[17:16], D[15:14], D[11:10]  |

In byte and word modes, a FRAME signal is required for controlling which DAC receives the data. In dual-word mode, the FRAME signal is not required because each DAC has a dedicated bus.

### DUAL-WORD MODE

In dual-word mode, the DCI signal is supplied as a qualifying clock that is time aligned with the input data. The rising edge of the DCI signal should be aligned with the changing data of each of the I and Q input data streams.

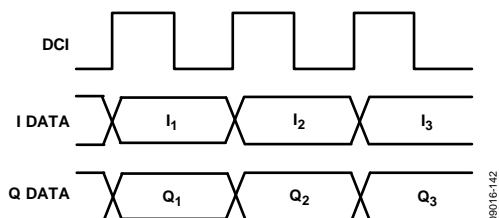


Figure 42. Timing Diagram for Dual-Word Mode

### WORD MODE

In word mode, the DCI signal is supplied as a qualifying clock that is time aligned with the input data. The rising edge of the DCI signal should be aligned with the changing data of the interleaved I and Q input data stream. The FRAME signal indicates to which DAC the data is sent. When FRAME is high, data is sent to the I DAC. When FRAME is low, data is sent to the Q DAC. For 14- and 12-bit resolution devices, the two and four LSBs are not significant, respectively. The complete timing diagram is shown in Figure 43.

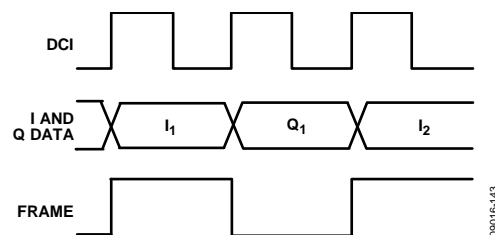


Figure 43. Timing Diagram for Word Mode

### BYTE MODE

In byte mode, the DCI signal is supplied as a qualifying clock that is time aligned with the input data. The rising edge of the DCI signal should be aligned with the changing data of the interleaved I and Q input data stream. The FRAME signal indicates to which DAC the data is sent. When FRAME is high, data is sent to the I DAC. When FRAME is low, data is sent to the Q DAC. Both bytes must be written to each datapath for proper operation. For 14- and 12-bit resolution devices, the LSBs in the second byte are not significant. The complete timing diagram is shown in Figure 44.

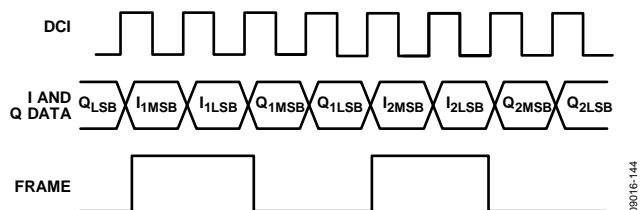
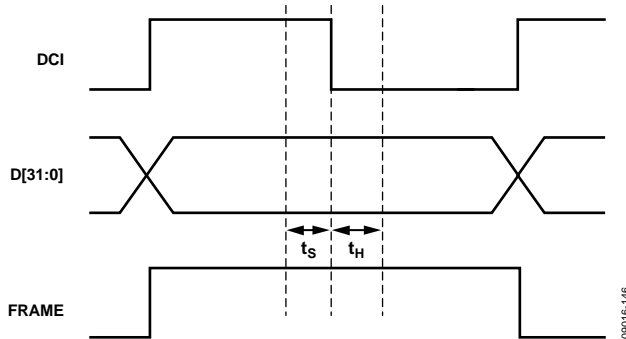


Figure 44. Timing Diagram for Byte Mode

## INTERFACE TIMING

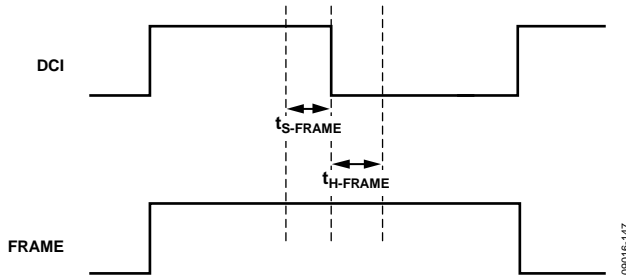
The timing diagram for the digital interface port is shown in Figure 45. The sampling point of the data bus occurs on the falling edge of the DCI signal and has an uncertainty of 2.1 ns, as illustrated by the sampling interval shown in Figure 45. The D[31:0] and FRAME signals must be valid throughout this sampling interval.

The setup ( $t_s$ ) and hold ( $t_H$ ) times with respect to the edges are shown in Figure 45. The minimum setup and hold times are shown in Table 13.



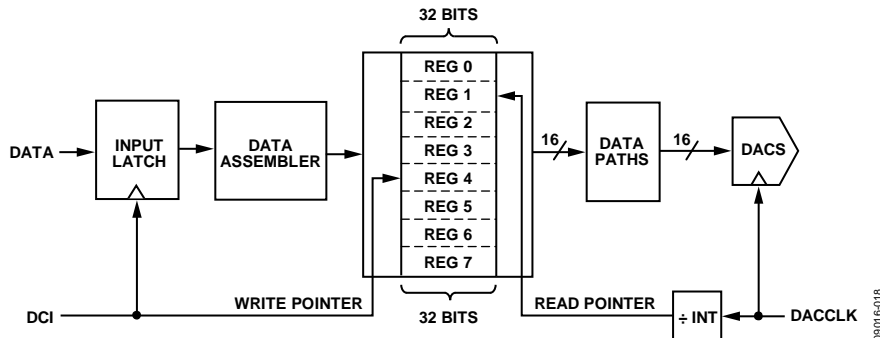
**Table 13. Data Port Setup and Hold Times**

| Minimum Setup Time, $t_s$ (ns) | Minimum Hold Time, $t_H$ (ns) |
|--------------------------------|-------------------------------|
| 0.86                           | 1.24                          |



**Table 14. FRAME Setup and Hold Times**

| Minimum Setup Time, $t_{s\_FRAME}$ (ns) | Minimum Hold Time, $t_{H\_FRAME}$ (ns) |
|---|--|
| -0.04                                   | +1.05                                  |



The data interface timing can be verified by using the sample error detection (SED) circuitry. See the Interface Timing Validation section for details.

## FIFO OPERATION

The AD9125 contains a 2-channel, 16-bit wide, eight-word-deep FIFO designed to relax the timing relationship between the data arriving at the DAC input ports and the internal DAC data rate clock. The FIFO acts as a buffer that absorbs timing variations between the data source and DAC, such as the clock-to-data variation of an FPGA or ASIC, which significantly increases the timing budget of the interface.

Figure 47 shows the block diagram of the datapath through the FIFO. The data is latched into the device and is formatted, and then it is written into the FIFO register determined by the FIFO write pointer. The value of the write pointer is incremented every time a new word is loaded into the FIFO. Meanwhile, data is read from the FIFO register determined by the read pointer and fed into the digital datapath. The value of the read pointer is updated every time data is read into the datapath from the FIFO. This happens at the data rate, that is, the DACCLK rate divided by the interpolation ratio.

Valid data is transmitted through the FIFO as long as the FIFO does not overflow or become empty. Note that an overflow or empty condition of the FIFO is the same as the write pointer and read pointer being equal. When both pointers are equal, an attempt is made to read and write a single FIFO register simultaneously. This simultaneous register access leads to unreliable data transfer through the FIFO and must be avoided.

Nominally, data is written to the FIFO at the same rate that data is read from the FIFO, which keeps the data level in the FIFO constant. If data is written to the FIFO faster than data is read, the data level in the FIFO increases. If data is written to the device slower than data is read, the data level in the FIFO decreases. For an optimum timing margin, the FIFO level should be maintained near half full, which is the same as maintaining a difference of four between the write pointer and read pointer values.

### Initializing the FIFO Data Level

To avoid a concurrent read and write to the same FIFO address and to ensure a fixed pipeline delay, it is important to initialize the FIFO pointers to known states. The FIFO pointers can be initialized in two ways: via a write sequence to the serial port or by strobing the FRAME input. There are two types of FIFO pointer resets: a relative reset and an absolute reset. A relative reset enforces a defined FIFO depth. An absolute reset enforces a particular write pointer value when the reset is initiated. A serial port initiated FIFO reset is always a relative reset. A FRAME strobe initiated reset can be either a relative or an absolute reset.

The operation of the FRAME initiated FIFO reset depends on the synchronization mode chosen. When synchronization is disabled or when the device is configured for data rate mode synchronization, the FRAME strobe initiates a relative FIFO reset. When FIFO mode synchronization is chosen, the FRAME strobe initiates an absolute FIFO reset. More details on the synchronization function can be found in the Multichip Synchronization section.

A summary of the synchronization modes and the type of FIFO reset employed is listed in Table 15.

**Table 15. Summary of FIFO Resets**

| FIFO Reset Signal | Synchronization Mode |                |                |
|-------------------|----------------------|----------------|----------------|
|                   | Disabled             | Data Rate      | FIFO Rate      |
| Serial Port       | Relative reset       | Relative reset | Relative reset |
| FRAME             | Relative reset       | Relative reset | Absolute reset |

### FIFO Level Initialization via Serial Port

A serial port initiated FIFO reset can be issued in any mode and always results in a relative FIFO reset. To initialize the FIFO data level through the serial port, Bit 1 of Register 0x18 should be toggled from 0 to 1 and then back to 0. When the write to the register is complete, the FIFO data level is initialized. When the initialization is triggered, the next time the read pointer becomes 0, the write pointer is set to the value of the FIFO phase offset level (Register 0x17, Bits[2:0]) variable upon initialization. By default, this is 4, but it can be programmed to a value between 0 and 7.

The recommended procedure for a serial port FIFO data level initialization is as follows:

1. Request FIFO level reset by setting Register 0x18, Bit 1, to 1.
2. Verify that the part acknowledges the request by ensuring that Register 0x18, Bit 2, is 1.
3. Remove the request by setting Register 0x18, Bit 1, to 0.
4. Verify that the part drops the acknowledge signal by ensuring that Register 0x18, Bit 2, is 0.

### FIFO Level Initialization via FRAME Signal

The primary function of the FRAME input is indicating to which DAC the input data is written. Another function of the FRAME input is initializing the FIFO data level value. This is done by asserting the FRAME signal high for at least the time interval needed to load complete data to the I and Q DACs. This

corresponds to one DCI period in dual-word mode, two DCI periods in word mode, and four DCI periods in byte mode.

To initiate a relative FIFO reset with the FRAME signal, the device must be configured in data rate mode (Register 0x10, Bit 6). When FRAME is asserted in data rate mode, the write pointer is set to 4 (by default or to the FIFO start level) the next time the read pointer becomes 0 (see Figure 48).

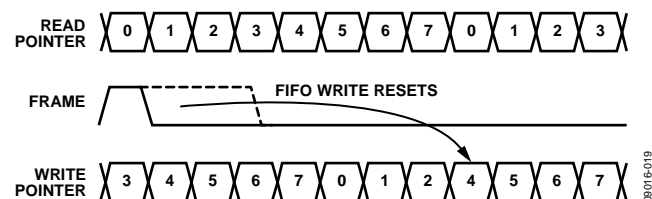


Figure 48. FRAME Input vs. Write Pointer Value, Data Rate Mode

### Write Pointer Initialization via FRAME Signal

In FIFO rate synchronization mode, the REFCLK/SYNC signal is used to reset the FIFO read pointer to 0. The edge of the DAC clock used to sample the SYNC signal is selected by Bit 3 of Register 0x10. The FRAME signal is used to reset the FIFO write pointer. In the FIFO rate synchronization mode, the FIFO write pointer is reset immediately after the FRAME signal is asserted high for at least the time interval needed to load complete data to the I and Q DACs. The FIFO write pointer is initialized to the value of the FIFO phase offset[2:0] (Register 0x17). FIFO rate synchronization is selected by setting Bit 6 of Register 0x10 to 0.

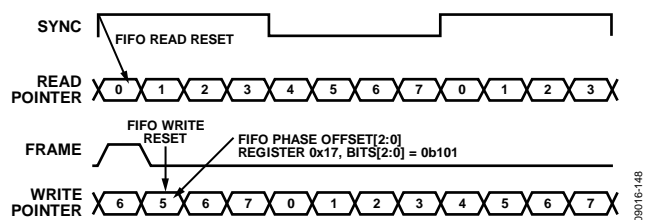


Figure 49. FRAME Input vs. Write Pointer Value, FIFO Rate Mode

### Monitoring the FIFO Status

The FIFO initialization and status can be read from Register 0x18. This register provides information on the FIFO initialization method and whether the initialization was successful. The MSB of Register 0x18 is a FIFO warning flag that can optionally trigger a device interrupt (IRQ). This flag is an indication that the FIFO is close to emptying (FIFO level is 1) or overflowing (FIFO level is 7). This is an indication that data may soon be corrupted and action should be taken.

The FIFO data level can be read from Register 0x19 at any time. The FIFO data level reported by the serial port is denoted as a 7-bit thermometer code of the write counter state relative to the absolute read counter being at 0. The optimum FIFO data level of 4 is, therefore, reported as a value of 00001111 in the status register. It should be noted that, depending on the timing relationship between DCI and the main DACCLK, the FIFO level value can be off by  $\pm 1$  count. Therefore, it is important to keep the difference between the read and write pointers to at least 2.



## DIGITAL DATAPATH

The block diagram in Figure 50 shows the functionality of the digital datapath. The digital processing includes a premodulation block, three half-band interpolation filters, a quadrature modulator with a fine resolution NCO, a phase and offset adjustment block, and an inverse sinc filter.

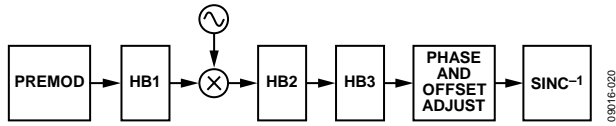


Figure 50. Block Diagram of Digital Datapath

The digital datapath accepts I and Q data streams and processes them as a quadrature data stream. The signal processing blocks can be used when the input data stream is represented as complex data.

The datapath can be used to process an input data stream representing two independent real data streams as well, but the functionality is somewhat restricted. The premodulation block can be used, as well as any of the nonshifted interpolation filter modes (see the Premodulation section for more details).

### PREMODULATION

The half-band interpolation filters have selectable pass bands that allow the center frequencies to be moved in increments of  $\frac{1}{2}$  of their input data rate. The premodulation block provides a digital upconversion of the incoming waveform by  $\frac{1}{2}$  of the incoming data rate,  $f_{DATA}$ . This can be used to frequency-shift baseband input data to the center of the interpolation filters' pass band.

### INTERPOLATION FILTERS

The transmit path contains three interpolation filters. Each of the three interpolation filters provides a  $2\times$  increase in output data rate. The half-band (HB) filters can be individually bypassed or cascaded to provide  $1\times$ ,  $2\times$ ,  $4\times$ , or  $8\times$  interpolation ratios. Each of the half-band filter stages offers a different combination of bandwidths and operating modes.

The bandwidth of the three half-band filters with respect to the data rate at the filter input is as follows:

- Bandwidth of HB1 =  $0.8 \times f_{IN1}$
- Bandwidth of HB2 =  $0.5 \times f_{IN2}$
- Bandwidth of HB3 =  $0.4 \times f_{IN3}$

The usable bandwidth is defined as the frequency over which the filters have a pass-band ripple of less than  $\pm 0.001$  dB and an image rejection of greater than +85 dB. As is discussed in the Half-Band Filter 1 (HB1) section, the image rejection usually sets the usable bandwidth of the filter, not the pass-band flatness.

The half-band filters operate in several modes, providing programmable pass-band center frequencies as well as signal modulation. The HB1 filter has four modes of operation, and the HB2 and HB3 filters each have eight modes of operation.

### Half-Band Filter 1 (HB1)

HB1 has four modes of operation, as shown in Figure 51. The shape of the filter response is identical in each of the four modes. The four modes are distinguished by two factors: the filter center frequency and whether the input signal is modulated by the filter.

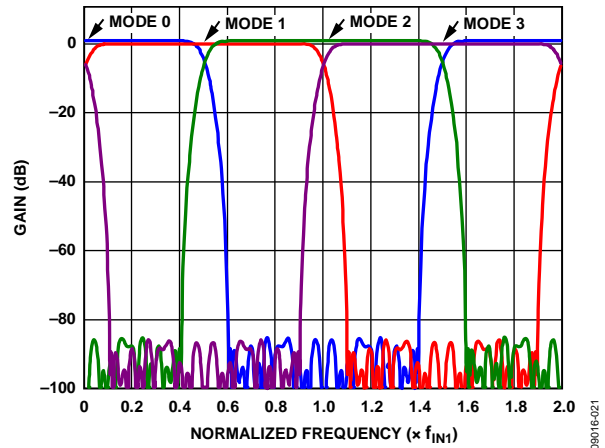


Figure 51. HB1 Filter Modes

As shown in Figure 51, the center frequency in each mode is offset by  $\frac{1}{2}$  the input data rate ( $f_{IN1}$ ) of the filter. Mode 0 and Mode 1 do not modulate the input signal. Mode 2 and Mode 3 modulate the input signal by  $f_{IN1}$ . When HB1 operates in Mode 0 and Mode 2, the I and Q paths operate independently and no mixing of the data between channels occurs. When HB1 operates in Mode 1 and Mode 3, mixing of the data between the I and Q paths occurs; therefore, the data input into the filter is assumed complex. Table 16 summarizes the HB1 modes.

Table 16. HB1 Filter Mode Summary

| Mode | $f_{CENTER}$ | $f_{MOD}$ | Input Data      |
|------|--------------|-----------|-----------------|
| 0    | DC           | None      | Real or complex |
| 1    | $f_{IN}/2$   | None      | Complex         |
| 2    | $f_{IN}$     | $f_{IN}$  | Real or complex |
| 3    | $3f_{IN}/2$  | $f_{IN}$  | Complex         |

Figure 52 shows the pass-band filter response for HB1. In most applications, the usable bandwidth of the filter is limited by the image suppression provided by the stop-band rejection, not by the pass-band flatness. Table 17 shows the pass-band flatness and stop-band rejection that the HB1 filter supports at different bandwidths.

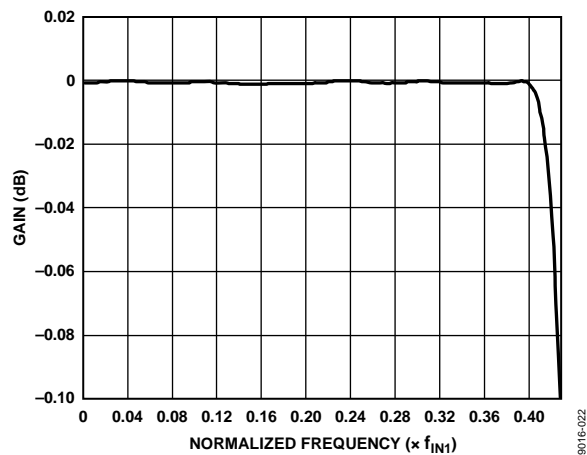


Figure 52. Pass-Band Detail of HB1

Table 17. HB1 Pass-Band Flatness and Stop-Band Rejection

| Bandwidth (% of $f_{IN1}$ ) | Pass-Band Flatness (dB) | Stop-Band Rejection (dB) |
|-----------------------------|-------------------------|--------------------------|
| 80                          | 0.001                   | 85                       |
| 80.4                        | 0.0012                  | 80                       |
| 81.2                        | 0.0033                  | 70                       |
| 82.0                        | 0.0076                  | 60                       |
| 83.6                        | 0.0271                  | 50                       |
| 85.6                        | 0.1096                  | 40                       |

### Half-Band Filter 2 (HB2)

HB2 has eight modes of operation, as shown in Figure 53 and Figure 54. The shape of the filter response is identical in each of the eight modes. The eight modes are distinguished by two factors: the filter center frequency and whether the input signal is modulated by the filter.

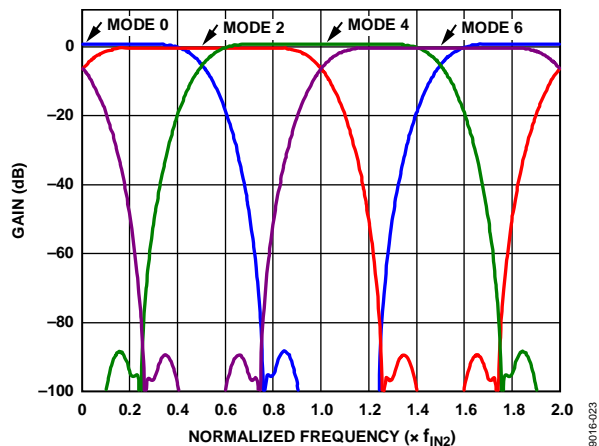


Figure 53. HB2, Even Filter Modes

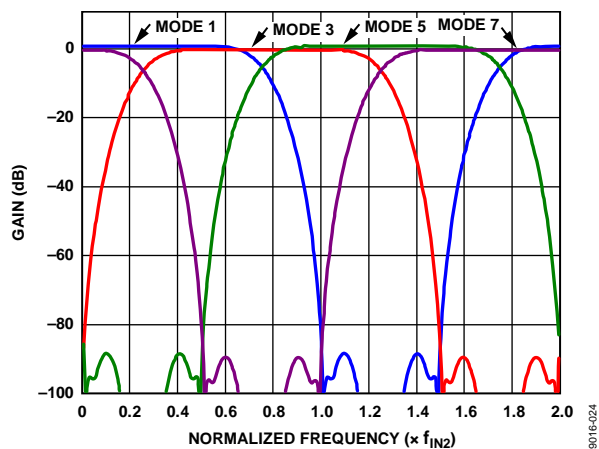


Figure 54. HB2, Odd Filter Modes

As shown in Figure 53 and Figure 54, the center frequency in each mode is offset by  $\frac{1}{4}$  of the input data rate ( $f_{IN2}$ ) of the filter. Mode 0 through Mode 3 do not modulate the input signal. Mode 4 through Mode 7 modulate the input signal by  $f_{IN2}$ . When HB2 operates in Mode 0 and Mode 4, the I and Q paths operate independently and no mixing of the data between channels occurs. When HB2 operates in the other six modes, mixing of the data between the I and Q paths occurs; therefore, the data input to the filter is assumed complex.

Table 18 summarizes the HB2 and HB3 modes.

**Table 18. HB2 and HB3 Filter Mode Summary**

| Mode | f <sub>CENTER</sub> | f <sub>MOD</sub> | Input Data      |
|------|---------------------|------------------|-----------------|
| 0    | DC                  | None             | Real or complex |
| 1    | f <sub>IN</sub> /4  | None             | Complex         |
| 2    | f <sub>IN</sub> /2  | None             | Complex         |
| 3    | 3f <sub>IN</sub> /4 | None             | Complex         |
| 4    | f <sub>IN</sub>     | f <sub>IN</sub>  | Real or complex |
| 5    | 5f <sub>IN</sub> /4 | f <sub>IN</sub>  | Complex         |
| 6    | 6f <sub>IN</sub> /4 | f <sub>IN</sub>  | Complex         |
| 7    | 7f <sub>IN</sub> /4 | f <sub>IN</sub>  | Complex         |

Figure 55 shows the pass-band filter response for HB2. In most applications, the usable bandwidth of the filter is limited by the image suppression provided by the stop-band rejection, not by the pass-band flatness. Table 19 shows the pass-band flatness and stop-band rejection that the HB2 filter supports at different bandwidths.

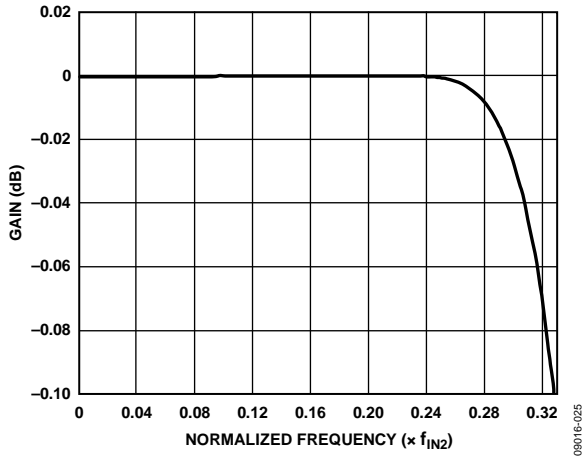


Figure 55. Pass-Band Detail of HB2

**Table 19. HB2 Pass-Band Flatness and Stop-Band Rejection**

| Complex Bandwidth (% of f <sub>IN2</sub> ) | Pass-Band Flatness (dB) | Stop-Band Rejection (dB) |
|--|-------------------------|--------------------------|
| 50   | 0.001                   | 85                       |
| 50.8                                       | 0.0012                  | 80                       |
| 52.8                                       | 0.0028                  | 70                       |
| 56.0                                       | 0.0089                  | 60                       |
| 60   | 0.0287                  | 50                       |
| 64.8                                       | 0.1877                  | 40                       |

## Half-Band Filter 3 (HB3)

HB3 has eight modes of operation that function the same as HB2. The primary difference between HB2 and HB3 is the filter bandwidths.

Figure 56 shows the pass-band filter response for HB3. In most applications, the usable bandwidth of the filter is limited by the image suppression provided by the stop-band rejection, not by the pass-band flatness. Table 20 shows the pass-band flatness and stop-band rejection that the HB3 filter supports at different bandwidths.

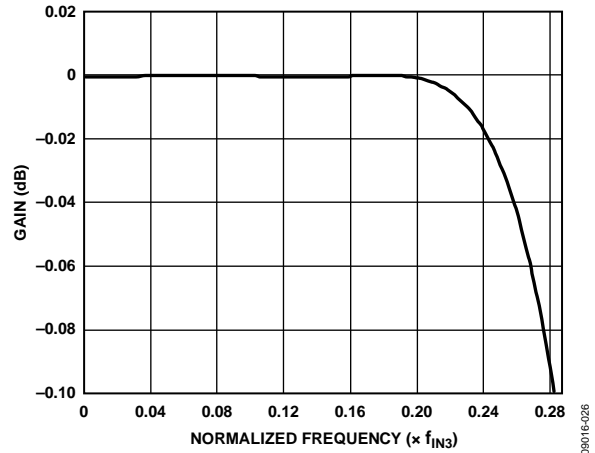


Figure 56. Pass-Band Detail of HB3

**Table 20. HB3 Pass-Band Flatness and Stop-Band Rejection**

| Complex Bandwidth (% of f <sub>IN3</sub> ) | Pass-Band Flatness (dB) | Stop-Band Rejection (dB) |
|--|-------------------------|--------------------------|
| 40   | 0.001                   | 85                       |
| 40.8                                       | 0.0014                  | 80                       |
| 42.4                                       | 0.002                   | 70                       |
| 45.6                                       | 0.0093                  | 60                       |
| 49.8                                       | 0.03                    | 50                       |
| 55.6                                       | 0.1                     | 40                       |

## NCO MODULATION

The digital quadrature modulator makes use of a numerically controlled oscillator, a phase shifter, and a complex modulator to provide a means for modulating the signal by a programmable carrier signal. A block diagram of the digital modulator is shown in Figure 57. The fine modulation provided by the digital modulator, in conjunction with the coarse modulation of the interpolation filters and premodulation block, allows the signal to be placed anywhere in the output spectrum with very fine frequency resolution.

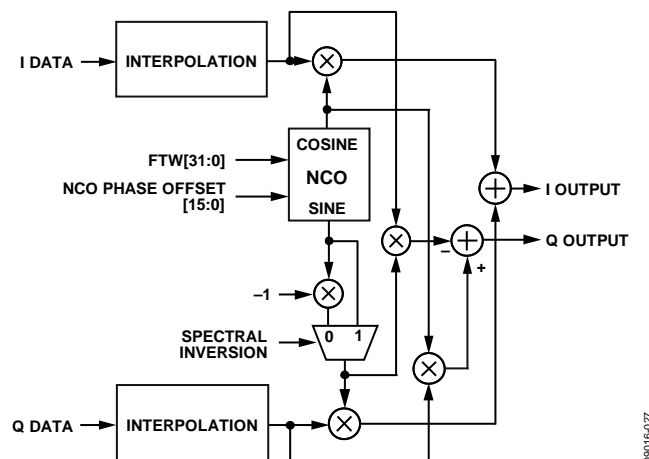


Figure 57. Digital Quadrature Modulator Block Diagram

The quadrature modulator is used to mix the carrier signal generated by the NCO with the I and Q signal. The NCO produces a quadrature carrier signal to translate the input signal to a new center frequency. A complex carrier signal is a pair of sinusoidal waveforms of the same frequency, offset 90° from each other. The frequency of the complex carrier signal is set via FTW[31:0] in Register 0x30 through Register 0x33.

The NCO operating frequency,  $f_{NCO}$ , is at either  $f_{DATA}$  (HB1 bypassed) or twice  $f_{DATA}$  (HB1 enabled). The frequency of the complex carrier signal can be set from dc up to  $f_{NCO}$ . The frequency tuning word (FTW) is calculated as

$$FTW = \frac{f_{CARRIER}}{f_{NCO}} \times 2^{32}$$

The generated quadrature carrier signal is mixed with the I and Q data. The quadrature products are then summed into the I and Q datapaths, as shown in Figure 57.

### Updating the Frequency Tuning Word

The frequency tuning word registers do not update immediately upon writing as other configuration registers. After loading the FTW registers with the desired values, Bit 0 of Register 0x36 must transition from 0 to 1 for the new FTW to take effect.

## DATAPATH CONFIGURATION

Configuring the AD9125 datapath starts with the application requirements of the input data rate, the interpolation ratio, the output signal bandwidth, and the output signal center frequency.

Given these four parameters, the first step in configuring the datapath is to verify that the device supports the bandwidth requirements. The modes of the interpolation filters are then chosen. Finally, any additional frequency offset requirements are determined and applied with premodulation and NCO modulation.

### Determining Datapath Signal Bandwidth

The available signal bandwidth of the datapath is dependent on the center frequency of the output signal in relation to the center frequency of the interpolation filters used. Signal center frequencies that are offset from the center frequencies of the half-band filters lower the available signal bandwidth.

When correctly configured, the available complex signal bandwidth for 2× interpolation is always 80% of the input data rate. The available signal bandwidth for 4× interpolation vs. output frequency varies between 50% and 80% of the input data rate, as shown in Figure 58. Note that in 4× interpolation mode,  $f_{DAC} = 4 \times f_{DATA}$ ; therefore, the data shown in Figure 58 repeats four times from dc to  $f_{DAC}$ .

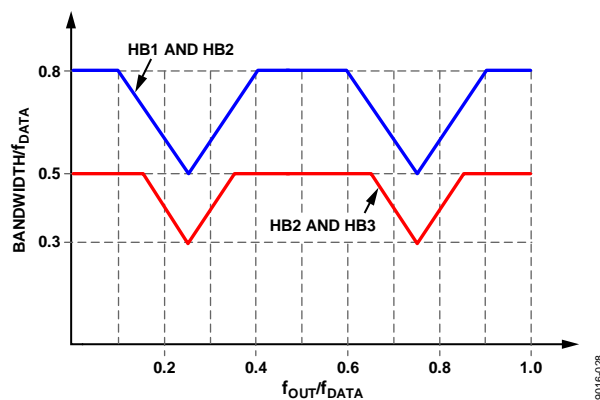


Figure 58. Signal Bandwidth vs. Center Frequency of the Output Signal, 4× Interpolation

Configuring 4× interpolation using the HB2 and HB3 filters can lower the power consumption of the device at the expense of reduced bandwidth. The lower curve in Figure 58 shows that the supported bandwidth in this mode varies from 30% to 50% of  $f_{DATA}$ .

The available signal bandwidth for 8× interpolation vs. output frequency varies between 50% and 80% of the input data rate, as shown in Figure 59. Note that in 8× interpolation mode,  $f_{DAC} = 8 \times f_{DATA}$ ; therefore, the data shown in Figure 59 repeats eight times from dc to  $f_{DAC}$ .

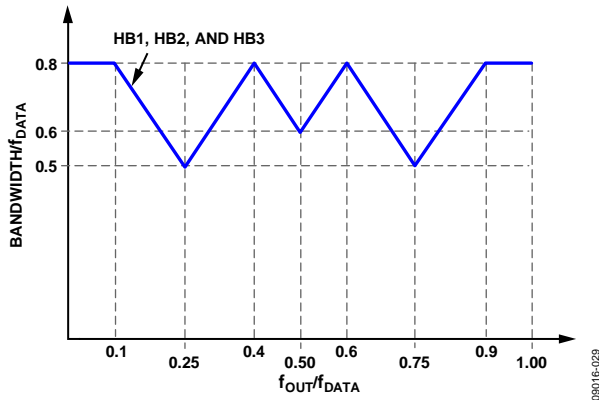


Figure 59. Signal Bandwidth vs. Center Frequency of the Output Signal, 8x Interpolation

## DETERMINING INTERPOLATION FILTER MODES

Table 21 shows the recommended interpolation filter settings for a variety of filter interpolation factors, filter center frequencies, and signal modulation. The interpolation modes were chosen based on the final center frequency of the signal and by determining the frequency shift of the signal required. When these are known and put in terms of the input data rate ( $f_{DATA}$ ), the filter configuration that comes closest to matching should be chosen from Table 21.

Table 21. Recommended Interpolation Filter Modes (Register 0x1C through Register 0x1E)

| Interpolation Factor | Filter Modes |          |          | $f_{SIGNAL}$ Modulation | $f_{CENTER}$ Shift     |
|----------------------|--------------|----------|----------|-------------------------|------------------------|
|                      | HB1[1:0]     | HB2[5:0] | HB3[5:0] |                         |                        |
| 8                    | 00 (0)       | 000000   | 000000   | DC                      | 0                      |
| 8                    | 01 (1)       | 001001   | 000000   | DC <sup>1</sup>         | $f_{DATA}/2$           |
| 8 <sup>2</sup>       | 10 (2)       | 010010   | 001001   | $f_{DATA}$              | $f_{DATA}$             |
| 8                    | 11 (3)       | 011011   | 001001   | $f_{DATA}^1$            | $3 \times f_{DATA}/2$  |
| 8                    | 00 (0)       | 100100   | 010010   | $2 \times f_{DATA}$     | $2 \times f_{DATA}$    |
| 8                    | 01 (1)       | 101101   | 010010   | $2 \times f_{DATA}^1$   | $5 \times f_{DATA}/2$  |
| 8                    | 10 (2)       | 110110   | 011011   | $3 \times f_{DATA}$     | $3 \times f_{DATA}$    |
| 8                    | 11 (3)       | 111111   | 011011   | $3 \times f_{DATA}^1$   | $7 \times f_{DATA}/2$  |
| 8                    | 00 (0)       | 000000   | 100100   | $4 \times f_{DATA}$     | $4 \times f_{DATA}$    |
| 8                    | 01 (1)       | 001001   | 100100   | $4 \times f_{DATA}^1$   | $9 \times f_{DATA}/2$  |
| 8                    | 10 (2)       | 010010   | 101101   | $5 \times f_{DATA}$     | $5 \times f_{DATA}$    |
| 8                    | 11 (3)       | 011011   | 101101   | $5 \times f_{DATA}^1$   | $11 \times f_{DATA}/2$ |
| 8                    | 00 (0)       | 100100   | 110110   | $6 \times f_{DATA}$     | $6 \times f_{DATA}$    |
| 8                    | 01 (1)       | 101101   | 110110   | $6 \times f_{DATA}^1$   | $13 \times f_{DATA}/2$ |
| 8                    | 10 (2)       | 110110   | 111111   | $7 \times f_{DATA}$     | $7 \times f_{DATA}$    |
| 8                    | 11 (3)       | 111111   | 111111   | $7 \times f_{DATA}^1$   | $15 \times f_{DATA}/2$ |
| 4                    | 00 (0)       | 000000   | Bypass   | DC                      | 0                      |
| 4 <sup>3</sup>       | 01 (1)       | 001001   | Bypass   | DC <sup>1</sup>         | $f_{DATA}/2$           |
| 4                    | 10 (2)       | 010010   | Bypass   | $f_{DATA}$              | $f_{DATA}$             |
| 4                    | 11 (3)       | 011011   | Bypass   | $f_{DATA}^1$            | $3 \times f_{DATA}/2$  |
| 4                    | 00 (0)       | 100100   | Bypass   | $2 \times f_{DATA}$     | $2 \times f_{DATA}$    |
| 4                    | 01 (1)       | 101101   | Bypass   | $2 \times f_{DATA}^1$   | $5 \times f_{DATA}/2$  |
| 4                    | 10 (2)       | 110110   | Bypass   | $3 \times f_{DATA}$     | $3 \times f_{DATA}$    |
| 4                    | 11 (3)       | 111111   | Bypass   | $3 \times f_{DATA}^1$   | $7 \times f_{DATA}/2$  |
| 2                    | 00 (0)       | Bypass   | Bypass   | DC                      | 0                      |
| 2                    | 01 (1)       | Bypass   | Bypass   | DC <sup>1</sup>         | $f_{DATA}/2$           |
| 2                    | 10 (2)       | Bypass   | Bypass   | $f_{DATA}$              | $f_{DATA}$             |
| 2                    | 11 (3)       | Bypass   | Bypass   | $f_{DATA}^1$            | $3 \times f_{DATA}/2$  |

<sup>1</sup> When HB1 Mode 1 or Mode 3 is used, enabling premodulation provides an addition frequency translation of the input signal by  $f_{DATA}/2$ , which centers a baseband input signal in the filter pass band.

<sup>2</sup> This configuration was used in the 8x interpolation without NCO example. In addition, see the 8x Interpolation Without NCO section.

<sup>3</sup> This configuration was used in the 4x interpolation with NCO example. In addition, see the 4x Interpolation with NCO section

**DATAPATH CONFIGURATION EXAMPLE**

**8× Interpolation Without NCO**

Given the following conditions, the desired 75 MHz of bandwidth is 75% of  $f_{DATA}$ :

- $f_{DATA} = 100$  MSPS
- 8× interpolation
- $f_{BW} = 75$  MHz
- $f_{CENTER} = 100$  MHz

In this case, the ratio of  $f_{OUT}/f_{DATA} = 100/100 = 1.0$ . From Figure 59, the bandwidth supported at  $f_{DATA}$  is 0.8, which verifies that the AD9125 supports the bandwidth required in this configuration.

The signal center frequency is  $f_{DATA}$ , and assuming the input signal is at baseband, the frequency shift required is also  $f_{DATA}$ . Using the settings detailed in the third row of the IF column from Table 21 (these settings use the configuration in the 8× interpolation without NCO example) selects filter modes that result in a center frequency of  $f_{DATA}$  and a frequency translation of  $f_{DATA}$ . The selected modes for the three half-band filters are HB1, Mode 2; HB2, Mode 2; and HB3, Mode 1. Figure 60 shows how the signal propagates through the interpolation filters.

Because  $2 \times f_{IN1} = f_{IN2}$  and  $2 \times f_{IN2} = f_{IN3}$ , the signal appears frequency scaled by  $\frac{1}{2}$  into each consecutive stage. The output signal band spans 0.15 to 0.35 of  $f_{IN3}$  (400 MHz). Therefore, the output frequency supported is 60 MHz to 140 MHz, which covers the 75 MHz bandwidth centered at 100 MHz, as desired.

**4× Interpolation with NCO**

Given the following conditions, the desired 140 MHz of bandwidth is 56% of  $f_{DATA}$ :

- $f_{DATA} = 250$  MSPS
- 4× interpolation
- $f_{BW} = 140$  MHz
- $f_{CENTER} = 175$  MHz

As shown in Figure 58, the value at  $0.7 \times f_{DATA}$  is 0.6. This is calculated as  $0.8 - 2(0.7 - 0.6) = 0.6$ . Therefore, the AD9125 supports a bandwidth of 60% of  $f_{DATA}$ , which exceeds the required 56%.

The signal center frequency is  $0.7 \times f_{DATA}$ , and assuming the input signal is at baseband, the frequency shift required is also  $0.7 \times f_{DATA}$ . Using the settings detailed in the second row in the IF column in the 4× interpolation section in Table 21 selects the filter modes that give a center frequency of  $f_{DATA}/2$  and no frequency translation. The selected modes for the three half-band filters are HB1, Mode 1; HB2, Mode 1; and HB3, bypassed.

Because Mode 1 of HB1 was selected, the premodulation block should be enabled. This provides  $f_{DATA}/2$  modulation, which centers the baseband input data at the center frequency of HB1. The digital modulator can be used to provide the final frequency translation of  $0.2 \times f_{DATA}$  to place the output signal at  $0.7 \times f_{DATA}$ , as desired.

The formula for calculating the FTW of the NCO is

$$FTW = \frac{f_{CARRIER}}{f_{NCO}} \times 2^{32}$$

where:

$$f_{CARRIER} = 0.2 \times f_{DATA}$$

$$f_{NCO} = 2 \times f_{DATA}. \text{ Therefore, } FTW = 2^{32}/10.$$

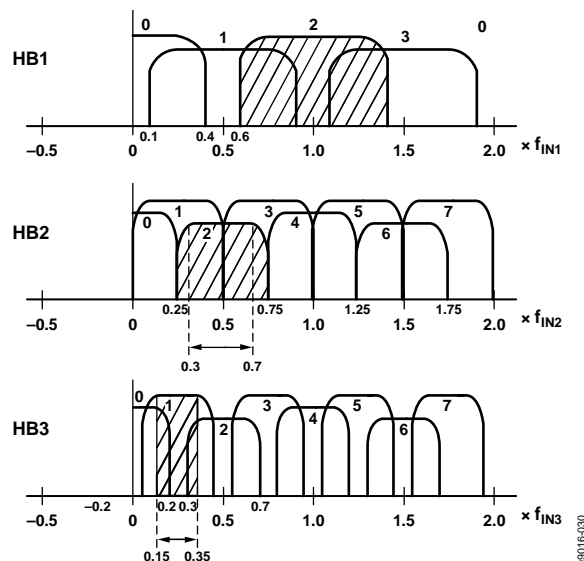


Figure 60. Signal Propagation for 8× Interpolation ( $f_{DATA}$  Modulation)

## DATA RATES VS. INTERPOLATION MODES

Table 23 summarizes the maximum bus speed ( $f_{BUS}$ ), the supported input data rates, and the signal bandwidths for various combinations of bus width modes and interpolation rates. The maximum bus speed in any mode is 250 MHz. The maximum DAC update rate ( $f_{DAC}$ ) in any mode is 1000 MHz. The real signal bandwidth supported is a fraction of the input data rate, which depends on the interpolation filter (HB1, HB2, or HB3) selected. The complex signal bandwidth supported is twice the real signal bandwidth.

In general,  $2\times$  interpolation is best supported by enabling HB1, and  $4\times$  interpolation is best supported enabling HB1 and HB2. In some cases, power dissipation can be lowered by avoiding HB1. If the bandwidth required is low enough,  $2\times$  interpolation can be supported by using HB2, and  $4\times$  interpolation can be supported by using HB2 and HB3.

## COARSE MODULATION MIXING SEQUENCES

The coarse digital quadrature modulation occurs within the interpolation filters. The modulation shifts the frequency spectrum of the incoming data by the frequency offset selected. The frequency offsets available are multiples of the input data rate. The modulation is equivalent to multiplying the quadrature input signal by a complex carrier signal,  $C(t)$ , of the form

$$C(t) = \cos(\omega_c t) + j \sin(\omega_c t)$$

In practice, this modulation results in mixing functions as shown in Table 22.

**Table 22. Modulation Mixing Sequences**

| Modulation       | Mixing Sequence  |
|------------------|--|
| $f_s/2$          | $I = I, -I, I, -I, \dots$<br>$Q = Q, -Q, Q, -Q, \dots$   |
| $f_s/4$          | $I = I, Q, -I, -Q, \dots$<br>$Q = Q, -I, -Q, I, \dots$   |
| $3 \times f_s/4$ | $I = I, -Q, -I, Q, \dots$<br>$Q = Q, I, -Q, -I, \dots$   |
| $f_s/8$          | $I = I, r(I+Q), Q, r(-I+Q), -I, -r(I+Q), -Q, r(I-Q), \dots$<br>$Q = Q, r(Q-I), -I, -r(Q+I), -Q, r(-Q+I), I, r(Q+I), \dots$ |

Note that  $r = \frac{\sqrt{2}}{2}$

As shown in Table 22, the mixing functions of most of the modes result in cross coupling samples between the I and Q channels. The I and Q channels only operate independently in  $f_s/2$  mode. This means that real modulation using both the I and Q DAC outputs can only be done in  $f_s/2$  mode. All other modulation modes require complex input data and produce complex output signals.

**Table 23. Summary of Data Rates and Bandwidths vs. Interpolation Modes**

| Bus Width                   | Filter Modes |     |     | $f_{BUS}$ (Mbps) | $f_{DATA}$ (Mbps) | Real Signal Bandwidth (MHz) | $f_{DAC}$ (MHz) |
|-----------------------------|--------------|-----|-----|------------------|-------------------|-----------------------------|-----------------|
|                             | HB3          | HB2 | HB1 |                  |                   |                             |                 |
| Byte Mode<br>(8 Bits)       | 0            | 0   | 0   | 250              | 62.5              | 31.25                       | 62.5            |
|                             | 0            | 0   | 1   | 250              | 62.5              | 25                          | 125             |
|                             | 0            | 1   | 0   | 250              | 62.5              | 15.625                      | 125             |
|                             | 0            | 1   | 1   | 250              | 62.5              | 25                          | 250             |
|                             | 1            | 1   | 0   | 250              | 62.5              | 15.625                      | 250             |
|                             | 1            | 1   | 1   | 250              | 62.5              | 25                          | 500             |
| Word Mode<br>(16 Bits)      | 0            | 0   | 0   | 250              | 125               | 62.5                        | 125             |
|                             | 0            | 0   | 1   | 250              | 125               | 50                          | 250             |
|                             | 0            | 1   | 0   | 250              | 125               | 31.25                       | 250             |
|                             | 0            | 1   | 1   | 250              | 125               | 50                          | 500             |
|                             | 1            | 1   | 0   | 250              | 125               | 31.25                       | 500             |
|                             | 1            | 1   | 1   | 250              | 125               | 50                          | 1000            |
| Dual-Word Mode<br>(32 Bits) | 0            | 0   | 0   | 250              | 250               | 125                         | 250             |
|                             | 0            | 0   | 1   | 250              | 250               | 100                         | 500             |
|                             | 0            | 1   | 0   | 250              | 250               | 62.5                        | 500             |
|                             | 0            | 1   | 1   | 250              | 250               | 100                         | 1000            |
|                             | 1            | 1   | 0   | 250              | 250               | 62.5                        | 1000            |
|                             | 1            | 1   | 1   | 125              | 125               | 50                          | 1000            |

## QUADRATURE PHASE CORRECTION

The purpose of the quadrature phase correction block is to enable compensation of the phase imbalance of the analog quadrature modulator following the DAC. If the quadrature modulator has a phase imbalance, the unwanted sideband appears with significant energy. Tuning the quadrature phase adjust value can optimize image rejection in single sideband radios.

Ordinarily, the I and Q channels have an angle of precisely  $90^\circ$  between them. The quadrature phase adjustment is used to change the angle between the I and Q channels. When the I phase adjust[9:0] is set to 1000000000, the I DAC output moves approximately  $1.75^\circ$  away from the Q DAC output, creating an angle of  $91.75^\circ$  between the channels. When the I phase adjust[9:0] is set to 0111111111, the I DAC output moves approximately  $1.75^\circ$  toward the Q DAC output, creating an angle of  $88.25^\circ$  between the channels.

The Q phase adjust bits (Bits[9:0]) work in a similar fashion. When the Q phase adjust[9:0] is set to 1000000000, the Q DAC output moves approximately  $1.75^\circ$  away from the I DAC output, creating an angle of  $91.75^\circ$  between the channels. When the Q phase adjust[9:0] is set to 0111111111, the Q DAC output moves approximately  $1.75^\circ$  toward the I DAC output, creating an angle of  $88.25^\circ$  between the channels.

Based on these two endpoints, the combined resolution of the phase compensation register is approximately  $3.5^\circ/1024$ , or  $0.00342^\circ$ , per code.

## DC OFFSET CORRECTION

The dc value of the I datapath and the Q datapath can be independently controlled by adjusting the I DAC offset[15:0] and Q DAC offset[15:0] values in Register 0x3C through Register 0x3F. These values are added directly to the datapath values. Care should be taken not to overrange the transmitted values.

Figure 61 shows how the DAC offset current varies as a function of the I DAC offset[15:0] and Q DAC offset[15:0] values. With the digital inputs fixed at midscale (0x0000, twos complement data format), Figure 61 shows the nominal  $I_{OUTXP}$  and  $I_{OUTXN}$  currents as the DAC offset value is swept from 0 to 65,535. Because  $I_{OUTXP}$  and  $I_{OUTXN}$  are complementary current outputs, the sum of  $I_{OUTXP}$  and  $I_{OUTXN}$  is always 20 mA.

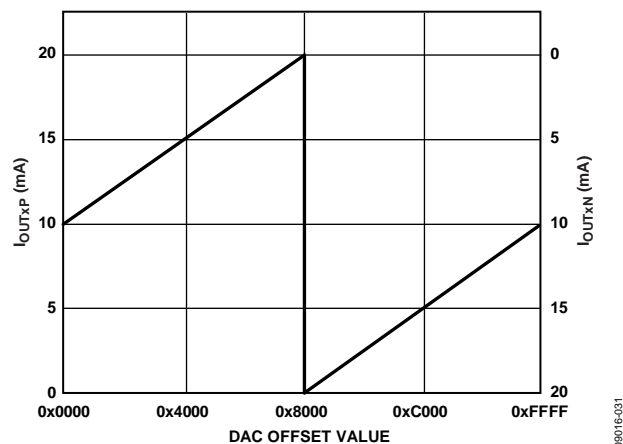


Figure 61. DAC Output Currents vs. DAC Offset Value

## INVERSE SINC FILTER

The inverse sinc ( $\text{sinc}^{-1}$ ) filter is a nine-tap FIR filter. The composite response of the  $\text{sinc}^{-1}$  and the  $\text{sin}(x)/x$  response of the DAC is shown in Figure 62. The composite response has less than  $\pm 0.05$  dB pass-band ripple up to a frequency of  $0.4 \times f_{\text{DACCLK}}$ . To provide the necessary peaking at the upper end of the pass band, the inverse sinc filters have an intrinsic insertion loss of about 3.2 dB. Figure 62 shows the composite frequency response.

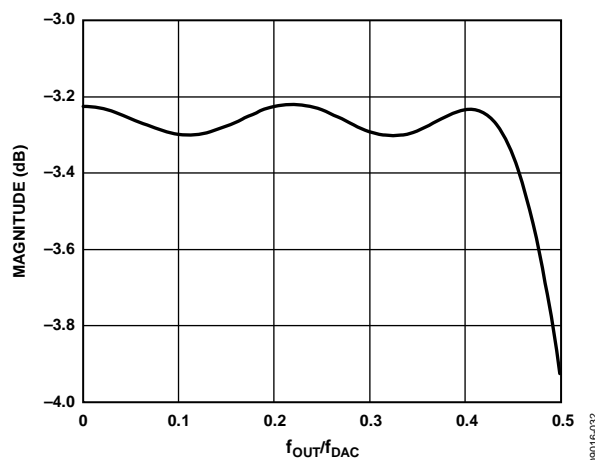


Figure 62. Sample Composite Responses of the  $\text{Sinc}^{-1}$  Filter with  $\text{Sin}(x)/x$  Roll-Off

The  $\text{sinc}^{-1}$  filter is enabled by default. It can be bypassed by setting the bypass  $\text{sinc}^{-1}$  bit (Register 0x1B, Bit 6).



# DAC INPUT CLOCK CONFIGURATIONS

## DAC INPUT CLOCK CONFIGURATIONS

The AD9125 DAC sample clock (DACCLK) can be sourced directly or by clock multiplying. Clock multiplying employs the on-chip phased-locked loop (PLL) that accepts a reference clock operating at a submultiple of the desired DACCLK rate, most commonly the data input frequency. The PLL then multiplies the reference clock up to the desired DACCLK frequency, which can be used to generate all the internal clocks required by the DAC. The clock multiplier provides a high quality clock that meets the performance requirements of most applications. Using the on-chip clock multiplier removes the burden of generating and distributing the high speed DACCLK.

The second mode bypasses the clock multiplier circuitry and allows DACCLK to be sourced directly to the DAC core. This mode enables the user to source a very high quality clock directly to the DAC core. Sourcing the DACCLK directly through the REFCLKP, REFCLKN, DACCLKP, and DACCLKN pins may be necessary in demanding applications that require the lowest possible DAC output noise, particularly when directly synthesizing signals above 150 MHz.

### Driving the DACCLK and REFCLK Inputs

The REFCLK and DACCLK differential inputs share similar clock receiver input circuitry. Figure 63 shows a simplified circuit diagram of the input. The on-chip clock receiver has a differential input impedance of about 10 kΩ. It is self-biased to a common-mode voltage of about 1.25 V. The inputs can be driven by directly coupling differential PECL or LVDS drivers. The inputs can also be ac-coupled if the driving source cannot meet the input compliance voltage of the receiver.

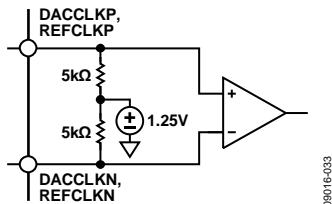


Figure 63. Clock Receiver Input Equivalent Circuit

The minimum input drive level to either clock input is 200 mV p-p differential. The optimal performance is achieved when the clock input signal is between 800 mV p-p differential and 1.6 V p-p differential. Whether using the on-chip clock multiplier or sourcing the DACCLK directly, it is necessary that the input clock signal to the device has low jitter and fast edge rates to optimize the DAC noise performance.

### Direct Clocking

Direct clocking with a low noise clock produces the lowest noise spectral density at the DAC outputs. To select the differential clock inputs as the source for the DAC sampling clock, set the PLL enable bit (Register 0x0A, Bit 7) to 0. This powers down the internal PLL clock multiplier and selects the input from the DACCLKP and DACCLKN pins as the source for the internal DAC sample clock.

The device also has duty-cycle correction circuitry and differential input-level correction circuitry. Enabling these circuits can provide improved performance in some cases. The control bits for these functions can be found in Register 0x08 (see Table 11).

### Clock Multiplication

The on-chip PLL clock multiplier circuit can be used to generate the DAC sample rate clock from a lower frequency reference clock. When the PLL enable bit (Register 0x0A, Bit 7) is set to 1, the clock multiplication circuit generates the DAC sample clock from the lower rate REFCLK input. The functional diagram of the clock multiplier is shown in Figure 64.

The clock multiplication circuit operates such that the VCO outputs a frequency,  $f_{VCO}$ , equal to the REFCLK input signal frequency multiplied by  $N1 \times N0$ .

$$f_{VCO} = f_{REFCLK} \times (N1 \times N0)$$

The DAC sample clock frequency,  $f_{DACCLK}$ , is equal to

$$f_{DACCLK} = f_{REFCLK} \times N1$$

The output frequency of the VCO must be chosen to keep  $f_{VCO}$  in the optimal operating range of 1.0 GHz to 2.1 GHz. The frequency of the reference clock and the values of  $N1$  and  $N0$  must be chosen so that the desired DACCLK frequency can be synthesized and the VCO output frequency is in the correct range.

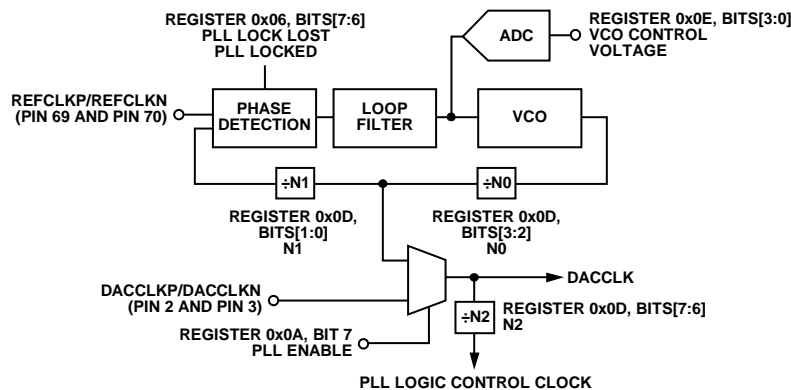


Figure 64. PLL Clock Multiplication Circuit  
Rev. 0 | Page 40 of 56

09016-034

### PLL Settings

There are three settings for the PLL circuitry that should be programmed to their nominal values. Table 24 lists the recommended PLL settings for these parameters.

**Table 24. PLL Settings**

| PLL SPI Control              | Address Register | Bits  | Optimal Setting |
|------------------------------|------------------|-------|-----------------|
| PLL Loop Bandwidth[2:0]      | 0x0C             | [7:5] | 110             |
| PLL Charge Pump Current[4:0] | 0x0C             | [4:0] | 10001           |
| PLL Cross Control Enable     | 0x0D             | 4     | 1               |

### Configuring the VCO Tuning Band

The PLL VCO has a valid operating range from approximately 1.0 GHz to 2.1 GHz, covered in 63 overlapping frequency bands. For any desired VCO output frequency, there may be several valid PLL band select values. The frequency bands of a typical device are shown in Figure 65. Device-to-device variations and operating temperature affect the actual band frequency range. Therefore, it is required that the optimal PLL band select value be determined for each individual device.

### Automatic VCO Band Select

The device has an automatic VCO band select feature on chip. Using the automatic VCO band select feature is a simple and reliable method of configuring the VCO frequency band. This feature is enabled by writing 0x80 to Register 0x0A. When this value is written, the device executes an automated routine that determines the optimal VCO band setting for the device. The setting selected by the device ensures that the PLL remains locked over the full  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$  operating temperature range of the device without further adjustment. (The PLL remains locked over the full temperature range even if the temperature during initialization is at one of the temperature extremes.)

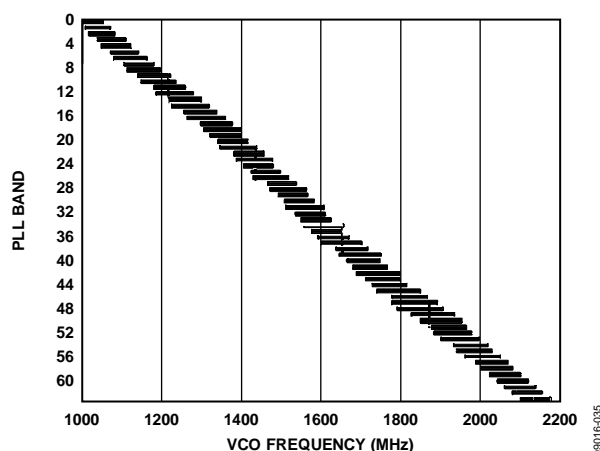


Figure 65. PLL Lock Range over Temperature for a Typical Device

### Manual VCO Band Select

The device also has a manual band select mode (PLL manual enable, Register 0x0A, Bit 6 = 1) that allows the user to select the VCO tuning band. When in manual mode, the VCO band is set directly with the value written to the manual VCO band, (Register 0x0A, Bits[5:0]). To properly select the VCO band, follow these steps:

1. Put the device in manual band select mode.
2. Sweep the VCO band over a range of bands that result in the PLL being locked.
3. For each band, verify that the PLL is locked and read the PLL using the VCO control voltage (Register 0x0E, Bits[3:0]).
4. Select the band that results in the control voltage being closest to the center of the range, that is, 0000 or 1000 (see Table 25 for more details). The resulting VCO band should be the optimal setting for the device. Write this band to the manual VCO band (Register 0x0A, Bits[5:0]) value.
5. If desired, an indication of where the VCO is within the operating frequency band can be determined by querying the VCO control voltage. Table 25 shows how to interpret the PLL VCO control voltage (Register 0x0E, Bits[3:0]) value.

**Table 25. VCO Control Voltage Range Indications**

| VCO Control Voltage | Indication  |
|---------------------|---|
| 1111                | Move to a higher VCO band                                       |
| 1110                |   |
| 1101                | VCO is operating in the higher end of the frequency band        |
| 1100                |   |
| 1011                |   |
| 1010                |   |
| 1001                | VCO is operating within an optimal region of the frequency band |
| 1000                |   |
| 0111                |   |
| 0110                |   |
| 0101                | VCO is operating in the lower end of the frequency band         |
| 0100                |   |
| 0011                |   |
| 0010                |   |
| 0001                | Move to a lower VCO band  |
| 0000                |   |

## ANALOG OUTPUTS

### TRANSMIT DAC OPERATION

Figure 66 shows a simplified block diagram of the transmit path DACs. The DAC core consists of a current source array, a switch core, a digital control logic, and a full-scale output current control. The DAC full-scale output current ( $I_{OUTFS}$ ) is nominally 20 mA. The output currents from the IOUT1P/IOUT2P and IOUT1N/ IOUT2N pins are complementary, meaning that the sum of the two currents always equals the full-scale current of the DAC. The digital input code to the DAC determines the effective differential current delivered to the load.

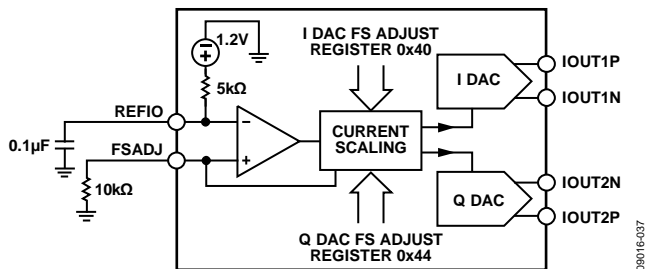


Figure 66. Simplified Block Diagram of DAC Core

The DAC has a 1.2 V band gap reference with an output impedance of 5 kΩ. The reference output voltage appears on the REFIO pin. When using the internal reference, the REFIO pin should be decoupled to AVSS with a 0.1 μF capacitor. Only use the internal reference for external circuits that draw dc currents of 2 μA or less. For dynamic loads or static loads greater than 2 μA, buffer the REFIO pin. If desired, an external reference (between 1.10 V and 1.30 V) can be applied to the REFIO pin. The internal reference can either be overdriven or powered down by setting Register 0x43, Bit 5.

A 10 kΩ external resistor,  $R_{SET}$ , must be connected from the FSADJ pin to AVSS. This resistor, along with the reference control amplifier, sets up the correct internal bias currents for the DAC. Because the full-scale current is inversely proportional to this resistor, the tolerance of  $R_{SET}$  is reflected in the full-scale output amplitude.

The full-scale current equation, where the DAC gain is set individually for the I and Q DACs in Register 0x40 and Register 0x44, respectively, follows:

$$I_{FS} = \frac{V_{REF}}{R_{SET}} \times \left( 72 + \left( \frac{3}{16} \times DAC \text{ gain} \right) \right)$$

For nominal values of  $V_{REF}$  (1.2 V),  $R_{SET}$  (10 kΩ), and DAC gain (512), the full-scale current of the DAC is typically 20.16 mA. The DAC full-scale current can be adjusted from 8.66 mA to 31.66 mA by setting the DAC gain code, as shown in Figure 67.

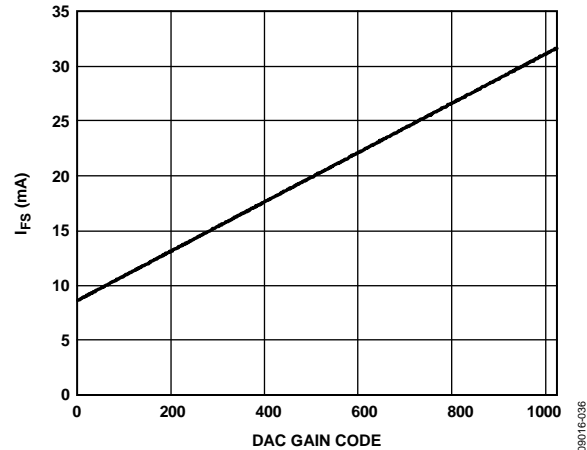


Figure 67. DAC Full-Scale Current vs. DAC Gain Code

### Transmit DAC Transfer Function

The output currents from the IOUT1P/IOUT2P and IOUT1N/ IOUT2N pins are complementary, meaning that the sum of the two currents always equals the full-scale current of the DAC. The digital input code to the DAC determines the effective differential current delivered to the load. IOUT1P/IOUT2P provide maximum output current when all bits are high. The output currents vs. DACCODE for the DAC outputs are expressed as

$$I_{OUTP} = \left[ \frac{DACCODE}{2^N} \right] \times I_{OUTFS} \quad (1)$$

$$I_{OUTN} = I_{OUTFS} - I_{OUTP} \quad (2)$$

where  $DACCODE = 0$  to  $2^N - 1$ .

### Transmit DAC Output Configurations

The optimum noise and distortion performance of the AD9125 is realized when it is configured for differential operation. The common-mode error sources of the DAC outputs are significantly reduced by the common-mode rejection of a transformer or differential amplifier. These common-mode error sources include even-order distortion products and noise. The enhancement in distortion performance becomes more significant as the frequency content of the reconstructed waveform increases and/or its amplitude increases. This is due to the first-order cancellation of various dynamic common-mode distortion mechanisms, digital feedthrough, and noise.

Figure 68 shows the most basic DAC output circuitry. A pair of resistors,  $R_O$ , is used to convert each of the complementary output currents to a differential voltage output,  $V_{OUT}$ . Because the current outputs of the DAC are high impedance, the differential driving point impedance of the DAC outputs,  $R_{OUT}$ , is equal to  $2 \times R_O$ . Figure 69 illustrates the output voltage waveforms.

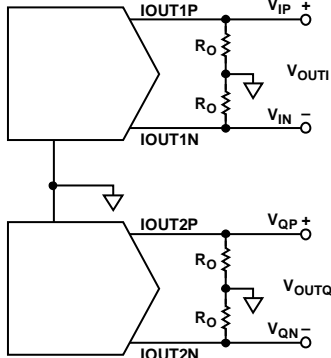


Figure 68. Basic Transmit DAC Output Circuit

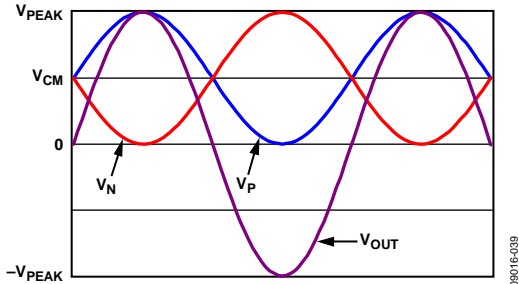


Figure 69. Voltage Output Waveforms

The common-mode signal voltage,  $V_{CM}$ , is calculated as

$$V_{CM} = \frac{I_{FS}}{2} \times R_O$$

The peak output voltage,  $V_{PEAK}$ , is calculated as

$$V_{PEAK} = I_{FS} \times R_O$$

With this circuit configuration, the single-ended peak voltage is the same as the peak differential output voltage.

**Transmit DAC Linear Output Signal Swing**

To achieve optimum performance, the DAC outputs have a linear output compliance voltage range that must be adhered to. The linear output signal swing is dependent on the full-scale output current,  $I_{OUTFS}$ , and the common-mode level of the output. Figure 70 and Figure 71 show the IMD performance vs. the common-mode output voltage at various full-scale currents and output frequencies.

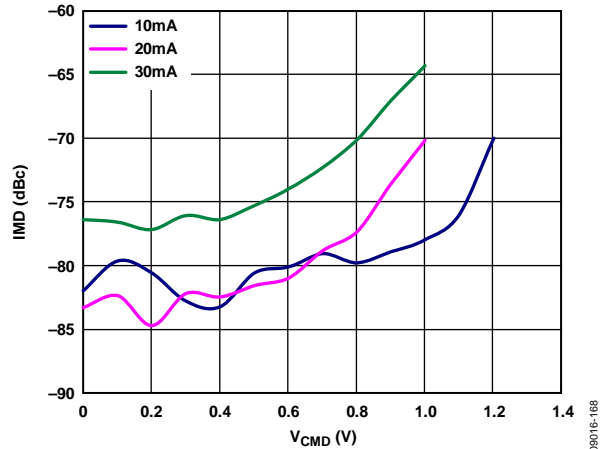


Figure 70. IMD vs. Common-Mode Output Voltage ( $f_{OUT} = 61$  MHz,  $R_{LOAD} = 50 \Omega$  differential,  $I_{FS} = 10$  mA, 20 mA, and 30 mA)

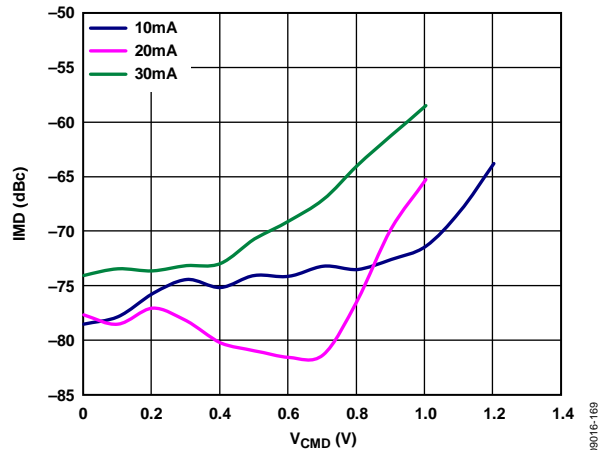


Figure 71. IMD vs. Common-Mode Output Voltage ( $f_{OUT} = 161$  MHz,  $R_{LOAD} = 50 \Omega$  differential,  $I_{FS} = 10$  mA, 20 mA, and 30 mA)

**AUXILIARY DAC OPERATION**

The AD9125 has two auxiliary DACs; one is associated with the I path, and the other is associated with the Q path. These auxiliary DACs can be used to compensate for dc offsets in the transmitted signal. Each auxiliary DAC has a single-ended current that can sink or source current into either the P or N output of the associated transmit DAC. The auxiliary DAC structure is shown in Figure 72.

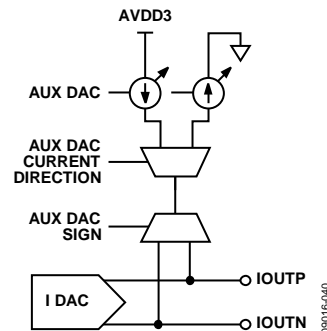


Figure 72. Auxiliary DAC Structure

The control registers for controlling the I and Q auxiliary DACs are in Register 0x42, Register 0x43, Register 0x46, and Register 0x47.

## Interfacing to Modulators

The AD9125 interfaces to the ADL537x family of modulators with a minimal number of components. An example of the recommended interface circuitry is shown in Figure 73.

The baseband inputs of the ADL537x family require a dc bias of 500 mV. The nominal midscale output current on each output of the DAC is 10 mA (½ the full-scale current). Therefore, a single 50 Ω resistor to ground from each DAC output results in the desired 500 mV dc common-mode bias for the inputs to the ADL537x. The signal level can be reduced through the addition of the load resistor in parallel with the modulator inputs. The peak-to-peak voltage swing of the transmitted signal is

$$V_{\text{SIGNAL}} = I_{\text{FS}} \times \frac{[2 \times R_B \times R_L]}{[2 \times R_B + R_L]}$$

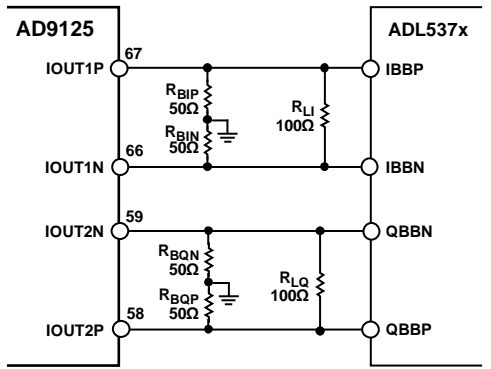


Figure 73. Typical Interface Circuitry Between the AD9125 and the ADL537x Family of Modulators

## BASEBAND FILTER IMPLEMENTATION

Most applications require a baseband anti-imaging filter between the DAC and the modulator to filter out Nyquist images and broadband DAC noise. The filter can be inserted between the I-V resistors at the DAC output and the signal-level setting resistor across the modulator input. This configuration establishes the input and output impedances for the filter.

Figure 75 shows a fifth-order low-pass filter. A common-mode choke is used between the I-V resistors and the remainder of the filter. This removes the common-mode signal produced by the DAC and prevents the common-mode signal from being converted to a differential signal, which can appear as unwanted spurious signals in the output spectrum. Splitting the first filter capacitor into two and grounding the center point creates a common-mode low-pass filter, providing additional common-mode rejection of high frequency signals. A purely differential filter can pass common-mode signals.

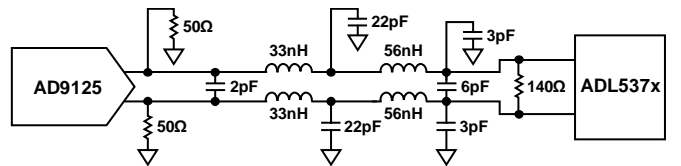


Figure 75. DAC Modulator Interface with Fifth-Order, Low Pass Filter

## DRIVING THE ADL5375-15

The ADL5375-15 is the version of the ADL5375 that offers an input baseband bias levels of 1500 mV. Because the ADL5375-15 requires a 1500 mV dc bias, it requires a slightly more complex interface than most other Analog Devices, Inc., modulators. The DAC output must be level-shifted from a 500 mV dc bias to the 1500 mV dc bias. Level-shifting can be achieved with a purely passive network, as shown in Figure 74. In this network, the dc bias of the DAC remains at 500 mV while the input to the ADL5375-15 is 1500 mV. This passive level-shifting network introduces approximately 2 dB of loss in the ac signal.

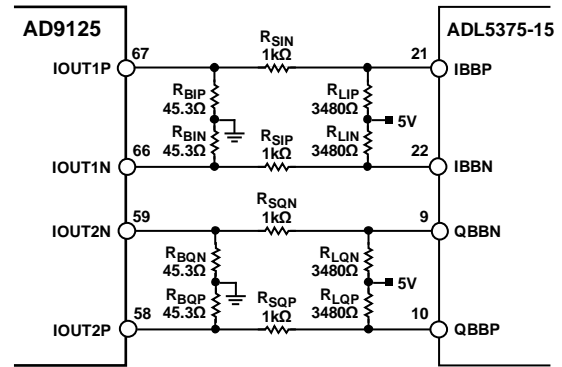


Figure 74. Passive Level-Shifting Network for Biasing ADL5375-15

## REDUCING LO LEAKAGE AND UNWANTED SIDEBANDS

Analog quadrature modulators can introduce unwanted signals at the LO frequency due to dc offset voltages in the I and Q baseband inputs, as well as feedthrough paths from the LO input to the output. The LO feedthrough can be nulled by applying the correct dc offset voltages at the DAC output. This can be done using the auxiliary DACs (Register 0x42, Register 0x43, Register 0x46, and Register 0x47) or by using the digital dc offset adjustments (Register 0x3C through Register 0x3F).

The advantage of using the auxiliary DACs is that none of the main DAC dynamic range is used to perform the dc offset adjustment. However, the disadvantage is that the common-mode level of the output signal changes as a function of the auxiliary DAC current. The opposite is true when the digital offset adjustment is used.

Good sideband suppression requires both gain and phase matching of the I and Q signals. The I phase adjust (Register 0x38 and Register 0x39), Q phase adjust (Register 0x3A and Register 0x3B), I DAC FS adjust (Register 0x40 and Register 0x41), and Q DAC FS adjust (Register 0x44 and Register 0x45) registers can be used to calibrate I and Q transmit paths to optimize the sideband suppression.

## DEVICE POWER DISSIPATION

The AD9125 has four supply rails: AVDD33, IOVDD, DVDD18, and CVDD18.

The AVDD33 supply powers the DAC core circuitry. The power dissipation of the AVDD33 supply rail is independent of the digital operating mode and sample rate. The current drawn from the AVDD33 supply rail is typically 57 mA (188 mW) when the full-scale current of the I and Q DACs is set to the nominal value of 20 mA. Changing the full-scale current directly impacts the supply current drawn from the AVDD33 rail. For example, if the full-scale current of the I DAC and the Q DAC is changed to 10 mA, the AVDD33 supply current drops by 20 mA to 37 mA.

The IOVDD voltage supplies the serial port I/O pins, the  $\overline{\text{RESET}}$  pin, and the  $\overline{\text{IRQ}}$  pin. The voltage applied to the IOVDD pin can range from 1.8 V to 3.3 V. The current drawn by the IOVDD supply pin is typically 3 mA.

The DVDD18 supply powers all of the digital signal processing blocks of the device. The power consumption from this supply is a function of which digital blocks are enabled and the frequency at which the device is operating.

The CVDD18 supply powers the clock receiver and clock distribution circuitry. The power consumption from this supply varies directly with the operating frequency of the device. CVDD18 also powers the PLL. The power dissipation of the PLL is typically 80 mA when enabled.

Figure 76 through Figure 80 detail the power dissipation of the AD9125 under a variety of operating conditions. All of the graphs are taken with data being supplied to both the I and Q channels. The power consumption of the device does not vary significantly with changes in the coarse modulation mode selected or analog output frequency. Graphs of the total power dissipation are shown along with the power dissipation of the DVDD18 and CVDD18 supplies.

Maximum power dissipation can be estimated to be 20% higher than the typical power dissipation.

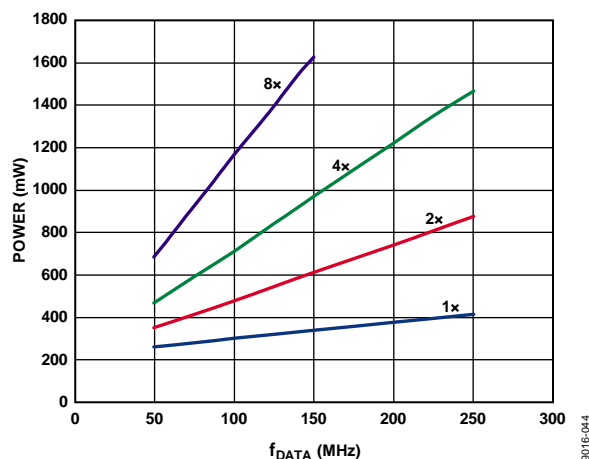


Figure 76. Total Power Dissipation vs.  $f_{\text{DATA}}$  Without PLL, Fine NCO, and Inverse Sinc

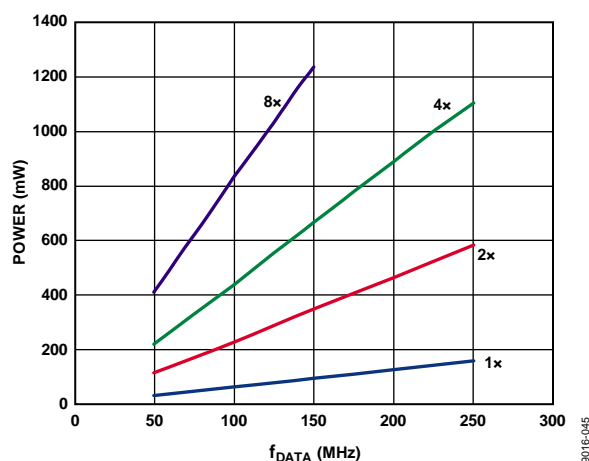


Figure 77. DVDD18 Power Dissipation vs.  $f_{\text{DATA}}$  Without Fine NCO and Inverse Sinc

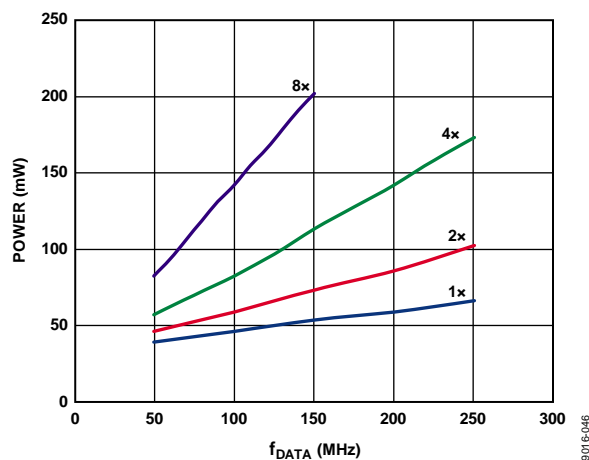


Figure 78. CVDD18 Power Dissipation vs.  $f_{\text{DATA}}$  with PLL Disabled

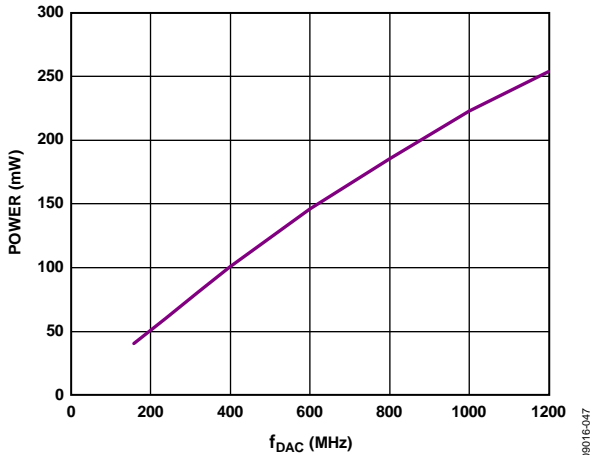


Figure 79. DVDD18 Power Dissipation vs.  $f_{DAC}$  Due to Inverse Sinc Filter

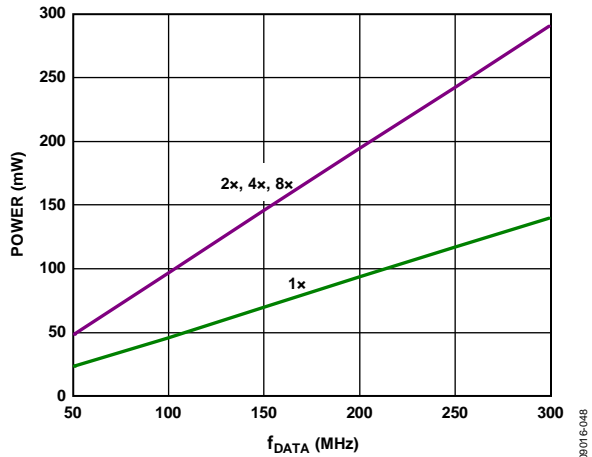


Figure 80. DVDD18 Power Dissipation vs.  $f_{DATA}$  Due to Fine NCO

## TEMPERATURE SENSOR

The AD9125 has a diode-based temperature sensor for measuring the temperature of the die. The temperature reading is accessed through Register 0x49 and Register 0x4A. The temperature of the die can be calculated by

$$T_{DIE} = \frac{(Die\ Temp[15:0] - 47,925)}{88}$$

where  $T_{DIE}$  is the die temperature in °C. The temperature accuracy is  $\pm 5^\circ\text{C}$  typical.

Estimates of the ambient temperature can be made if the power dissipation of the device is known. For example, if the device power dissipation is 800 mW and the measured die temperature is  $50^\circ\text{C}$ , then the ambient temperature can be calculated as

$$T_A = T_{DIE} - P_D \times T_{JA} = 50 - 0.8 \times 20.7 = 33.4^\circ\text{C}$$

where:

$T_A$  is the ambient temperature in °C.

$T_{DIE}$  is the die temperature in °C.

$P_D$  is the power dissipation.

$T_{JA}$  is the thermal resistance from junction to ambient of the AD9125, as shown in Table 7.

To use the temperature sensor, it must be enabled by setting Register 0x01, Bit 4, to 0. In addition, to obtain accurate readings, the range control register (Register 0x48) should be set to 0x02.

## MULTICHIP SYNCHRONIZATION

System demands may require that the outputs of multiple DACs be synchronized with each other or with a system clock. Systems that support transmit diversity or beam forming, where multiple antennas are used to transmit a correlated signal, require multiple DAC outputs to be phase aligned with each other. Systems with a time division multiplexing transmit chain may require one or more DACs to be synchronized with a system-level reference clock.

Multiple devices are considered synchronized to each other when the state of the clock generation state machine is identical for all parts and when time aligned data is being read from the FIFOs of all parts simultaneously. Devices are considered synchronized to a system clock when there is a constant, known relationship among the clock generation state machine, the data being read from the FIFO, and a particular clock edge of the system clock. The AD9125 has provisions for enabling multiple devices to be synchronized to each other or to a system clock.

The AD9125 supports synchronization in two modes: data rate mode and FIFO rate mode. Each of these modes has a different lowest rate clock that the synchronization logic attempts to synchronize to. In data rate mode, the input data rate represents the lowest synchronized clock. In FIFO rate mode, the FIFO rate, which is the data rate divided by the FIFO depth of 8, represents the lowest rate clock. The advantage of FIFO rate synchronization is increased time between keep-out windows for DCI changes relative to the DACCLK or REFCLK input.

When in data rate mode, the elasticity of the FIFO is not used to absorb timing variations between the data source and the DAC, resulting in keep-out windows repeating at the input data rate.

The method chosen for providing the DAC sampling clock directly impacts the synchronization methods available. When the device clock multiplier is used, only data rate mode is available. When the DAC sampling clock is sourced directly, both data rate mode and FIFO rate mode synchronization are available. This section details the synchronization methods for enabling both clocking modes and for querying the status of the synchronization logic.

### SYNCHRONIZATION WITH CLOCK MULTIPLICATION

When using the clock multiplier to generate the DAC sample rate clock, the REFCLK input signal acts both as the reference clock for the PLL-based clock multiplier and as the synchronization signal. To synchronize devices, distribute the REFCLK signal with low skew to all of the devices that need to be synchronized. Skew between the REFCLK signals of the devices shows up directly as a timing mismatch at the DAC outputs.

The frequency of the REFCLK signal is typically equal to the input data rate. The FRAME and DCI signals, along with the data, can be created in the FPGA. A circuit diagram of a typical configuration is shown in Figure 81.

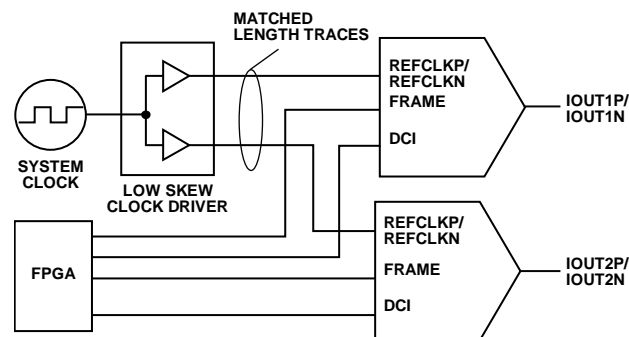


Figure 81. Typical Circuit Diagram for Synchronizing Devices

The Procedure for Synchronization when Using the PLL section outlines the steps required to synchronize multiple devices. The procedure assumes that the REFCLK signal is applied to all devices and that the PLL of each device is phase locked to this signal. This procedure must be carried out on each individual device.

### Procedure for Synchronization when Using the PLL

To synchronize all devices,

1. Configure the device for data rate mode and periodic synchronization by writing 0xC0 to the Sync Control 1 register (Register 0x10). Additional synchronization options are available.
2. Read the Sync Status 1 register (Register 0x12) and verify that the sync locked bit (Bit 6) is set high, indicating that the device achieved back-end synchronization and that the sync lost bit (Bit 7) is low. These levels indicate that the clocks are running with a constant, known phase relative to the sync signal.
3. Reset the FIFO by strobing the FRAME signal high for the time required to write two complete input data-words. Resetting the FIFO ensures that the correct data is being read from the FIFO.

To maintain synchronization, the skew between the REFCLK signals of the devices must be less than  $t_{\text{skew}}$ . There are also setup and hold times to be observed among the DCI, the data of each device, and the REFCLK signal. When resetting the FIFO, the FRAME signal must be held high for the time interval required to write two complete input data-words. A timing diagram of the input signals is shown in Figure 82.

This example shows a REFCLK frequency equal to the data rate. Although this is the most common situation, it is not strictly required for proper synchronization. Any REFCLK frequency that satisfies the following equation is acceptable:

$$f_{\text{SYNC}_1} = f_{\text{DACCLK}}/2^N \text{ and } f_{\text{SYNC}_1} \leq f_{\text{DATA}}$$

where  $N = 0, 1, 2, \text{ or } 3$ .

As an example, a configuration with  $4\times$  interpolation and clock frequencies of  $f_{\text{VCO}} = 1600 \text{ MHz}$ ,  $f_{\text{DACCLK}} = 800 \text{ MHz}$ ,  $f_{\text{DATA}} = 200 \text{ MHz}$ , and  $f_{\text{SYNC}_1} = 100 \text{ MHz}$  is a viable solution.



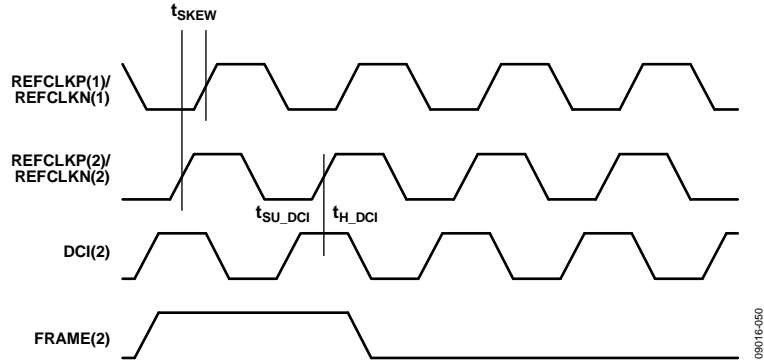


Figure 82. Timing Diagram Required for Synchronizing Devices

08016-050

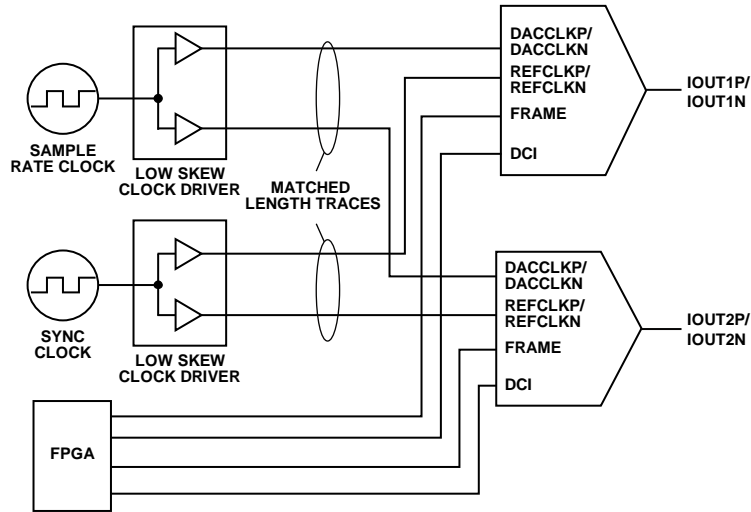


Figure 83. Typical Circuit Diagram for Synchronizing Devices to a System Clock

08016-051

## SYNCHRONIZATION WITH DIRECT CLOCKING

When directly sourcing the DAC sample rate clock, a separate REFCLK input signal is required for synchronization. To synchronize devices, the DACCLK signal and the REFCLK signal must be distributed with low skew to all of the devices being synchronized. If the devices need to be synchronized to a master clock, then use the master clock directly for generating the REFCLK input (see Figure 83).

## DATA RATE MODE SYNCHRONIZATION

The Procedure for Data Rate Synchronization when Directly Sourcing the DAC Sampling Clock section outlines the steps required to synchronize multiple devices in data rate mode. The procedure assumes that the DACCLK and REFCLK signals are applied to all of the devices. The procedure must be carried out on each individual device.

### Procedure for Data Rate Synchronization When Directly Sourcing the DAC Sampling Clock

To synchronize all devices,

1. Configure the device for data rate mode and periodic synchronization by writing 0xC0 to the Sync Control 1 register (Register 0x10). Additional synchronization options are available and are described in the Additional Synchronization Features section.
2. Poll the sync locked bit (Register 0x12, Bit 6) to verify that the device is back-end synchronized. A high level on this bit indicates that the clocks are running with a constant, known phase relative to the sync signal.
3. Reset the FIFO by strobing the FRAME signal high for the time required to write two complete input data-words. Resetting the FIFO ensures that the correct data is being read from the FIFO of each of the devices simultaneously.

To ensure that each DAC is updated with the correct data on the same CLK edge, two timing relationships must be met on each DAC. DCI and D[31:0] must meet the setup and hold times with respect to the rising edge of DACCLK, and REFCLK must meet the setup and hold times with respect to the rising edge of DACCLK. When resetting the FIFO, the FRAME signal must be held high for the time required to input two complete input data-words. When these conditions are met, the outputs of the DACs are updated within  $t_{\text{SKEW}} + t_{\text{OUTDLY}}$  of each other. A timing diagram that illustrates the timing requirements of the input signals is shown in Figure 84.

Figure 84 shows the synchronization signal timing with  $2\times$  interpolation; therefore,  $f_{\text{DCI}} = \frac{1}{2} \times f_{\text{CLK}}$ . The REFCLK input is shown to be equal to the data rate. The maximum frequency at which the device can be resynchronized in data rate mode can be expressed as

$$f_{\text{SYNC}_I} = f_{\text{DATA}} / 2^N$$

where  $N$  is any nonnegative integer.

Generally, for values of  $N$  equal to or greater than 3, select the FIFO rate synchronization mode.

**Table 26. DCI-DAC Setup and Hold Times**

| Minimum Setup Time, $t_{\text{SU\_DCI}}$ (ns) | Minimum Hold Time, $t_{\text{H\_DCI}}$ (ns) |
|---|---|
| 0.16  | 0.59  |

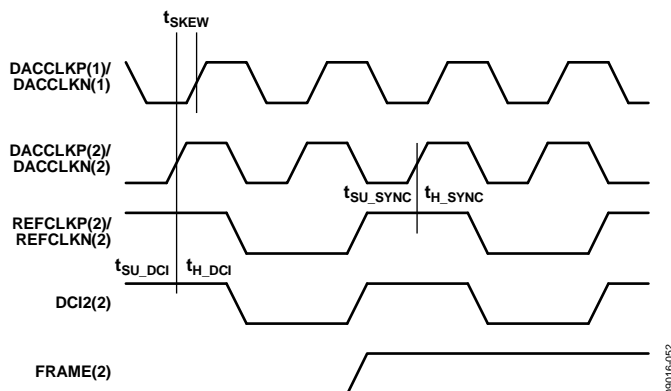


Figure 84. Data Rate Synchronization Signal Timing Requirements,  $2\times$  Interpolation

## FIFO RATE MODE SYNCHRONIZATION

The Procedure for FIFO Rate Synchronization when Directly Sourcing the DAC Sampling Clock section outlines the steps required to synchronize multiple devices in FIFO rate mode. The procedure assumes that the REFCLK and DACCLK signals are applied to all of the devices. The procedure must be carried out on each individual device.

### Procedure for FIFO Rate Synchronization When Directly Sourcing the DAC Sampling Clock

To synchronize all devices,

1. Configure the device for FIFO rate mode and periodic synchronization by writing 0x80 to the Sync Control 1 register (Register 0x10). Additional synchronization options are available and are described in the Additional Synchronization Features section.
2. Poll the sync locked bit (Register 0x12, Bit 6) to verify that the device is back-end synchronized. A high level on this bit indicates that the clocks are running with a constant and known phase relative to the sync signal.
3. Reset the FIFO by strobing the FRAME signal high for the time required to write two complete input data-words. Resetting the FIFO ensures that the correct data is being read from the FIFO of each of the devices simultaneously.

To ensure that each DAC is updated with the correct data on the same CLK edge, two timing relationships must be met on each DAC. DCI and D[31:0] must meet the setup and hold times with respect to the rising edge of DACCLK, and REFCLK must meet the setup and hold times with respect to the rising edge of DACCLK. When resetting the FIFO, the FRAME signal must be held high for at least three data periods (that is, 1.5 cycles of DCI). When these conditions are met, the outputs of the DACs are updated within  $t_{\text{SKEW}} + t_{\text{OUTDLY}}$  of each other. A timing diagram that illustrates the timing requirements of the input signals is shown in Figure 85.

Figure 85 shows the synchronization signal timing with  $2\times$  interpolation; therefore,  $f_{\text{DCI}} = \frac{1}{2} \times f_{\text{CLK}}$ . The REFCLK input is shown to be equal to the FIFO rate. More generally, the maximum frequency at which the device can be resynchronized in FIFO rate mode can be expressed as

$$f_{\text{SYNC}_I} = f_{\text{DATA}} / (8 \times 2^N)$$

where  $N$  is any nonnegative integer.

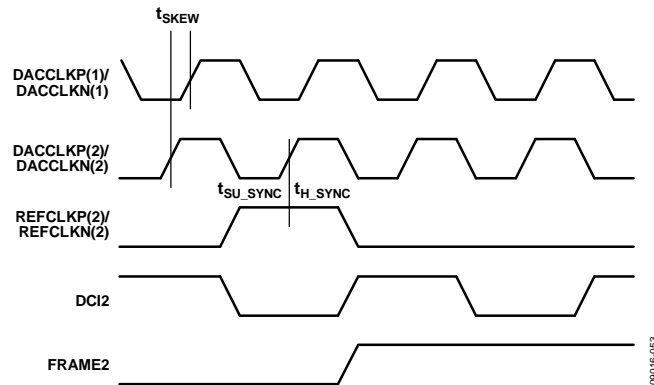


Figure 85. FIFO Rate Synchronization Signal Timing Requirements,  $2\times$  Interpolation

## ADDITIONAL SYNCHRONIZATION FEATURES

The synchronization logic incorporates additional features that provide means for querying the status of the synchronization, improving the robustness of the synchronization, and enabling a one-shot synchronization mode. These features are detailed in the Sync Status Bits and Timing Optimization sections.

### Sync Status Bits

When the sync locked bit (Register 0x12, Bit 6) is set, it indicates that the synchronization logic has reached alignment. This alignment is determined when the clock generation state machine phase is constant. It takes between  $(11 + \text{averaging}) \times 64$  and  $(11 + \text{averaging}) \times 128$  DACCLK cycles. This bit can optionally trigger an  $\overline{\text{IRQ}}$ , as described in the Interrupt Request Operation section.

When the sync lost bit (Register 0x12, Bit 7) is set, it indicates a previously synchronized device has lost alignment. This bit is latched and remains set until cleared by overwriting the register. This bit can optionally trigger an  $\overline{\text{IRQ}}$ , as described in the Interrupt Request Operation section.

The sync phase readback bits (Register 0x13, Bits[7:0]) report the current clock phase in a 6.2 format. Bits[7:2] report which of the 64 states (0 to 63) the clock is currently in. When averaging is enabled, Bits[1:0] provide  $\frac{1}{4}$  state accuracy (for 0,  $\frac{1}{4}$ ,  $\frac{1}{2}$ ,  $\frac{3}{4}$ ). The lower two bits give an indication of the timing margin issues that may exist. If the sync sampling is error free, the fractional clock state should be 00.

### Timing Optimization

The REFCLK signal is sampled by a version of the DACCLK. If sampling errors are being detected, the opposite sampling edge can be selected to improve the sampling point. The sampling edge can be selected by setting Register 0x10, Bit 3 (1 = rising and 0 = falling).

The synchronization logic resynchronizes when a phase change between the REFCLK signal and the state of the clock generation state machine exceeds a threshold. To mitigate the effects of jitter and prevent erroneous resynchronizations, the relative phase can be averaged. The amount of averaging is set by the sync averaging bits (Register 0x10, Bits[2:0]) and can be set from 1 to 128. The higher the number of averages, the more slowly the device recognizes and resynchronizes to a legitimate phase correction. Generally, the averaging should be made as large as possible while still meeting the allotted resynchronization time interval.

The value of the sync phase request bits (Register 0x11, Bits[5:0]) is the state to which the clock generation state machine resets upon initialization. By varying this value, the timing of the internal clocks with respect to the REFCLK signal can be adjusted. Every increment in the value of the sync phase request bits (Register 0x11, Bits[5:0]) advances the internal clocks by one DACCLK period. This offset can be used for two purposes: to skew the outputs of two synchronized DAC outputs in increments of the DACCLK period and to change the relative timing between the DCI input and REFCLK. This may allow for more optimal placement of the DCI sampling point in data rate synchronization mode.

**Table 27. Synchronization Setup and Hold Times**

| Parameter             | Min                    | Max                    | Unit |
|-----------------------|------------------------|------------------------|------|
| $t_{\text{SKEW}}$     | $-t_{\text{DACCLK}}/2$ | $+t_{\text{DACCLK}}/2$ | ps   |
| $t_{\text{SV\_SYNC}}$ | 100                    |                        | ps   |
| $T_{\text{H\_SYNC}}$  | 330                    |                        | ps   |

## INTERRUPT REQUEST OPERATION

The AD9125 provides an interrupt request output signal (on Pin 7,  $\overline{\text{IRQ}}$ ) that can be used to notify an external host processor of significant device events. Upon assertion of the interrupt, the device should be queried to determine the precise event that occurred. The  $\overline{\text{IRQ}}$  pin is an open-drain, active low output. Pull the  $\overline{\text{IRQ}}$  pin high external to the device. This pin can be tied to the interrupt pins of other devices with open-drain outputs to wire-OR these pins together.

Sixteen event flags provide visibility into the device. These 16 flags are located in the two event flag registers (Register 0x06 and Register 0x07). The behavior of each of the event flags is independently selected in the interrupt enable registers (Register 0x04 and Register 0x05). When the flag interrupt enable is active, the event flag latches and triggers an external interrupt. When the flag interrupt is disabled, the event flag simply monitors the source signal and the external  $\overline{\text{IRQ}}$  remains inactive.

Figure 86 shows the  $\overline{\text{IRQ}}$ -related circuitry. This diagram shows how event flag signals propagate to the  $\overline{\text{IRQ}}$  output. The  $\text{INTERRUPT\_ENABLE}$  signal represents one bit from the interrupt enable registers. The  $\text{EVENT\_FLAG\_SOURCE}$  signal represents one bit from the event flag registers. The  $\text{EVENT\_FLAG\_SOURCE}$  signal represents one of the device signals that can be monitored, such as the  $\text{PLL\_LOCKED}$  signal from the PLL phase detector or the  $\text{FIFO\_WARNING\_1}$  signal from the FIFO controller.

When an interrupt enable bit is set high, the corresponding event flag bit reflects a positively tripped signal (that is, latched on the rising edge of the  $\text{EVENT\_FLAG\_SOURCE}$  signal). This signal

also asserts the external  $\overline{\text{IRQ}}$ . When an interrupt enable bit is set low, the event flag bit reflects the current status of the  $\text{EVENT\_FLAG\_SOURCE}$  signal, but the event flag has no effect on the external  $\overline{\text{IRQ}}$ .

The latched version of an event flag (the  $\text{INTERRUPT\_SOURCE}$  signal) can be cleared in two ways. The recommended way is by writing 1 to the corresponding event flag bit; however, a hardware or software reset can also clear the  $\text{INTERRUPT\_SOURCE}$ .

### INTERRUPT SERVICE ROUTINE

The interrupt request management starts by selecting the set of event flags that require host intervention or monitoring. Those events that require host action should be enabled so that the host is notified when they occur. For events requiring host intervention, upon  $\overline{\text{IRQ}}$  activation, run the following routine to clear an interrupt request:

1. Read the status of the event flag bits that are being monitored.
2. Set the interrupt enable bit low so that the unlatched  $\text{EVENT\_FLAG\_SOURCE}$  signal can be monitored directly.
3. Perform any actions that are required to clear the  $\text{EVENT\_SOURCE\_FLAG}$  signal. In many cases, no specific actions are required.
4. Read the event flag to verify that the  $\text{EVENT\_FLAG\_SOURCE}$  signal has been cleared.
5. Clear the interrupt by writing 1 to the event flag bit.
6. Set the interrupt enable bits of the events to be monitored.

Note that some of the  $\text{EVENT\_FLAG\_SOURCE}$  signals are latched signals. These are cleared by writing to the corresponding event flag bit. Details of each of the event flags can be found in Table 11.

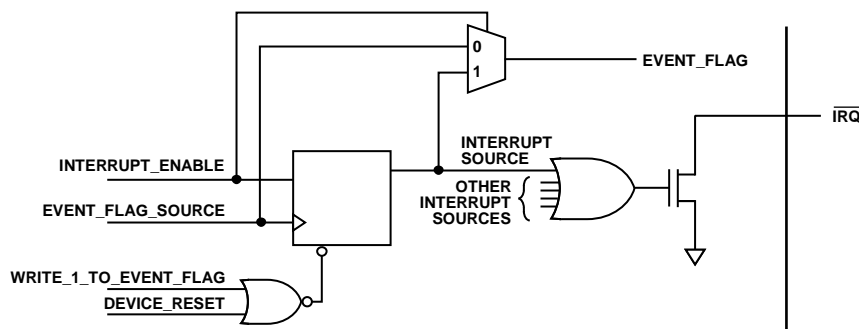


Figure 86. Simplified Schematic of  $\overline{\text{IRQ}}$  Circuitry

## INTERFACE TIMING VALIDATION

The AD9125 provides on-chip sample error detection (SED) circuitry that simplifies verification of the input data interface. The SED compares the input data samples captured at the digital input pins with a set of comparison values, which are loaded into registers through the SPI port. Differences between these values are detected and stored. Options are available for customizing SED test sequencing and error handling.

### SED OPERATION

The SED circuitry operates on a data set made up of four 16-bit input words, denoted as I0, Q0, I1, and Q1. To properly align the input samples, the first I and Q data-words (that is, I0 and Q0) are indicated by asserting the FRAME signal for a minimum of two complete input samples.

Figure 87 shows the input timing of the interface in dual-word mode. The FRAME signal can be issued once at the start of the data transmission, or it can be asserted repeatedly at intervals coinciding with the I0 and Q0 data-words.

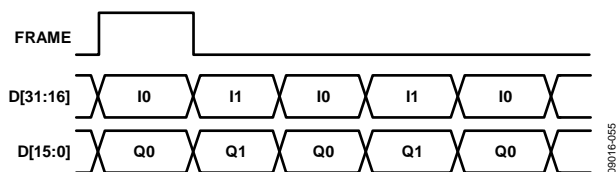


Figure 87. Timing Diagram for Dual-Word Mode SED Operation

In word mode, the FRAME signal required to align the data samples needs to be extended. The FRAME signal can be issued once at the start of the data transmission, or it can be asserted repeatedly at intervals coinciding with the I0 and Q0 data-words.

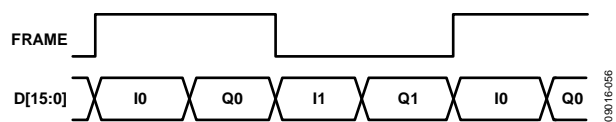


Figure 88. Timing Diagram for Two-Port Mode SED Operation

The SED has three flag bits (Register 0x67, Bit 0, Bit 1, and Bit 5) that indicate the results of the input sample comparisons. The sample error detected bit (Register 0x67, Bit 5) is set when an error is detected and remains set until the bit is cleared. The SED also provides registers that indicate which input data bits experienced errors (Register 0x70 through Register 0x73). These bits are latched and indicate the accumulated errors detected until cleared.

The autoclear mode has two effects: it activates the compare fail bit and the compare pass bit (Register 0x67, Bit 1 and Bit 0) and

changes the behavior of Register 0x70 through Register 0x73. The compare pass bit is set if the last comparison indicated that the sample was error free. The compare fail bit is set if an error is detected. The compare fail bit is automatically cleared by the reception of eight consecutive error-free comparisons. When autoclear mode is enabled, Register 0x70 through Register 0x73 accumulate errors as previously described but reset to all 0s after eight consecutive error-free sample comparisons are made.

The sample error, compare pass, and compare fail flags can be configured to trigger an  $\overline{\text{IRQ}}$  when active, if desired. This is done by enabling the appropriate bits in the Event Flag 2 register (Register 0x07). Table 28 shows a progression of the input sample comparison results and the corresponding states of the error flags.

### SED EXAMPLE

#### Normal Operation

The following example illustrates the SED configuration for continuously monitoring the input data and assertion of an  $\overline{\text{IRQ}}$  when a single error is detected.

- Write to the following registers to enable the SED and load the comparison values.
  - Register 0x67: 0x80
  - Register 0x68: I0[7:0]
  - Register 0x69: I0[15:8]
  - Register 0x6A: Q0[7:0]
  - Register 0x6B: Q0[15:8]
  - Register 0x6C: I1[7:0]
  - Register 0x6D: I1[15:8]
  - Register 0x6E: Q1[7:0]
  - Register 0x6F: Q1[15:8]
 Comparison values can be chosen arbitrarily; however, choosing values that require frequent bit toggling provides the most robust test.
- Enable the SED error detect flag to assert the  $\overline{\text{IRQ}}$  pin by writing 0x04 to Register 0x05.
- Begin transmitting the input data pattern.

If  $\overline{\text{IRQ}}$  is asserted, read Register 0x67 and Register 0x70 through Register 0x73 to verify that a SED error was detected and to determine which input bits were in error. The bits in Register 0x70 through Register 0x73 are latched; therefore, the bits indicate any errors that occurred on those bits throughout the test, not just the errors that caused the error detected flag to be set.

Table 28. Progression of Comparison Outcomes and the Resulting SED Register Values

| Compare Results (Pass/Fail)                                   | P              | F              | F              | F              | P              | P              | P              | P              | P              | P              | P              | P              | P              | F              | P              | F              |
|---|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|
| Register 0x67, Bit 5 (Sample Error Detected)                  | 0              | 1              | 1              | 1              | 1              | 1              | 1              | 1              | 1              | 1              | 1              | 1              | 1              | 1              | 1              | 1              |
| Register 0x67, Bit 1 (Compare Fail)                           | 0              | 1              | 1              | 1              | 1              | 1              | 1              | 1              | 1              | 1              | 1              | 1              | 1              | 0              | 1              | 1              |
| Register 0x67, Bit 0 (Compare Pass)                           | 1              | 0              | 0              | 0              | 1              | 1              | 1              | 1              | 1              | 1              | 1              | 1              | 1              | 0              | 1              | 0              |
| Register 0x70 to Register 0x73 (Errors Detected x_BITS[15:0]) | Z <sup>1</sup> | N <sup>2</sup> | N <sup>2</sup> | N <sup>2</sup> | N <sup>2</sup> | N <sup>2</sup> | N <sup>2</sup> | N <sup>2</sup> | N <sup>2</sup> | N <sup>2</sup> | N <sup>2</sup> | N <sup>2</sup> | N <sup>2</sup> | Z <sup>1</sup> | N <sup>2</sup> | N <sup>2</sup> |

<sup>1</sup> Z = all 0s.

<sup>2</sup> N = nonzero.

## EXAMPLE START-UP ROUTINE

There are certain sequences that should be followed to ensure reliable startup of the AD9125.

The example start-up routine assumes the following device configuration:

- $f_{DATA} = 122.88$  MSPS
- Interpolation = 4×, using HB1 = 10 and HB2 = 010010
- Input data = baseband data
- $f_{OUT} = 140$  MHz
- $f_{REFCLK} = 122.88$  MHz
- PLL = enabled
- Fine NCO = enabled
- Inverse SINC filter = enabled
- Synchronization = enabled

The following PLL settings can be derived from the device configuration:

- $f_{DACCLK} = f_{DATA} \times \text{Interpolation} = 491.52$  MHz
- $f_{VCO} = 4 \times f_{DACCLK} = 1966.08$  MHz ( $1 \text{ GHz} < f_{VCO} < 2.1 \text{ GHz}$ )
- $N1 = f_{DACCLK}/f_{REFCLK} = 4$
- $N2 = f_{VCO}/f_{DACCLK} = 4$

The following NCO settings can be derived from the device configuration:

- $f_{NCO} = 2 \times f_{DATA}$
- $f_{CARRIER} = f_{OUT} - f_{MODHB1} = 140 - 122.88 = 17.12$  MHz
- $FTW = 17.12/(2 \times 122.88) \times 2^{32} = 0x11D55555$

## Start-Up Sequence

The following procedure sets the power clock and register write sequencing for reliable device start-up:

1. Power up the device (no specific power supply sequence is required).
2. Apply stable REFCLK input signal.
3. Apply stable DCI input signal.
4. Issue a hardware reset (optional).

As a result, the device configuration register write sequence is

```

0x00 → 0x20 /* Issue software reset */
0x00 → 0x00

0x0C → 0xD1 /* Start PLL */
0x0D → 0xD9
0x0A → 0xC0
0x0A → 0x80
                /* ??Verify PLL is locked?? */
Read 0x0E, expect Bit 7 = 1, Bit 6 = 0
Read 0x06, expect 0x5C

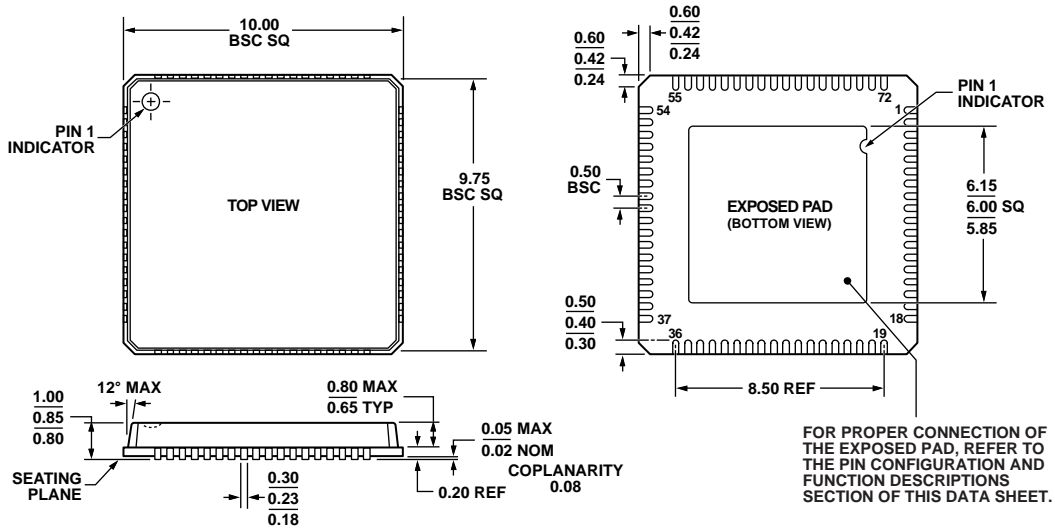
0x10 → 0x48 /* Choose data rate mode */
0x17 → 0x04 /* Issue software FIFO reset */
0x18 → 0x02
0x18 → 0x00
                /* ??Verify FIFO reset?? */
Read 0x18, expect 0x05
Read 0x19, expect 0x07

0x1B → 0x84 /* Configure interpolation
filters */
0x1C → 0x04
0x1D → 0x24

0x1E → 0x01 /* Configure NCO */
0x30 → 0x55
0x31 → 0x55
0x32 → 0xD5
0x33 → 0x11
0x36 → 0x01 /* Update frequency tuning
word */
0x36 → 0x00

```

# OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MO-220-VNND-4

Figure 89. 72-Lead Lead Frame Chip Scale Package [LFCSQ\_VQ]  
 10 mm × 10 mm Body, Very Thin Quad  
 (CP-72-7)  
 Dimensions shown in millimeters

05280P-A

## ORDERING GUIDE

| Model <sup>1</sup> | Temperature Range | Package Description                             | Package Option |
|--------------------|-------------------|---|----------------|
| AD9125BCPZ         | -40°C to +85°C    | 72-lead LFCSQ_VQ                                | CP-72-7        |
| AD9125BCPZRL       | -40°C to +85°C    | 72-lead LFCSQ_VQ                                | CP-72-7        |
| AD9125-M5372-EBZ   |                   | Evaluation Board Connected to ADL5372 Modulator |                |
| AD9125-M5375-EBZ   |                   | Evaluation Board Connected to ADL5375 Modulator |                |

<sup>1</sup> Z = RoHS Compliant Part.



**AD9125**

**NOTES**